

ProASIC3E Flash Family FPGAs

# I/Os Per Package<sup>1</sup>

ProASIC3E Devices	A3P	E600	A3PE	1500 <sup>3</sup>	A3PE	3000 <sup>3</sup>
Cortex-M1 Devices <sup>2</sup>			M1A3F	PE1500	M1A3	PE3000
			I/O T	ypes		
Package	Single-Ended I/O <sup>1</sup>	Differential I/O Pairs	Single-Ended I/O <sup>1</sup>	Differential I/O Pairs	Single-Ended I/O <sup>1</sup>	Differential I/O Pairs
PQ208	-	-	147	65	147	65
FG256	165	79	-	-	-	-
FG324	-	-	-	-	221	110
FG484	270	135	280	139	341	168
FG676	-	-	444	222	_	-
FG896	-	-	-	_	620	310

Notes:

1. When considering migrating your design to a lower- or higher-density device, refer to the ProASIC3E FPGA Fabric User's Guide to ensure compliance with design and board migration requirements.

- 2. Each used differential I/O pair reduces the number of single-ended I/Os available by two.
- 3. For A3PE1500 and A3PE3000 devices, the usage of certain I/O standards is limited as follows:
  - SSTL3(I) and (II): up to 40 I/Os per north or south bank
  - LVPECL / GTL+ 3.3 V / GTL 3.3 V: up to 48 I/Os per north or south bank
  - SSTL2(I) and (II) / GTL+ 2.5 V/ GTL 2.5 V: up to 72 I/Os per north or south bank
- 4. FG256 and FG484 are footprint-compatible packages.
- 5. When using voltage-referenced I/O standards, one I/O pin should be assigned as a voltage-referenced pin (VREF) per minibank (group of I/Os).
- 6. "G" indicates RoHS-compliant packages. Refer to the "ProASIC3E Ordering Information" on page III for the location of the "G" in the part number.

Package	PQ208	FG256	FG324	FG484	FG676	FG896
Length × Width (mm\mm)	28 × 28	17 × 17	19 × 19	23 × 23	27 × 27	31 × 31
Nominal Area (mm <sup>2</sup> )	784	289	361	529	729	961
Pitch (mm)	0.5	1.0	1.0	1.0	1.0	1.0
Height (mm)	3.40	1.60	1.63	2.23	2.23	2.23

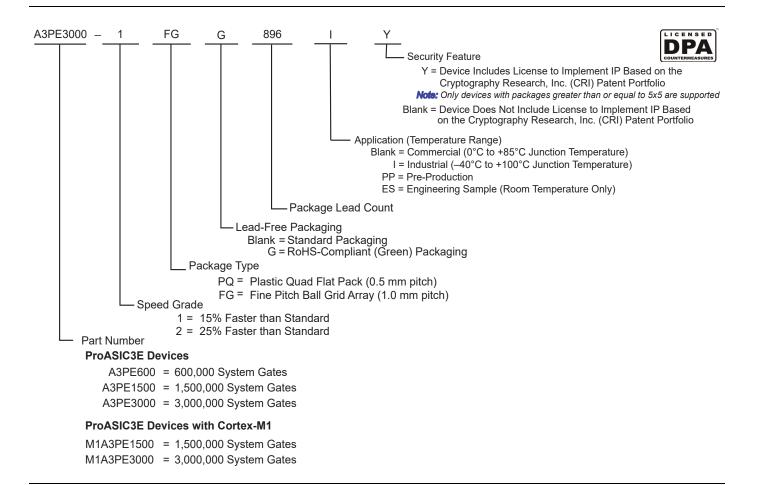
#### Table 1-2 • ProASIC3E FPGAs Package Sizes Dimensions

# **ProASIC3E Device Status**

ProASIC3E Devices	Status	M1 ProASIC3E Devices	Status
A3PE600	Production		
A3PE1500	Production	M1A3PE1500	Production
A3PE3000	Production	M1A3PE3000	Production

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# **ProASIC3E Ordering Information**





ProASIC3E Flash Family FPGAs

# **Temperature Grade Offerings**

Package	A3PE600	A3PE1500	A3PE3000
Cortex-M1 Devices		M1A3PE1500	M1A3PE3000
PQ208	_	C, I	C, I
FG256	C, I	-	_
FG324	-	-	C, I
FG484	C, I	C, I	C, I
FG676	-	C, I	_
FG896	-	-	C, I

*Note:* C = Commercial temperature range: 0°C to 70°C ambient temperature<math>I = Industrial temperature range: -40°C to 85°C ambient temperature

# **Speed Grade and Temperature Grade Matrix**

Temperature Grade	Std.	-1	-2
C <sup>1</sup>	$\checkmark$	$\checkmark$	$\checkmark$
12	$\checkmark$	$\checkmark$	$\checkmark$

Notes:

1. C = Commercial temperature range: 0°C to 70°C ambient temperature

2. I = Industrial temperature range: -40°C to 85°C ambient temperature

References made to ProASIC3E devices also apply to ARM-enabled ProASIC3E devices. The ARM-enabled part numbers start with M1 (Cortex-M1).

Contact your local Microsemi SoC Products Group representative for device availability: www.microsemi.com/index.php?option=com\_content&id=135&lang=en&view=article.



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## Package Pin Assignments

PQ208			 		 • •	 								 	 			 	 	 			 	 	 	 • •	 		4	-1
FG256			 		 • •	 								 	 				 				 	 	 -	 	 		4	-6
FG324																														
FG484			 		 	 								 	 			 	 	 			 	 	 -	 	 	 4	1-1	14
FG676			 		 	 								 	 			 	 	 			 	 	 -	 	 	 4	1-3	30
FG896			 		 	 								 	 			 	 	 			 	 	 -	 	 	 4	1-3	38

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# 1 – ProASIC3E Device Family Overview

## **General Description**

ProASIC3E, the third-generation family of Microsemi flash FPGAs, offers performance, density, and features beyond those of the ProASIC<sup>PLUS®</sup> family. Nonvolatile flash technology gives ProASIC3E devices the advantage of being a secure, low power, single-chip solution that is Instant On. ProASIC3E is reprogrammable and offers time-to-market benefits at an ASIC-level unit cost. These features enable designers to create high-density systems using existing ASIC or FPGA design flows and tools.

ProASIC3E devices offer 1 kbit of on-chip, programmable, nonvolatile FlashROM storage as well as clock conditioning circuitry based on six integrated phase-locked loops (PLLs). ProASIC3E devices have up to three million system gates, supported with up to 504 kbits of true dual-port SRAM and up to 620 user I/Os.

Several ProASIC3E devices support the Cortex-M1 soft IP cores, and the ARM-Enabled devices have Microsemi ordering numbers that begin with M1A3PE.

## **Flash Advantages**

#### Reduced Cost of Ownership

Advantages to the designer extend beyond low unit cost, performance, and ease of use. Unlike SRAMbased FPGAs, flash-based ProASIC3E devices allow all functionality to be Instant On; no external boot PROM is required. On-board security mechanisms prevent access to all the programming information and enable secure remote updates of the FPGA logic. Designers can perform secure remote in-system reprogramming to support future design iterations and field upgrades with confidence that valuable intellectual property (IP) cannot be compromised or copied. Secure ISP can be performed using the industry-standard AES algorithm. The ProASIC3E family device architecture mitigates the need for ASIC migration at higher user volumes. This makes the ProASIC3E family a cost-effective ASIC replacement solution, especially for applications in the consumer, networking/ communications, computing, and avionics markets.

#### Security

The nonvolatile, flash-based ProASIC3E devices do not require a boot PROM, so there is no vulnerable external bitstream that can be easily copied. ProASIC3E devices incorporate FlashLock, which provides a unique combination of reprogrammability and design security without external overhead, advantages that only an FPGA with nonvolatile flash programming can offer.

ProASIC3E devices utilize a 128-bit flash-based lock and a separate AES key to provide the highest level of protection in the FPGA industry for programmed intellectual property and configuration data. In addition, all FlashROM data in ProASIC3E devices can be encrypted prior to loading, using the industry-leading AES-128 (FIPS192) bit block cipher encryption standard. The AES standard was adopted by the National Institute of Standards and Technology (NIST) in 2000 and replaces the 1977 DES standard. ProASIC3E devices have a built-in AES decryption engine and a flash-based AES key that make them the most comprehensive programmable logic device security solution available today. ProASIC3E devices with AES-based security provide a high level of protection for secure, remote field updates over public networks such as the Internet, and ensure that valuable IP remains out of the hands of system overbuilders, system cloners, and IP thieves.

Security, built into the FPGA fabric, is an inherent component of the ProASIC3E family. The flash cells are located beneath seven metal layers, and many device design and layout techniques have been used to make invasive attacks extremely difficult. The ProASIC3E family, with FlashLock and AES security, is unique in being highly resistant to both invasive and noninvasive attacks. Your valuable IP is protected with industry-standard security, making remote ISP possible. A ProASIC3E device provides the best available security for programmable logic designs.

## Single Chip

Flash-based FPGAs store their configuration information in on-chip flash cells. Once programmed, the configuration data is an inherent part of the FPGA structure, and no external configuration data needs to



be loaded at system power-up (unlike SRAM-based FPGAs). Therefore, flash-based ProASIC3E FPGAs do not require system configuration components such as EEPROMs or microcontrollers to load device configuration data. This reduces bill-of-materials costs and PCB area, and increases security and system reliability.

#### Instant On

Flash-based ProASIC3E devices support Level 0 of the Instant On classification standard. This feature helps in system component initialization, execution of critical tasks before the processor wakes up, setup and configuration of memory blocks, clock generation, and bus activity management. The Instant On feature of flash-based ProASIC3E devices greatly simplifies total system design and reduces total system cost, often eliminating the need for CPLDs and clock generation PLLs that are used for these purposes in a system. In addition, glitches and brownouts in system power will not corrupt the ProASIC3E device's flash configuration, and unlike SRAM-based FPGAs, the device will not have to be reloaded when system power is restored. This enables the reduction or complete removal of the configuration PROM, expensive voltage monitor, brownout detection, and clock generator devices from the PCB design. Flash-based ProASIC3E devices simplify total system design and reduce cost and design risk while increasing system reliability and improving system initialization time.

#### Firm Errors

Firm errors occur most commonly when high-energy neutrons, generated in the upper atmosphere, strike a configuration cell of an SRAM FPGA. The energy of the collision can change the state of the configuration cell and thus change the logic, routing, or I/O behavior in an unpredictable way. These errors are impossible to prevent in SRAM FPGAs. The consequence of this type of error can be a complete system failure. Firm errors do not exist in the configuration memory of ProASIC3E flash-based FPGAs. Once it is programmed, the flash cell configuration element of ProASIC3E FPGAs cannot be altered by high-energy neutrons and is therefore immune to them. Recoverable (or soft) errors occur in the user data SRAM of all FPGA devices. These can easily be mitigated by using error detection and correction (EDAC) circuitry built into the FPGA fabric.

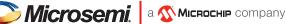
#### Low Power

Flash-based ProASIC3E devices exhibit power characteristics similar to an ASIC, making them an ideal choice for power-sensitive applications. ProASIC3E devices have only a very limited power-on current surge and no high-current transition period, both of which occur on many FPGAs.

ProASIC3E devices also have low dynamic power consumption to further maximize power savings.

## **Advanced Flash Technology**

The ProASIC3E family offers many benefits, including nonvolatility and reprogrammability through an advanced flashbased, 130-nm LVCMOS process with seven layers of metal. Standard CMOS design techniques are used to implement logic and control functions. The combination of fine granularity, enhanced flexible routing resources, and abundant flash switches allows for very high logic utilization without compromising device routability or performance. Logic functions within the device are interconnected through a four-level routing hierarchy.



General Description

## Advanced Architecture

The proprietary ProASIC3E architecture provides granularity comparable to standard-cell ASICs. The ProASIC3E device consists of five distinct and programmable architectural features (Figure 1-1 on page 3):

- **FPGA** VersaTiles
- **Dedicated FlashROM**
- Dedicated SRAM/FIFO memory
- Extensive CCCs and PLLs
- Pro I/O structure

The FPGA core consists of a sea of VersaTiles. Each VersaTile can be configured as a three-input logic function, a Dflip-flop (with or without enable), or a latch by programming the appropriate flash switch interconnections. The versatility of the ProASIC3E core tile as either a three-input lookup table (LUT) equivalent or as a D-flip-flop/latch with enable allows for efficient use of the FPGA fabric. The VersaTile capability is unique to the ProASIC family of thirdgeneration architecture Flash FPGAs. VersaTiles are connected with any of the four levels of routing hierarchy. Flash switches are distributed throughout the device to provide nonvolatile, reconfigurable interconnect programming. Maximum core utilization is possible for virtually any design.

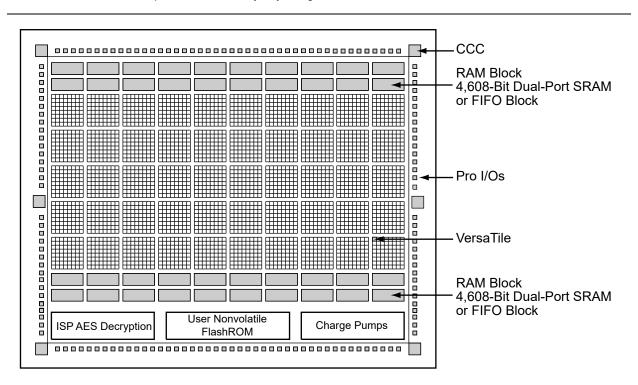


Figure 1-1 • ProASIC3E Device Architecture Overview

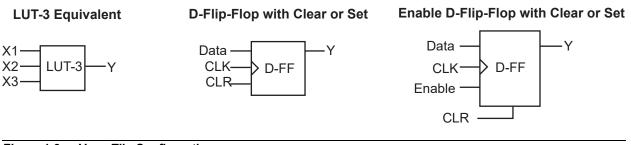
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#### VersaTiles

The ProASIC3E core consists of VersaTiles, which have been enhanced beyond the ProASIC<sup>PLUS®</sup> core tiles. The ProASIC3E VersaTile supports the following:

- All 3-input logic functions—LUT-3 equivalent
- Latch with clear or set
- D-flip-flop with clear or set
- Enable D-flip-flop with clear or set

Refer to Figure 1-2 for VersaTile configurations.



#### Figure 1-2 • VersaTile Configurations

#### User Nonvolatile FlashROM

ProASIC3E devices have 1 kbit of on-chip, user-accessible, nonvolatile FlashROM. The FlashROM can be used in diverse system applications:

- Internet protocol addressing (wireless or fixed)
- · System calibration settings
- Device serialization and/or inventory control
- Subscription-based business models (for example, set-top boxes)
- · Secure key storage for secure communications algorithms
- Asset management/tracking
- Date stamping
- Version management

The FlashROM is written using the standard ProASIC3E IEEE 1532 JTAG programming interface. The core can be individually programmed (erased and written), and on-chip AES decryption can be used selectively to securely load data over public networks, as in security keys stored in the FlashROM for a user design.

The FlashROM can be programmed via the JTAG programming interface, and its contents can be read back either through the JTAG programming interface or via direct FPGA core addressing. Note that the FlashROM can only be programmed from the JTAG interface and cannot be programmed from the internal logic array.

The FlashROM is programmed as 8 banks of 128 bits; however, reading is performed on a byte-by-byte basis using a synchronous interface. A 7-bit address from the FPGA core defines which of the 8 banks and which of the 16 bytes within that bank are being read. The three most significant bits (MSBs) of the FlashROM address determine the bank, and the four least significant bits (LSBs) of the FlashROM address define the byte.

The ProASIC3E development software solutions, Libero<sup>®</sup> System-on-Chip (SoC) and Designer, have extensive support for the FlashROM. One such feature is auto-generation of sequential programming files for applications requiring a unique serial number in each part. Another feature allows the inclusion of static data for system version control. Data for the FlashROM can be generated quickly and easily using Libero SoC and Designer software tools. Comprehensive programming file support is also included to allow for easy programming of large numbers of parts with differing FlashROM contents.

#### SRAM and FIFO

ProASIC3E devices have embedded SRAM blocks along their north and south sides. Each variable-aspect-ratio SRAM block is 4,608 bits in size. Available memory configurations are 256×18, 512×9, 1k×4, 2k×2, and 4k×1 bits. The individual blocks have independent read and write ports that can be configured with different bit widths on each port.



For example, data can be sent through a 4-bit port and read as a single bitstream. The embedded SRAM blocks can be initialized via the device JTAG port (ROM emulation mode) using the UJTAG macro.

In addition, every SRAM block has an embedded FIFO control unit. The control unit allows the SRAM block to be configured as a synchronous FIFO without using additional core VersaTiles. The FIFO width and depth are programmable. The FIFO also features programmable Almost Empty (AEMPTY) and Almost Full (AFULL) flags in addition to the normal Empty and Full flags. The embedded FIFO control unit contains the counters necessary for generation of the read and write address pointers. The embedded SRAM/FIFO blocks can be cascaded to create larger configurations.

## PLL and CCC

ProASIC3E devices provide designers with very flexible clock conditioning capabilities. Each member of the ProASIC3E family contains six CCCs, each with an integrated PLL.

The six CCC blocks are located at the four corners and the centers of the east and west sides.

To maximize user I/Os, only the center east and west PLLs are available in devices using the PQ208 package. However, all six CCC blocks are still usable; the four corner CCCs allow simple clock delay operations as well as clock spine access.

The inputs of the six CCC blocks are accessible from the FPGA core or from one of several inputs located near the CCC that have dedicated connections to the CCC block.

The CCC block has these key features:

- Wide input frequency range ( $f_{IN CCC}$ ) = 1.5 MHz to 350 MHz
- Output frequency range (f<sub>OUT CCC</sub>) = 0.75 MHz to 350 MHz
- Clock delay adjustment via programmable and fixed delays from -7.56 ns to +11.12 ns
- · 2 programmable delay types for clock skew minimization
- Clock frequency synthesis

Additional CCC specifications:

- Internal phase shift = 0°, 90°, 180°, and 270°. Output phase shift depends on the output divider configuration.
- Output duty cycle = 50% ± 1.5% or better
- Low output jitter: worst case < 2.5% × clock period peak-to-peak period jitter when single global network used
- Maximum acquisition time = 300 µs
- Low power consumption of 5 mW
- Exceptional tolerance to input period jitter allowable input jitter is up to 1.5 ns
- Four precise phases; maximum misalignment between adjacent phases of 40 ps × (350 MHz / f<sub>OUT\_CCC</sub>)

#### Global Clocking

ProASIC3E devices have extensive support for multiple clocking domains. In addition to the CCC and PLL support described above, there is a comprehensive global clock distribution network.

Each VersaTile input and output port has access to nine VersaNets: six chip (main) and three quadrant global networks. The VersaNets can be driven by the CCC or directly accessed from the core via multiplexers (MUXes). The VersaNets can be used to distribute low-skew clock signals or for rapid distribution of high fanout nets.



## Pro I/Os with Advanced I/O Standards

The ProASIC3E family of FPGAs features a flexible I/O structure, supporting a range of voltages (1.5 V, 1.8 V, 2.5 V, and 3.3 V). ProASIC3E FPGAs support 19 different I/O standards, including single-ended, differential, and voltage-referenced. The I/Os are organized into banks, with eight banks per device (two per side). The configuration of these banks determines the I/O standards supported. Each I/O bank is subdivided into VREF minibanks, which are used by voltage-referenced I/Os. VREF minibanks contain 8 to 18 I/Os. All the I/Os in a given minibank share a common VREF line. Therefore, if any I/O in a given VREF minibank is configured as a VREF pin, the remaining I/Os in that minibank will be able to use that reference voltage.

Each I/O module contains several input, output, and enable registers. These registers allow the implementation of the following:

- Single-Data-Rate applications (e.g., PCI 66 MHz, bidirectional SSTL 2 and 3, Class I and II)
- Double-Data-Rate applications (e.g., DDR LVDS, B-LVDS, and M-LVDS I/Os for point-to-point communications, and DDR 200 MHz SRAM using bidirectional HSTL Class II)

ProASIC3E banks support M-LVDS with 20 multi-drop points.

Hot-swap (also called hot-plug, or hot-insertion) is the operation of hot-insertion or hot-removal of a card in a poweredup system.

Cold-sparing (also called cold-swap) refers to the ability of a device to leave system data undisturbed when the system is powered up, while the component itself is powered down, or when power supplies are floating.

## **Specifying I/O States During Programming**

You can modify the I/O states during programming in FlashPro. In FlashPro, this feature is supported for PDB files generated from Designer v8.5 or greater. See the *FlashPro User's Guide* for more information.

- Note: PDB files generated from Designer v8.1 to Designer v8.4 (including all service packs) have limited display of Pin Numbers only.
  - 1. Load a PDB from the FlashPro GUI. You must have a PDB loaded to modify the I/O states during programming.
  - 2. From the FlashPro GUI, click PDB Configuration. A FlashPoint Programming File Generator window appears.
  - 3. Click the Specify I/O States During Programming button to display the Specify I/O States During Programming dialog box.
  - 4. Sort the pins as desired by clicking any of the column headers to sort the entries by that header. Select the I/Os you wish to modify (Figure 1-3 on page 1-7).
  - 5. Set the I/O Output State. You can set Basic I/O settings if you want to use the default I/O settings for your pins, or use Custom I/O settings to customize the settings for each pin. Basic I/O state settings:
    - 1 I/O is set to drive out logic High
    - 0 I/O is set to drive out logic Low

Last Known State – I/O is set to the last value that was driven out prior to entering the programming mode, and then held at that value during programming

Z -Tri-State: I/O is tristated



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Port Name	Macro Cell	Pin Number	1/O State (Output Only)
BIST	ADLIB:INBUF	T2	1
BYPASS_IO	ADLIB:INBUF	K1	1
CLK	ADLIB:INBUF	B1	1
ENOUT	ADLIB:INBUF	J16	1
LED	ADLIB:OUTBUF	M3	0
MONITOR[0]	ADLIB:OUTBUF	B5	0
MONITOR[1]	ADLIB:OUTBUF	C7	Z
MONITOR[2]	ADLIB:OUTBUF	D9	Z
MONITOR[3]	ADLIB:OUTBUF	D7	Z
MONITOR[4]	ADLIB:OUTBUF	A11	Z
OEa	ADLIB:INBUF	E4	Z
ОЕЬ	ADLIB:INBUF	F1	Z
OSC_EN	ADLIB:INBUF	К3	Z
PAD[10]	ADLIB:BIBUF_LVCMOS33U	M8	Z
PAD[11]	ADLIB:BIBUF_LVCMOS33D	B7	Z
PAD[12]	ADLIB:BIBUF_LVCMOS33U	D11	Z
PAD[13]	ADLIB:BIBUF_LVCMOS33D	C12	Z
PAD[14]	ADLIB:BIBUF_LVCMOS33U	R6	Z
			-

#### *Figure 1-3* • I/O States During Programming Window

6. Click OK to return to the FlashPoint - Programming File Generator window.

I/O States during programming are saved to the ADB and resulting programming files after completing programming file generation.



# 2 – ProASIC3E DC and Switching Characteristics

## **General Specifications**

DC and switching characteristics for -F speed grade targets are based only on simulation.

The characteristics provided for the -F speed grade are subject to change after establishing FPGA specifications. Some restrictions might be added and will be reflected in future revisions of this document. The -F speed grade is only supported in the commercial temperature range.

## **Operating Conditions**

Stresses beyond those listed in Table 2-1 may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Absolute Maximum Ratings are stress ratings only; functional operation of the device at these or any other conditions beyond those listed under the Recommended Operating Conditions specified in Table 2-2 on page 2-2 is not implied.

Table 2-1 • Absolute Maximum Ratings

Symbol	Parameter	Limits	Units
VCC	DC core supply voltage	-0.3 to 1.65	V
VJTAG	JTAG DC voltage	-0.3 to 3.75	V
VPUMP	Programming voltage	-0.3 to 3.75	V
VCCPLL	Analog power supply (PLL)	-0.3 to 1.65	V
VCCI <sup>2</sup>	DC I/O output buffer supply voltage	-0.3 to 3.75	V
VMV <sup>2</sup>	DC I/O input buffer supply voltage	-0.3 to 3.75	V
VI	I/O input voltage	<ul> <li>-0.3 V to 3.6 V (when I/O hot insertion mode is enabled)</li> <li>-0.3 V to (VCCI + 1 V) or 3.6 V, whichever voltage is lower (when I/O hot-insertion mode is disabled)</li> </ul>	V
T <sub>STG</sub> <sup>3</sup>	Storage temperature	-65 to +150	°C
T <sub>J</sub> <sup>3</sup>	Junction temperature	+125	°C

Notes:

2. VMV pins must be connected to the corresponding VCCI pins. See the "VMVx I/O Supply Voltage (quiet)" section on page 3-1 for further information.

3. For flash programming and retention maximum limits, refer to Table 2-3 on page 2-2, and for recommended operating limits, refer to Table 2-2 on page 2-2.

<sup>1.</sup> The device should be operated within the limits specified by the datasheet. During transitions, the input signal may undershoot or overshoot according to the limits shown in Table 2-3 on page 2-2.

Symbol	Para	meter	Commercial	Industrial	Units
T <sub>A</sub>	Ambient temperature		0 to +70	-40 to +85	°C
TJ	Junction temperature		0 to +85	-40 to +100	°C
VCC	1.5 V DC core supply volta	age	1.425 to 1.575	1.425 to 1.575	V
VJTAG	JTAG DC voltage		1.4 to 3.6	1.4 to 3.6	V
VPUMP	Programming voltage	Programming Mode <sup>2</sup>	3.15 to 3.45	3.15 to 3.45	V
		Operation <sup>3</sup>	0 to 3.6	0 to 3.6	V
VCCPLL	Analog power supply (PLL	_)	1.425 to 1.575	1.425 to 1.575	V
VCCI and VMV $^4$	1.5 V DC supply voltage		1.425 to 1.575	1.425 to 1.575	V
	1.8 V DC supply voltage		1.7 to 1.9	1.7 to 1.9	V
	2.5 V DC supply voltage		2.3 to 2.7	2.3 to 2.7	V
	3.3 V DC supply voltage		3.0 to 3.6	3.0 to 3.6	V
	3.0 V DC supply voltage <sup>5</sup>		2.7 to 3.6	2.7 to 3.6	V
	LVDS/B-LVDS/M-LVDS di	fferential I/O	2.375 to 2.625	2.375 to 2.625	V
	LVPECL differential I/O		3.0 to 3.6	3.0 to 3.6	V

#### Table 2-2 • Recommended Operating Conditions<sup>1</sup>

Notes:

1. All parameters representing voltages are measured with respect to GND unless otherwise specified.

2. The programming temperature range supported is  $T_{ambient} = 0^{\circ}C$  to  $85^{\circ}C$ .

3. VPUMP can be left floating during normal operation (not programming mode).

- 4. The ranges given here are for power supplies only. The recommended input voltage ranges specific to each I/O standard are given in Table 2-13 on page 2-17. VMV and VCCI should be at the same voltage within a given I/O bank. VMV pins must be connected to the corresponding VCCI pins. See the "VMVx I/O Supply Voltage (quiet)" section on page 3-1 for further information.
- 5. To ensure targeted reliability standards are met across ambient and junction operating temperatures, Microsemi recommends that the user follow best design practices using Microsemi's timing and power simulation tools.
- 6. 3.3 V wide range is compliant to the JESD8-B specification and supports 3.0 V VCCI operation.

#### Table 2-3 • Flash Programming Limits – Retention, Storage and Operating Temperature<sup>1</sup>

Product Grade		Program Retention (biased/unbiased)	Maximum Storage Temperature T <sub>STG</sub> (°C) <sup>2</sup>	Maximum Operating Junction Temperature T <sub>J</sub> (°C) <sup>2</sup>
Commercial	500	20 years	110	100
Industrial	500	20 years	110	100

Notes:

1. This is a stress rating only; functional operation at any condition other than those indicated is not implied.

2. These limits apply for program/data retention only. Refer to Table 2-1 on page 2-1 and Table 2-2 for device operating conditions and absolute limits.

VCCI and VMV	Average VCCI–GND Overshoot or Undershoot Duration as a Percentage of Clock Cycle <sup>2</sup>	Maximum Overshoot/ Undershoot <sup>2</sup>
2.7 V or less	10%	1.4 V
	5%	1.49 V
3 V	10%	1.1 V
-	5%	1.19 V
3.3 V	10%	0.79 V
-	5%	0.88 V
3.6 V	10%	0.45 V
	5%	0.54 V

#### Table 2-4 • Overshoot and Undershoot Limits <sup>1</sup>

Notes:

- 1. Based on reliability requirements at 85°C.
- 2. The duration is allowed at one out of six clock cycles. If the overshoot/undershoot occurs at one out of two cycles, the maximum overshoot/undershoot has to be reduced by 0.15 V.
- 3. This table does not provide PCI overshoot/undershoot limits.

# I/O Power-Up and Supply Voltage Thresholds for Power-On Reset (Commercial and Industrial)

Sophisticated power-up management circuitry is designed into every ProASIC<sup>®</sup>3E device. These circuits ensure easy transition from the powered-off state to the powered-up state of the device. The many different supplies can power up in any sequence with minimized current spikes or surges. In addition, the I/O will be in a known state through the power-up sequence. The basic principle is shown in Figure 2-1 on page 2-4.

There are five regions to consider during power-up.

ProASIC3E I/Os are activated only if ALL of the following three conditions are met:

- 1. VCC and VCCI are above the minimum specified trip points (Figure 2-1 on page 2-4).
- 2. VCCI > VCC 0.75 V (typical)
- 3. Chip is in the operating mode.

#### VCCI Trip Point:

Ramping up: 0.6 V < trip\_point\_up < 1.2 V Ramping down: 0.5 V < trip\_point\_down < 1.1 V

#### VCC Trip Point:

Ramping up: 0.6 V < trip\_point\_up < 1.1 V Ramping down: 0.5 V < trip\_point\_down < 1 V

VCC and VCCI ramp-up trip points are about 100 mV higher than ramp-down trip points. This specifically built-in hysteresis prevents undesirable power-up oscillations and current surges. Note the following:

- During programming, I/Os become tristated and weakly pulled up to VCCI.
- JTAG supply, PLL power supplies, and charge pump VPUMP supply have no influence on I/O behavior.



## PLL Behavior at Brownout Condition

Microsemi recommends using monotonic power supplies or voltage regulators to ensure proper power-up behavior. Power ramp-up should be monotonic at least until VCC and VCCPLXL exceed brownout activation levels. The VCC activation level is specified as 1.1 V worst-case (see Figure 2-1 on page 2-4 for more details).

When PLL power supply voltage and/or VCC levels drop below the VCC brownout levels (0.75 V ± 0.25 V), the PLL output lock signal goes low and/or the output clock is lost. Refer to the "Power-Up/-Down Behavior of Low Power Flash Devices" chapter of the ProASIC3E FPGA Fabric User's Guide for information on clock and lock recovery.

#### Internal Power-Up Activation Sequence

- 1. Core
- 2. Input buffers
- 3. Output buffers, after 200 ns delay from input buffer activation

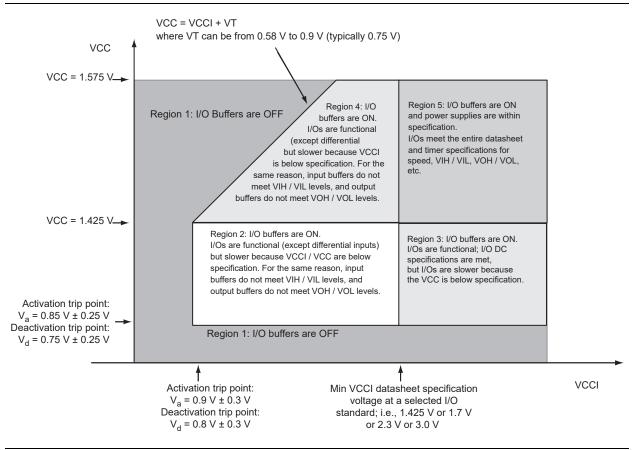


Figure 2-1 • I/O State as a Function of VCCI and VCC Voltage Levels

## **Thermal Characteristics**

#### Introduction

The temperature variable in Designer software refers to the junction temperature, not the ambient temperature. This is an important distinction because dynamic and static power consumption cause the chip junction to be higher than the ambient temperature.

EQ 1 can be used to calculate junction temperature.

$$T_{J}$$
 = Junction Temperature =  $\Delta T + T_{A}$ 

where:

T<sub>A</sub> = Ambient Temperature

 $\Delta T$  = Temperature gradient between junction (silicon) and ambient  $\Delta T$  =  $\theta_{ia}$  \* P

 $\theta_{ja}$  = Junction-to-ambient of the package.  $\theta_{ja}$  numbers are located in Table 2-5.

P = Power dissipation

#### Package Thermal Characteristics

The device junction-to-case thermal resistivity is  $\theta_{jc}$  and the junction-to-ambient air thermal resistivity is  $\theta_{ja}$ . The thermal characteristics for  $\theta_{ja}$  are shown for two air flow rates. The absolute maximum junction temperature is 110°C. EQ 2 shows a sample calculation of the absolute maximum power dissipation allowed for an 896-pin FBGA package at commercial temperature and in still air.

Maximum Power Allowed = 
$$\frac{\text{Max. junction temp. (°C)} - \text{Max. ambient temp. (°C)}}{\theta_{ja}(°C/W)} = \frac{110°C - 70°C}{13.6°C/W} = 5.88 \text{ W}$$

#### Table 2-5 • Package Thermal Resistivities

EQ 1

EQ 2

## Temperature and Voltage Derating Factors

Table 2-6 • Temperature and Voltage Derating Factors for Timing Delays (normalized to  $T_J = 70^{\circ}C$ , VCC = 1.425 V)

Array Voltage		Junction Temperature (°C)					
VCC (V)	–40°C	0°C	25°C	70°C	85°C	100°C	
1.425	0.87	0.92	0.95	1.00	1.02	1.04	
1.500	0.83	0.88	0.90	0.95	0.97	0.98	
1.575	0.80	0.85	0.87	0.92	0.93	0.95	

# **Calculating Power Dissipation**

## **Quiescent Supply Current**

#### Table 2-7 • Quiescent Supply Current Characteristics

	A3PE600	A3PE1500	A3PE3000
Typical (25°C)	5 mA	12 mA	25 mA
Maximum (Commercial)	30 mA	70 mA	150 mA
Maximum (Industrial)	45 mA	105 mA	225 mA

Notes:

1. IDD Includes VCC, VPUMP, VCCI, and VMV currents. Values do not include I/O static contribution, which is shown in Table 2-8 and Table 2-9 on page 2-7.

2. -F speed grade devices may experience higher standby IDD of up to five times the standard IDD and higher I/O leakage.

## Power per I/O Pin

#### Table 2-8 • Summary of I/O Input Buffer Power (per pin) – Default I/O Software Settings

	VMV (V)	Static Power PDC2 (mW) <sup>1</sup>	Dynamic Power PAC9 (µW/MHz) <sup>2</sup>
Single-Ended			1
3.3 V LVTTL/LVCMOS	3.3	-	17.39
3.3 V LVTTL/LVCMOS – Schmitt trigger	3.3	_	25.51
3.3 V LVTTL/LVCMOS Wide Range <sup>3</sup>	3.3	_	16.34
3.3 V LVTTL/LVCMOS Wide Range – Schmitt trigger <sup>3</sup>	3.3	_	24.49
2.5 V LVCMOS	2.5	-	5.76
2.5 V LVCMOS – Schmitt trigger	2.5	_	7.16
1.8 V LVCMOS	1.8	_	2.72
1.8 V LVCMOS – Schmitt trigger	1.8	_	2.80
1.5 V LVCMOS (JESD8-11)	1.5	_	2.08
1.5 V LVCMOS (JESD8-11) – Schmitt trigger	1.5	-	2.00
3.3 V PCI	3.3	-	18.82

Notes:

1. PDC2 is the static power (where applicable) measured on VMV.

2. PAC9 is the total dynamic power measured on VCC and VMV.

3. All LVCMOS 3.3 V software macros support LVCMOS 3.3 V wide range as specified in the JESD8b specification.

#### Table 2-8 • Summary of I/O Input Buffer Power (per pin) – Default I/O Software Settings (continued)

	VMV (V)	Static Power PDC2 (mW) <sup>1</sup>	Dynamic Power PAC9 (µW/MHz) <sup>2</sup>
3.3 V PCI – Schmitt trigger	3.3	_	20.12
3.3 V PCI-X	3.3	_	18.82
3.3 V PCI-X – Schmitt trigger	3.3	_	20.12
Voltage-Referenced			·
3.3 V GTL	3.3	2.90	8.23
2.5 V GTL	2.5	2.13	4.78
3.3 V GTL+	3.3	2.81	4.14
2.5 V GTL+	2.5	2.57	3.71
HSTL (I)	1.5	0.17	2.03
HSTL (II)	1.5	0.17	2.03
SSTL2 (I)	2.5	1.38	4.48
SSTL2 (II)	2.5	1.38	4.48
SSTL3 (I)	3.3	3.21	9.26
SSTL3 (II)	3.3	3.21	9.26
Differential	_	•	•
LVDS/B-LVDS/M-LVDS	2.5	2.26	1.50
LVPECL	3.3	5.71	2.17

Notes:

1. PDC2 is the static power (where applicable) measured on VMV.

2. PAC9 is the total dynamic power measured on VCC and VMV.

3. All LVCMOS 3.3 V software macros support LVCMOS 3.3 V wide range as specified in the JESD8b specification.

#### Table 2-9 • Summary of I/O Output Buffer Power (per pin) – Default I/O Software Settings <sup>1</sup>

	C <sub>LOAD</sub> (pF)	VCCI (V)	Static Power PDC3 (mW) <sup>2</sup>	Dynamic Power PAC10 (µW/MHz) <sup>3</sup>
Single-Ended				
3.3 V LVTTL/LVCMOS	35	3.3	-	474.70
3.3 V LVTTL/LVCMOS Wide Range <sup>4</sup>	35	3.3	_	474.70
2.5 V LVCMOS	35	2.5	-	270.73
1.8 V LVCMOS	35	1.8	_	151.78
1.5 V LVCMOS (JESD8-11)	35	1.5	-	104.55
3.3 V PCI	10	3.3	_	204.61
3.3 V PCI-X	10	3.3	-	204.61
Voltage-Referenced				
3.3 V GTL	10	3.3	-	24.08
2.5 V GTL	10	2.5	-	13.52
3.3 V GTL+	10	3.3	-	24.10
2.5 V GTL+	10	2.5	-	13.54

5     7.08       5     13.88       5     16.69       5     25.91	26.22 27.22 105.56 116.60
5 16.69	105.56
5 25.91	116.60
	in the JESD8-B specification.
3 26.02	114.87
3 42.21	131.76
	89.62
	2.5 7.70

#### Table 2-9 • Summary of I/O Output Buffer Power (per pin) – Default I/O Software Settings (continued) (continued)<sup>1</sup>

2. PDC3 is the static power (where applicable) measured on VCCI.

3. PAC10 is the total dynamic power measured on VCC and VCCI.

4. All LVCMOS 3.3 V software macros support LVCMOS 3.3 V wide range as specified in the JESD8-B specification.

## **Power Consumption of Various Internal Resources**

#### Table 2-10 • Different Components Contributing to the Dynamic Power Consumption in ProASIC3E Devices

		Device-Specific Dynamic Contribution (µW/MHz)		
Parameter	Definition	A3PE600	A3PE1500	A3PE3000
PAC1	Clock contribution of a Global Rib	12.77	16.21	19.7
PAC2	Clock contribution of a Global Spine	1.85	3.06	4.16
PAC3	Clock contribution of a VersaTile row		0.88	
PAC4	Clock contribution of a VersaTile used as a sequential module		0.12	
PAC5	First contribution of a VersaTile used as a sequential module		0.07	
PAC6	Second contribution of a VersaTile used as a sequential module		0.29	
PAC7	Contribution of a VersaTile used as a combinatorial module	0.29		
PAC8	Average contribution of a routing net	0.70		
PAC9	Contribution of an I/O input pin (standard-dependent)	See Table 2-8 on page 2-6.		
PAC10	Contribution of an I/O output pin (standard-dependent)	See	Table 2-9 on pag	ge 2-7
PAC11	Average contribution of a RAM block during a read operation		25.00	

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		Device-Specific Dynamic Contribution (µW/MHz)		ontributions
Parameter	Definition	A3PE600	A3PE1500	A3PE3000
PAC12	Average contribution of a RAM block during a write operation		30.00	
PAC13	Static PLL contribution		2.55 mW	
PAC14	Dynamic contribution for PLL		2.60	

*Note:* For a different output load, drive strength, or slew rate, Microsemi recommends using the Microsemi power calculator or SmartPower in Libero SoC.

## **Power Calculation Methodology**

This section describes a simplified method to estimate power consumption of an application. For more accurate and detailed power estimations, use the SmartPower tool in the Libero SoC software.

The power calculation methodology described below uses the following variables:

- · The number of PLLs as well as the number and the frequency of each output clock generated
- The number of combinatorial and sequential cells used in the design
- · The internal clock frequencies
- · The number and the standard of I/O pins used in the design
- · The number of RAM blocks used in the design
- Toggle rates of I/O pins as well as VersaTiles—guidelines are provided in Table 2-11 on page 2-12.
- Enable rates of output buffers—guidelines are provided for typical applications in Table 2-12 on page 2-12.
- Read rate and write rate to the memory—guidelines are provided for typical applications in Table 2-12 on page 2-12. The calculation should be repeated for each clock domain defined in the design.

#### Methodology

#### Total Power Consumption—PTOTAL

 $P_{TOTAL} = P_{STAT} + P_{DYN}$ 

P<sub>STAT</sub> is the total static power consumption.

P<sub>DYN</sub> is the total dynamic power consumption.

#### Total Static Power Consumption—P<sub>STAT</sub>

P<sub>STAT</sub> = PDC1 + N<sub>INPUTS</sub> \* PDC2 + N<sub>OUTPUTS</sub> \* PDC3

N<sub>INPUTS</sub> is the number of I/O input buffers used in the design.

N<sub>OUTPUTS</sub> is the number of I/O output buffers used in the design.

#### Total Dynamic Power Consumption—P<sub>DYN</sub>

P<sub>DYN</sub> = P<sub>CLOCK</sub> + P<sub>S-CELL</sub> + P<sub>C-CELL</sub> + P<sub>NET</sub> + P<sub>INPUTS</sub> + P<sub>OUTPUTS</sub> + P<sub>MEMORY</sub> + P<sub>PLL</sub>

#### Global Clock Contribution—P<sub>CLOCK</sub>

 $P_{CLOCK}$  = (PAC1 + N<sub>SPINE</sub> \* PAC2 + N<sub>ROW</sub> \* PAC3 + N<sub>S-CELL</sub> \* PAC4) \* F<sub>CLK</sub>

N<sub>SPINE</sub> is the number of global spines used in the user design—guidelines are provided in the "Spine Architecture" section of the Global Resources chapter in the *ProASIC3E FPGA Fabric User's Guide*.

N<sub>ROW</sub> is the number of VersaTile rows used in the design—guidelines are provided in the "Spine Architecture" section of the Global Resources chapter in the *ProASIC3E FPGA Fabric User's Guide*.

F<sub>CLK</sub> is the global clock signal frequency.

N<sub>S-CELL</sub> is the number of VersaTiles used as sequential modules in the design.

PAC1, PAC2, PAC3, and PAC4 are device-dependent.

#### Sequential Cells Contribution—P<sub>S-CELL</sub>

 $P_{S-CELL} = N_{S-CELL} * (PAC5 + \alpha_1 / 2 * PAC6) * F_{CLK}$ 

 $N_{S-CELL}$  is the number of VersaTiles used as sequential modules in the design. When a multi-tile sequential cell is used, it should be accounted for as 1.

 $\alpha_1$  is the toggle rate of VersaTile outputs—guidelines are provided in Table 2-11 on page 2-12.

F<sub>CLK</sub> is the global clock signal frequency.

#### Combinatorial Cells Contribution—P<sub>C-CELL</sub>

 $P_{C-CELL} = N_{C-CELL} * \alpha_1 / 2 * PAC7 * F_{CLK}$ 

N<sub>C-CELL</sub> is the number of VersaTiles used as combinatorial modules in the design.

 $\alpha_1$  is the toggle rate of VersaTile outputs—guidelines are provided in Table 2-11 on page 2-12.

F<sub>CLK</sub> is the global clock signal frequency.

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#### Routing Net Contribution—P<sub>NET</sub>

 $\mathsf{P}_{\mathsf{NET}} = (\mathsf{N}_{\mathsf{S}\text{-}\mathsf{CELL}} + \mathsf{N}_{\mathsf{C}\text{-}\mathsf{CELL}}) * \alpha_1 / 2 * \mathsf{PAC8} * \mathsf{F}_{\mathsf{CLK}}$ 

N<sub>S-CELL</sub> is the number of VersaTiles used as sequential modules in the design.

N<sub>C-CELL</sub> is the number of VersaTiles used as combinatorial modules in the design.

 $\alpha_1$  is the toggle rate of VersaTile outputs—guidelines are provided in Table 2-11 on page 2-12.

F<sub>CLK</sub> is the global clock signal frequency.

## I/O Input Buffer Contribution—PINPUTS

 $P_{INPUTS} = N_{INPUTS} * \alpha_2 / 2 * PAC9 * F_{CLK}$ 

N<sub>INPUTS</sub> is the number of I/O input buffers used in the design.

 $\alpha_2$  is the I/O buffer toggle rate—guidelines are provided in Table 2-11 on page 2-12.

F<sub>CLK</sub> is the global clock signal frequency.

#### I/O Output Buffer Contribution—POUTPUTS

 $P_{OUTPUTS}$  =  $N_{OUTPUTS}$  \*  $\alpha_2$  / 2 \*  $\beta_1$  \* PAC10 \*  $F_{CLK}$ 

N<sub>OUTPUTS</sub> is the number of I/O output buffers used in the design.

 $\alpha_2$  is the I/O buffer toggle rate—guidelines are provided in Table 2-11 on page 2-12.

 $\beta_1$  is the I/O buffer enable rate—guidelines are provided in Table 2-12 on page 2-12.

F<sub>CLK</sub> is the global clock signal frequency.

#### RAM Contribution—P<sub>MEMORY</sub>

 $P_{MEMORY} = PAC11 * N_{BLOCKS} * F_{READ-CLOCK} * \beta_2 + PAC12 * N_{BLOCK} * F_{WRITE-CLOCK} * \beta_3$ 

N<sub>BLOCKS</sub> is the number of RAM blocks used in the design.

F<sub>READ-CLOCK</sub> is the memory read clock frequency.

 $\beta_2$  is the RAM enable rate for read operations—guidelines are provided in Table 2-12 on page 2-12. F<sub>WRITE-CLOCK</sub> is the memory write clock frequency.

 $\beta_3$  is the RAM enable rate for write operations—guidelines are provided in Table 2-12 on page 2-12.

#### PLL Contribution—P<sub>PLL</sub>

P<sub>PLL</sub> = PAC13 + PAC14 \* F<sub>CLKOUT</sub>

F<sub>CLKOUT</sub> is the output clock frequency.<sup>1</sup>

 The PLL dynamic contribution depends on the input clock frequency, the number of output clock signals generated by the PLL, and the frequency of each output clock. If a PLL is used to generate more than one output clock, include each output clock in the formula by adding its corresponding contribution (PAC14 \* F<sub>CLKOUT</sub> product) to the total PLL contribution.



#### Guidelines

#### **Toggle Rate Definition**

A toggle rate defines the frequency of a net or logic element relative to a clock. It is a percentage. If the toggle rate of a net is 100%, this means that this net switches at half the clock frequency. Below are some examples:

- The average toggle rate of a shift register is 100% as all flip-flop outputs toggle at half of the clock frequency.
- The average toggle rate of an 8-bit counter is 25%: •
  - Bit 0 (LSB) = 100%
  - Bit 1 = 50%
  - Bit 2 = 25%
  - ...
  - Bit 7 (MSB) = 0.78125%
  - Average toggle rate = (100% + 50% + 25% + 12.5% + ... + 0.78125%) / 8

#### **Enable Rate Definition**

Output enable rate is the average percentage of time during which tristate outputs are enabled. When nontristate output buffers are used, the enable rate should be 100%.

#### Table 2-11 • Toggle Rate Guidelines Recommended for Power Calculation

Component	Definition	Guideline
α <sub>1</sub>	Toggle rate of VersaTile outputs	10%
α <sub>2</sub>	I/O buffer toggle rate	10%

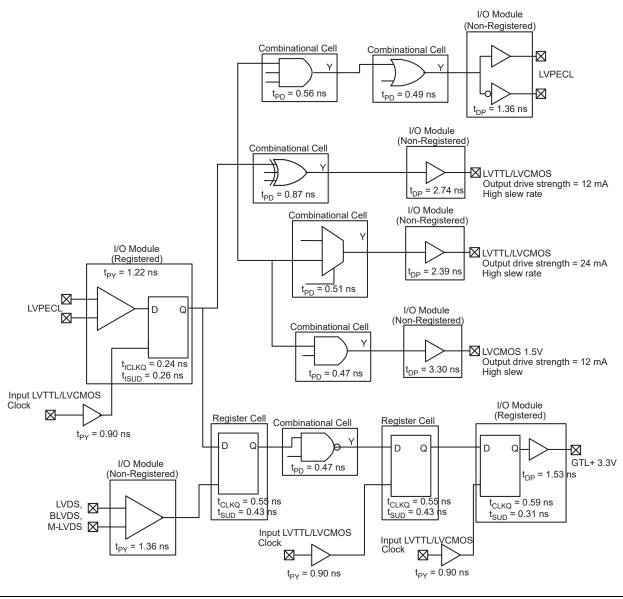
#### Table 2-12 • Enable Rate Guidelines Recommended for Power Calculation

Component	Component Definition				
β <sub>1</sub>	I/O output buffer enable rate	100%			
β <sub>2</sub>	RAM enable rate for read operations	12.5%			
$\beta_3$	RAM enable rate for write operations	12.5%			



## **User I/O Characteristics**

## **Timing Model**







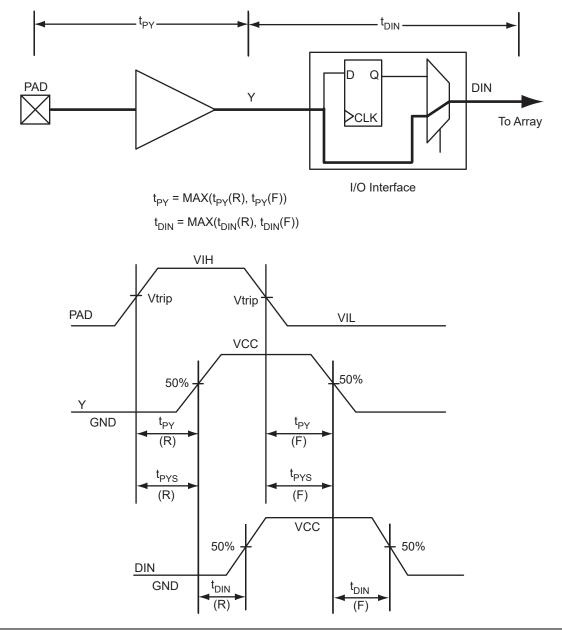


Figure 2-3 • Input Buffer Timing Model and Delays (example)

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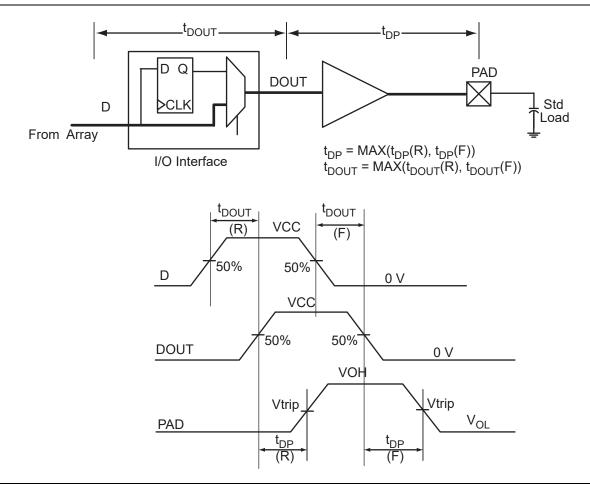
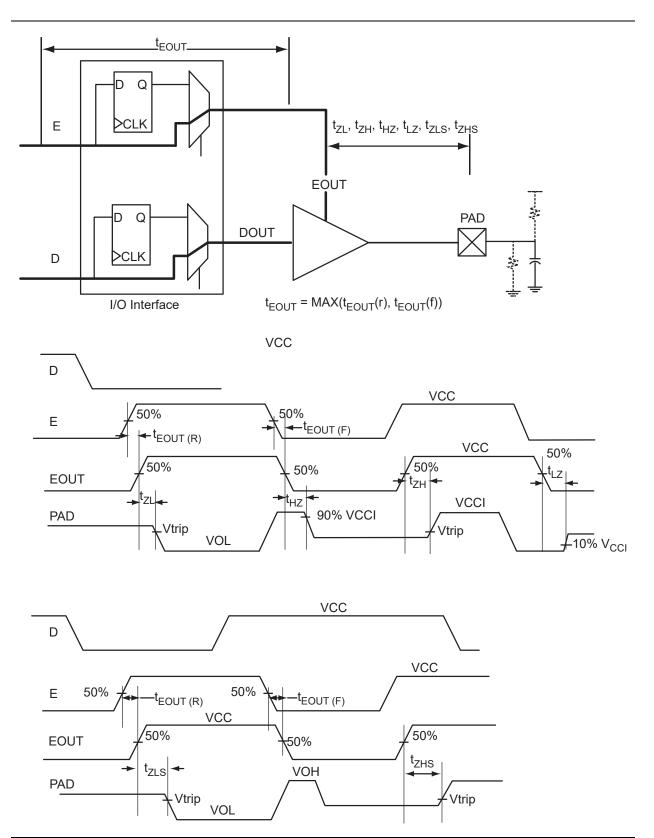


Figure 2-4 • Output Buffer Model and Delays (example)





*Figure 2-5* • Tristate Output Buffer Timing Model and Delays (example)

## **Overview of I/O Performance**

## Summary of I/O DC Input and Output Levels – Default I/O Software Settings

		Equivalent			VIL	VIH		VOL	VOH	IOL <sup>3</sup>	IOH <sup>3</sup>
I/O Standard	Drive Strength		Slew Rate	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA
3.3 V LVTTL / 3.3 V LVCMOS	12 mA	12 mA	High	-0.3	0.8	2	3.6	0.4	2.4	12	12
3.3 V LVCMOS Wide Range	100 µA	12 mA	High	-0.3	0.8	2	3.6	0.2	VCCI – 0.2	0.1	0.1
2.5 V LVCMOS	12 mA	12 mA	High	-0.3	0.7	1.7	3.6	0.7	1.7	12	12
1.8 V LVCMOS	12 mA	12 mA	High	-0.3	0.35 * VCCI	0.65 * VCCI	3.6	0.45	VCCI – 0.45	12	12
1.5 V LVCMOS	12 mA	12 mA	High	-0.3	0.30 * VCCI	0.7 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	12	12
3.3 V PCI		Per PCI Specification									
3.3 V PCI-X					Per PC	-X Specificati	on				
3.3 V GTL	20 mA <sup>2</sup>	20 mA <sup>2</sup>	High	-0.3	VREF – 0.05	VREF + 0.05	3.6	0.4	_	20	20
2.5 V GTL	20 mA <sup>2</sup>	20 mA <sup>2</sup>	High	-0.3	VREF – 0.05	VREF + 0.05	3.6	0.4	_	20	20
3.3 V GTL+	35 mA	35 mA	High	-0.3	VREF – 0.1	VREF + 0.1	3.6	0.6	-	35	35
2.5 V GTL+	33 mA	33 mA	High	-0.3	VREF – 0.1	VREF + 0.1	3.6	0.6	-	33	33
HSTL (I)	8 mA	8 mA	High	-0.3	VREF – 0.1	VREF + 0.1	3.6	0.4	VCCI - 0.4	8	8
HSTL (II)	15 mA <sup>2</sup>	15 mA <sup>2</sup>	High	-0.3	VREF – 0.1	VREF + 0.1	3.6	0.4	VCCI – 0.4	15	15
SSTL2 (I)	15 mA	15 mA	High	-0.3	VREF – 0.2	VREF + 0.2	3.6	0.54	VCCI – 0.62	15	15
SSTL2 (II)	18 mA	18 mA	High	-0.3	VREF – 0.2	VREF + 0.2	3.6	0.35	VCCI – 0.43	18	18
SSTL3 (I)	14 mA	14 mA	High	-0.3	VREF – 0.2	VREF + 0.2	3.6	0.7	VCCI – 1.1	14	14
SSTL3 (II)	21 mA	21 mA	High	-0.3	VREF – 0.2	VREF + 0.2	3.6	0.5	VCCI - 0.9	21	21

 Table 2-13 • Summary of Maximum and Minimum DC Input and Output Levels

 Applicable to Commercial and Industrial Conditions

Notes:

 The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is ±100 μA. Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.

2. Output drive strength is below JEDEC specification.

3. Currents are measured at 85°C junction temperature.

 Output Slew Rates can be extracted from IBIS Models, located at http://www.microsemi.com/index.php?option=com\_content&id=1671&lang=en&view=article.

	Comm	ercial <sup>1</sup>	Indus	strial <sup>2</sup>
	IIL <sup>3</sup>	IIH <sup>4</sup>	IIL <sup>3</sup>	IIH <sup>4</sup>
DC I/O Standards	μΑ	μΑ	μΑ	μΑ
3.3 V LVTTL / 3.3 V LVCMOS	10	10	15	15
3.3 V LVCMOS Wide Range	10	10	15	15
2.5 V LVCMOS	10	10	15	15
1.8 V LVCMOS	10	10	15	15
1.5 V LVCMOS	10	10	15	15
3.3 V PCI	10	10	15	15
3.3 V PCI-X	10	10	15	15
3.3 V GTL	10	10	15	15
2.5 V GTL	10	10	15	15
3.3 V GTL+	10	10	15	15
2.5 V GTL+	10	10	15	15
HSTL (I)	10	10	15	15
HSTL (II)	10	10	15	15
SSTL2 (I)	10	10	15	15
SSTL2 (II)	10	10	15	15
SSTL3 (I)	10	10	15	15
SSTL3 (II)	10	10	15	15

# Table 2-14 • Summary of Maximum and Minimum DC Input Levels Applicable to Commercial and Industrial Conditions

Notes:

1. Commercial range ( $0^{\circ}C < T_A < 70^{\circ}C$ )

2. Industrial range ( $-40^{\circ}C < T_A < 85^{\circ}C$ )

3. IIL is the input leakage current per I/O pin over recommended operation conditions where –0.3 V < VIN < VIL.

4. IIH is the input leakage current per I/O pin over recommended operating conditions VIH < VIN < VCCI. Input current is larger when operating outside recommended ranges.

## Summary of I/O Timing Characteristics – Default I/O Software Settings

Standard	Input Reference Voltage (VREF_TYP)	Board Termination Voltage (VTT_REF)	Measuring Trip Point (Vtrip)
3.3 V LVTTL / 3.3 V LVCMOS	_	-	1.4 V
3.3 V LVCMOS Wide Range	-	-	1.4 V
2.5 V LVCMOS	-	-	1.2 V
1.8 V LVCMOS	-	-	0.90 V
1.5 V LVCMOS	-	-	0.75 V
3.3 V PCI	_	_	0.285 * VCCI (RR) 0.615 * VCCI (FF))
3.3 V PCI-X	_	_	0.285 * VCCI (RR) 0.615 * VCCI (FF)
3.3 V GTL	0.8 V	1.2 V	VREF
2.5 V GTL	0.8 V	1.2 V	VREF
3.3 V GTL+	1.0 V	1.5 V	VREF
2.5 V GTL+	1.0 V	1.5 V	VREF
HSTL (I)	0.75 V	0.75 V	VREF
HSTL (II)	0.75 V	0.75 V	VREF
SSTL2 (I)	1.25 V	1.25 V	VREF
SSTL2 (II)	1.25 V	1.25 V	VREF
SSTL3 (I)	1.5 V	1.485 V	VREF
SSTL3 (II)	1.5 V	1.485 V	VREF
LVDS	-	-	Cross point
LVPECL	-	-	Cross point

#### Table 2-15 • Summary of AC Measuring Points

#### Table 2-16 • I/O AC Parameter Definitions

Parameter	Definition
t <sub>DP</sub>	Data to Pad delay through the Output Buffer
t <sub>PY</sub>	Pad to Data delay through the Input Buffer with Schmitt trigger disabled
t <sub>DOUT</sub>	Data to Output Buffer delay through the I/O interface
t <sub>EOUT</sub>	Enable to Output Buffer Tristate Control delay through the I/O interface
t <sub>DIN</sub>	Input Buffer to Data delay through the I/O interface
t <sub>PYS</sub>	Pad to Data delay through the Input Buffer with Schmitt trigger enabled
t <sub>HZ</sub>	Enable to Pad delay through the Output Buffer—High to Z
t <sub>ZH</sub>	Enable to Pad delay through the Output Buffer—Z to High
t <sub>LZ</sub>	Enable to Pad delay through the Output Buffer—Low to Z
t <sub>ZL</sub>	Enable to Pad delay through the Output Buffer—Z to Low
t <sub>ZHS</sub>	Enable to Pad delay through the Output Buffer with delayed enable—Z to High
t <sub>ZLS</sub>	Enable to Pad delay through the Output Buffer with delayed enable—Z to Low

#### Table 2-17 • Summary of I/O Timing Characteristics—Software Default Settings -2 Speed Grade, Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V

		CCI = 3.0 V															
I/O Standard	Drive Strength (mA)	Equivalent Software Default Drive Strength Option) <sup>1</sup>	Slew Rate	Capacitive Load (pF)	External Resistor $(\Omega)$	t <sub>bour</sub> (ns)	t <sub>DP</sub> (ns)	t <sub>DIN</sub> (ns)	t <sub>pY</sub> (ns)	t <sub>PYS</sub> (ns)	t <sub>EOUT</sub> (ns)	t <sub>ZL</sub> (ns)	t <sub>ZH</sub> (ns)	t <sub>LZ</sub> (ns)	t <sub>HZ</sub> (ns)	t <sub>ZLS</sub> (ns)	t <sub>ZHS</sub> (ns)
3.3 V LVTTL / 3.3 V LVCMOS	12	12	High	35	Ι	0.49				1.17				2.45			3.81
3.3 V LVCMOS Wide Range <sup>2</sup>	100 µA	12	High	35	Ι	0.49	4.24	0.03	1.36	1.78	0.32	4.24	3.25	3.78	4.17	6.77	5.79
2.5 V LVCMOS	12	12	High	35	-	0.49	2.80	0.03	1.13	1.24	0.32	2.85	2.61	2.51	2.61	4.52	4.28
1.8 V LVCMOS	12	12	High	35	_	0.49	2.83	0.03	1.08	1.42	0.32	2.89	2.31	2.79	3.16	4.56	3.98
1.5 V LVCMOS	12	12	High	35	-	0.49	3.30	0.03	1.27	1.60	0.32	3.36	2.70	2.96	3.27	5.03	4.37
3.3 V PCI	Per PCI spec	-	High	10	25 <sup>3</sup>	0.49	2.09	0.03	0.78	1.17	0.32	2.13	1.49	2.45	2.70	3.80	3.16
3.3 V PCI-X	Per PCI-X spec	-	High	10	25 <sup>3</sup>	0.49	2.09	0.03	0.78	1.17	0.32	2.13	1.49	2.45	2.70	3.80	3.16
3.3 V GTL	20 <sup>4</sup>	-	High	10	25	0.45	1.55	0.03	2.19	-	0.32	1.52	1.55	-	-	3.19	3.22
2.5 V GTL	20 <sup>4</sup>	-	High	10	25	0.45	1.59	0.03	1.83	-	0.32	1.61	1.59	_	_	3.28	3.26
3.3 V GTL+	35	-	High	10	25	0.45	1.53	0.03	1.19	-	0.32	1.56	1.53	-	-	3.23	3.20
2.5 V GTL+	33	-	High	10	25	0.45	1.65	0.03	1.13	-	0.32	1.68	1.57	_	-	3.35	3.24
HSTL (I)	8	-	High	20	50	0.49	2.37	0.03	1.59	-	0.32	2.42	2.35	-	-	4.09	4.02
HSTL (II)	15 <sup>4</sup>	-	High	20	25	0.49	2.26	0.03	1.59	_	0.32	2.30	2.03	_	_	3.97	3.70
SSTL2 (I)	15	-	High	30	50	0.49	1.59	0.03	1.00	_	0.32	1.62	1.38	_	_	3.29	3.05
SSTL2 (II)	18	-	High	30	25	0.49	1.62	0.03	1.00	_	0.32	1.65	1.32	_	_	3.32	2.99
SSTL3 (I)	14	_	High	30	50	0.49	1.72	0.03	0.93	—	0.32	1.75	1.37	_	_	3.42	3.04
SSTL3 (II)	21	-	High	30	25	0.49	1.54	0.03	0.93	_	0.32	1.57	1.25	_	_	3.24	2.92
LVDS/B-LVDS/ M-LVDS	24	-	High	Ι	Ι	0.49	1.40	0.03	1.36	_	_	-	_	_	_	_	-
LVPECL	24	-	High	-	-	0.49	1.36	0.03	1.22	_	-	_	_	_	_	_	-

Notes:

1. The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is ±100 μA. Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.

2. All LVCMOS 3.3 V software macros support LVCMOS 3.3V wide range as specified in the JESD8b specification.

3. Resistance is used to measure I/O propagation delays as defined in PCI specifications. See Figure 2-11 on page 2-39 for connectivity. This resistor is not required during normal operation.

4. Output drive strength is below JEDEC specification.

5. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6.

## **Detailed I/O DC Characteristics**

#### Table 2-18 • Input Capacitance

Symbol	Definition	Conditions	Min.	Max.	Units
C <sub>IN</sub>	Input capacitance	VIN = 0, f = 1.0 MHz		8	pF
C <sub>INCLK</sub>	Input capacitance on the clock pin	VIN = 0, f = 1.0 MHz		8	pF

#### Table 2-19 • I/O Output Buffer Maximum Resistances<sup>1</sup>

Standard	Drive Strength	R <sub>PULL-DOWN</sub> (Ω) <sup>2</sup>	R <sub>PULL-UP</sub> (Ω) <sup>3</sup>
3.3 V LVTTL / 3.3 V LVCMOS	4 mA	100	300
	8 mA	50	150
	12 mA	25	75
	16 mA	17	50
	24 mA	11	33
3.3 V LVCMOS Wide Range	100 µA	Same as regular 3.3 V LVCMOS	Same as regular 3.3 V LVCMOS
2.5 V LVCMOS	4 mA	100	200
	8 mA	50	100
	12 mA	25	50
	16 mA	20	40
	24 mA	11	22
1.8 V LVCMOS	2 mA	200	225
	4 mA	100	112
	6 mA	50	56
	8 mA	50	56
	12 mA	20	22
	16 mA	20	22
1.5 V LVCMOS	2 mA	200	224
	4 mA	100	112
	6 mA	67	75
	8 mA	33	37
	12 mA	33	37
3.3 V PCI/PCI-X	Per PCI/PCI-X specification	25	75
3.3 V GTL	20 mA <sup>4</sup>	11	-
2.5 V GTL	20 mA <sup>4</sup>	14	_

Notes:

- These maximum values are provided for informational reasons only. Minimum output buffer resistance values depend on VCCI, drive strength selection, temperature, and process. For board design considerations and detailed output buffer resistances, use the corresponding IBIS models located on the Microsemi SoC Products Group website at www.microsemi.com/index.php?option=com\_content&id=1671&lang=en&view=article.
- 2. R<sub>(PULL-DOWN-MAX)</sub> = (VOLspec) / IOLspec
- 3. R<sub>(PULL-UP-MAX)</sub> = (VCCImax VOHspec) / IOHspec
- 4. Output drive strength is below JEDEC specification.

Standard	Drive Strength	R <sub>PULL-DOWN</sub> (Ω) <sup>2</sup>	$R_{PULL-UP}$ (Ω) <sup>3</sup>
3.3 V GTL+	35 mA	12	-
2.5 V GTL+	33 mA	15	-
HSTL (I)	8 mA	50	50
HSTL (II)	15 mA <sup>4</sup>	25	25
SSTL2 (I)	15 mA	27	31
SSTL2 (II)	18 mA	13	15
SSTL3 (I)	14 mA	44	69
SSTL3 (II)	21 mA	18	32

#### Table 2-19 • I/O Output Buffer Maximum Resistances<sup>1</sup> (continued)

Notes:

1. These maximum values are provided for informational reasons only. Minimum output buffer resistance values depend on VCCI, drive strength selection, temperature, and process. For board design considerations and detailed output buffer resistances, use the corresponding IBIS models located on the Microsemi SoC Products Group website at

www.microsemi.com/index.php?option=com\_content&id=1671&lang=en&view=article.

- 2. R<sub>(PULL-DOWN-MAX)</sub> = (VOLspec) / IOLspec
- 3. R<sub>(PULL-UP-MAX)</sub> = (VCCImax VOHspec) / IOHspec
- 4. Output drive strength is below JEDEC specification.

#### Table 2-20 • I/O Weak Pull-Up/Pull-Down Resistances Minimum and Maximum Weak Pull-Up/Pull-Down Resistance Values

		Ω)	R <sub>(WEAK PULL-DOWN)</sub> <sup>2</sup> (Ω)		
VCCI	Min.	Max.	Min.	Max.	
3.3 V	10 k	45 k	10 k	45 k	
3.3 V (Wide Range I/Os)	10 k	45 k	10 k	45 k	
2.5 V	11 k	55 k	12 k	74 k	
1.8 V	18 k	70 k	17 k	110 k	
1.5 V	19 k	90 k	19 k	140 k	

Notes:

1. R<sub>(WEAK PULL-UP-MAX)</sub> = (VCCImax – VOHspec) / I<sub>(WEAK PULL-UP-MIN)</sub>

2. R(WEAK PULL-DOWN-MAX) = (VOLspec) / I(WEAK PULL-DOWN-MIN)

#### Table 2-21 • I/O Short Currents IOSH/IOSL

	Drive Strength	IOSH (mA)*	IOSL (mA)*
3.3 V LVTTL / 3.3 V LVCMOS	2 mA	25	27
	4 mA	25	27
	6 mA	51	54
	8 mA	51	54
	12 mA	103	109
	16 mA	132	127
	24 mA	268	181
3.3 V LVCMOS Wide Range	100 µA	Same as regular 3.3 V LVCMOS	Same as regular 3.3 V LVCMOS
2.5 V LVCMOS	4 mA	16	18
	8 mA	32	37
	12 mA	65	74
	16 mA	83	87
	24 mA	169	124
1.8 V LVCMOS	2 mA	9	11
	4 mA	17	22
	6 mA	35	44
	8 mA	45	51
	12 mA	91	74
	16 mA	91	74
1.5 V LVCMOS	2 mA	13	16
	4 mA	25	33
	6 mA	32	39
	8 mA	66	55
	12 mA	66	55

Notes:

1.  $T_J = 100^{\circ}C$ 

2. Applicable to 3.3 V LVCMOS Wide Range. IOSL/IOSH dependent on the I/O buffer drive strength selected for wide range applications. All LVCMOS 3.3 V software macros support LVCMOS 3.3 V wide range as specified in the JESD8b specification.

The length of time an I/O can withstand IOSH/IOSL events depends on the junction temperature. The reliability data below is based on a 3.3 V, 36 mA I/O setting, which is the worst case for this type of analysis.

For example, at 100°C, the short current condition would have to be sustained for more than six months to cause a reliability concern. The I/O design does not contain any short circuit protection, but such protection would only be needed in extremely prolonged stress conditions.

Table 2-22 • Duration of	Short Circuit	<b>Event Before Failure</b>
--------------------------	---------------	-----------------------------

Temperature	Time before Failure
-40°C	> 20 years
0°C	> 20 years
25°C	> 20 years
70°C	5 years

#### Table 2-22 • Duration of Short Circuit Event Before Failure (continued)

Temperature	Time before Failure			
85°C	2 years			
100°C	6 months			

## Table 2-23 • Schmitt Trigger Input Hysteresis

Hysteresis Voltage Value (typ.) for Schmitt Mode Input Buffers

Input Buffer Configuration	Hysteresis Value (typ.)
3.3 V LVTTL/LVCMOS/PCI/PCI-X (Schmitt trigger mode)	240 mV
2.5 V LVCMOS (Schmitt trigger mode)	140 mV
1.8 V LVCMOS (Schmitt trigger mode)	80 mV
1.5 V LVCMOS (Schmitt trigger mode)	60 mV

#### Table 2-24 • I/O Input Rise Time, Fall Time, and Related I/O Reliability\*

Input Buffer	Input Rise/Fall Time (min.)	Input Rise/Fall Time (max.)	Reliability
LVTTL/LVCMOS (Schmitt trigger disabled)	No requirement	10 ns *	20 years (110°C)
LVTTL/LVCMOS (Schmitt trigger enabled)		No requirement, but input noise voltage cannot exceed Schmitt hysteresis.	- 5
HSTL/SSTL/GTL	No requirement	10 ns *	10 years (100°C)
LVDS/B-LVDS/M-LVDS/ LVPECL	No requirement	10 ns *	10 years (100°C)

Note: \*For clock signals and similar edge-generating signals, refer to the "ProASIC3/E SSO and Pin Placement Guidelines" chapter of the ProASIC3E FPGA Fabric User's Guide. The maximum input rise/fall time is related to the noise induced into the input buffer trace. If the noise is low, then the rise time and fall time of input buffers can be increased beyond the maximum value. The longer the rise/fall times, the more susceptible the input signal is to the board noise. Microsemi recommends signal integrity evaluation/characterization of the system to ensure that there is no excessive noise coupling into input signals.

## **Single-Ended I/O Characteristics**

## 3.3 V LVTTL / 3.3 V LVCMOS

Low-Voltage Transistor–Transistor Logic is a general-purpose standard (EIA/JESD) for 3.3 V applications. It uses an LVTTL input buffer and push-pull output buffer. The 3.3 V LVCMOS standard is supported as part of the 3.3 V LVTTL support.

3.3 V LVTTL / 3.3 V LVCMOS	v	ïL	v	ΊН	VOL	VОН	IOL	юн	IOSL	IOSH	IIL <sup>1</sup>	IIH <sup>2</sup>
Drive Strength	Min. V	Max. V	Min., V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>3</sup>	Max. mA <sup>3</sup>	μA <sup>4</sup>	μA <sup>4</sup>
2 mA	-0.3	0.8	2	3.6	0.4	2.4	4	4	27	25	10	10
4 mA	-0.3	0.8	2	3.6	0.4	2.4	4	4	27	25	10	10
6 mA	-0.3	0.8	2	3.6	0.4	2.4	8	8	54	51	10	10
8 mA	-0.3	0.8	2	3.6	0.4	2.4	8	8	54	51	10	10
12 mA	-0.3	0.8	2	3.6	0.4	2.4	12	12	109	103	10	10
16 mA	-0.3	0.8	2	3.6	0.4	2.4	16	16	127	132	10	10
24 mA	-0.3	0.8	2	3.6	0.4	2.4	24	24	181	268	10	10

#### Table 2-25 • Minimum and Maximum DC Input and Output Levels

Notes:

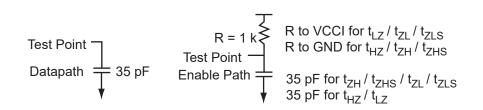
1. IIL is the input leakage current per I/O pin over recommended operation conditions where –0.3 V< VIN < VIL.

2. IIH is the input leakage current per I/O pin over recommended operating conditions VIH < VIN< VCCI. Input current is larger when operating outside recommended ranges.

3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

4. Currents are measured at 85°C junction temperature.

5. Software default selection highlighted in gray.



#### Figure 2-6 • AC Loading

#### Table 2-26 • 3.3 V LVTTL / 3.3 V LVCMOS AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	C <sub>LOAD</sub> (pF)
0	3.3	1.4	-	35

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

Drive	Speed			· · · · ·	· · · · ·					· · · · ·	· · · · ·			İ
Strength	Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
2 mA	Std.	0.66	7.88	0.04	1.20	1.57	0.43	8.03	6.70	2.69	2.59	10.26	8.94	ns
	-1	0.56	6.71	0.04	1.02	1.33	0.36	6.83	5.70	2.29	2.20	8.73	7.60	ns
	-2	0.49.	5.89	0.03	0.90	1.17	0.32	6.00	5.01	2.01	1.93	7.67	6.67	ns
4 mA	Std.	0.66	7.88	0.04	1.20	1.57	0.43	8.03	6.70	2.69	2.59	10.26	8.94	ns
	-1	0.56	6.71	0.04	1.02	1.33	0.36	6.83	5.70	2.29	2.20	8.73	7.60	ns
	-2	0.49	5.89	0.03	0.90	1.17	0.32	6.00	5.01	2.01	1.93	7.67	6.67	ns
6 mA	Std.	0.66	5.08	0.04	1.20	1.57	0.43	5.17	4.14	3.05	3.21	7.41	6.38	ns
	-1	0.56	4.32	0.04	1.02	1.33	0.36	4.40	3.52	2.59	2.73	6.30	5.43	ns
	-2	0.49	3.79	0.03	0.90	1.17	0.32	3.86	3.09	2.28	2.40	5.53	4.76	ns
8 mA	Std.	0.66	5.08	0.04	1.20	1.57	0.43	5.17	4.14	3.05	3.21	7.41	6.38	ns
	-1	0.56	4.32	0.04	1.02	1.33	0.36	4.40	3.52	2.59	2.73	6.30	5.43	ns
	-2	0.49	3.79	0.03	0.90	1.17	0.32	3.86	3.09	2.28	2.40	5.53	4.76	ns
12 mA	Std.	0.66	3.67	0.04	1.20	1.57	0.43	3.74	2.87	3.28	3.61	5.97	5.11	ns
	-1	0.56	3.12	0.04	1.02	1.33	0.36	3.18	2.44	2.79	3.07	5.08	4.34	ns
	-2	0.49	2.74	0.03	0.90	1.17	0.32	2.79	2.14	2.45	2.70	4.46	3.81	ns
16 mA	Std.	0.66	3.46	0.04	1.20	1.57	0.43	3.53	2.61	3.33	3.72	5.76	4.84	ns
	-1	0.56	2.95	0.04	1.02	1.33	0.36	3.00	2.22	2.83	3.17	4.90	4.12	ns
	-2	0.49	2.59	0.03	0.90	1.17	0.32	2.63	1.95	2.49	2.78	4.30	3.62	ns
24 mA	Std.	0.66	3.21	0.04	1.20	1.57	0.43	3.27	2.16	3.39	4.13	5.50	4.39	ns
	-1	0.56	2.73	0.04	1.02	1.33	0.36	2.78	1.83	2.88	3.51	4.68	3.74	ns
	-2	0.49	2.39	0.03	0.90	1.17	0.32	2.44	1.61	2.53	3.08	4.11	3.28	ns

Table 2-27 • 3.3 V LVTTL / 3.3 V LVCMOS High Slew

Commercial-Case Conditions:  $T_J = 70^{\circ}$ C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V

Notes:

1. Software default selection highlighted in gray.

Table 2-28 • 3.3 V LVTTL / 3.3 V LVCMOS Low Slew Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V

Drive Strength	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zHS</sub>	Units
2 mA	Std.	0.66	11.01	0.04	1.20	1.57	0.43	11.21	9.05	2.69	2.44	13.45	11.29	ns
	-1	0.56	9.36	0.04	1.02	1.33	0.36	9.54	7.70	2.29	2.08	11.44	9.60	ns
	-2	0.49	8.22	0.03	0.90	1.17	0.32	8.37	6.76	2.01	1.82	10.04	8.43	ns
4 mA	Std.	0.66	11.01	0.04	1.20	1.57	0.43	11.21	9.05	2.69	2.44	13.45	11.29	ns
	-1	0.56	9.36	0.04	1.02	1.33	0.36	9.54	7.70	2.29	2.08	11.44	9.60	ns
	-2	0.49	8.22	0.03	0.90	1.17	0.32	8.37	6.76	2.01	1.82	10.04	8.43	ns
6 mA	Std.	0.66	7.86	0.04	1.20	1.57	0.43	8.01	6.44	3.04	3.06	10.24	8.68	ns
	-1	0.56	6.69	0.04	1.02	1.33	0.36	6.81	5.48	2.58	2.61	8.71	7.38	ns
	-2	0.49	5.87	0.03	0.90	1.17	0.32	5.98	4.81	2.27	2.29	7.65	6.48	ns
8 mA	Std.	0.66	7.86	0.04	1.20	1.57	0.43	8.01	6.44	3.04	3.06	10.24	8.68	ns
	-1	0.56	6.69	0.04	1.02	1.33	0.36	6.81	5.48	2.58	2.61	8.71	7.38	ns

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Drive Strength	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
	-2	0.49	5.87	0.03	0.90	1.17	0.32	5.98	4.81	2.27	2.29	7.65	6.48	ns
12 mA	Std.	0.66	6.03	0.04	1.20	1.57	0.43	6.14	5.02	3.28	3.47	8.37	7.26	ns
	-1	0.56	5.13	0.04	1.02	1.33	0.36	5.22	4.27	2.79	2.95	7.12	6.17	ns
	-2	0.49	4.50	0.03	0.90	1.17	0.32	4.58	3.75	2.45	2.59	6.25	5.42	ns
16 mA	Std.	0.66	5.62	0.04	1.20	1.57	0.43	5.72	4.72	3.32	3.58	7.96	6.96	ns
	-1	0.56	4.78	0.04	1.02	1.33	0.36	4.87	4.02	2.83	3.04	6.77	5.92	ns
	-2	0.49	4.20	0.03	0.90	1.17	0.32	4.27	3.53	2.48	2.67	5.94	5.20	ns
24 mA	Std.	0.66	5.24	0.04	1.20	1.57	0.43	5.34	4.69	3.39	3.96	7.58	6.93	ns
	-1	0.56	4.46	0.04	1.02	1.33	0.36	4.54	3.99	2.88	3.37	6.44	5.89	ns
	-2	0.49	3.92	0.03	0.90	1.17	0.32	3.99	3.50	2.53	2.96	5.66	5.17	ns

#### Table 2-28 • 3.3 V LVTTL / 3.3 V LVCMOS Low Slew Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V

## 3.3 V LVCMOS Wide Range

3.3 V LVCMOS Wide Range	Equivalent Software Default Drive	v	IL	v	ін	VOL	VOH	IOL	юн	IOSL	IOSH	IIL <sup>2</sup>	IIH <sup>3</sup>
Drive Strength	Strength Option <sup>1</sup>	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	μA	μA	Max. mA <sup>4</sup>	Max. mA <sup>4</sup>	μA <sup>5</sup>	μA <sup>5</sup>
100 µA	2 mA	-0.3	0.8	2	3.6	0.2	VDD – 0.2	100	100	27	25	10	10
100 µA	4 mA	-0.3	0.8	2	3.6	0.2	VDD – 0.2	100	100	27	25	10	10
100 µA	6 mA	-0.3	0.8	2	3.6	0.2	VDD – 0.2	100	100	54	51	10	10
100 µA	8 mA	-0.3	0.8	2	3.6	0.2	VDD – 0.2	100	100	54	51	10	10
100 µA	12 mA	-0.3	0.8	2	3.6	0.2	VDD – 0.2	100	100	109	103	10	10
100 µA	16 mA	-0.3	0.8	2	3.6	0.2	VDD – 0.2	100	100	127	132	10	10
100 µA	24 mA	-0.3	0.8	2	3.6	0.2	VDD – 0.2	100	100	181	268	10	10

#### Table 2-29 • Minimum and Maximum DC Input and Output Levels

Notes:

1. The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is ±100 µA. Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.

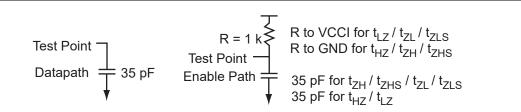
2. IIL is the input leakage current per I/O pin over recommended operation conditions where -0.3 V < VIN < VIL.

3. IIH is the input leakage current per I/O pin over recommended operating conditions VIH < VIN< VCCI. Input current is larger when operating outside recommended ranges.

4. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

5. Currents are measured at 85°C junction temperature.

6. Software default selection highlighted in gray.



#### Figure 2-7 • AC Loading

#### Table 2-30 • 3.3 V LVCMOS Wide Range AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	C <sub>LOAD</sub> (pF)
0	3.3	1.4	-	35

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

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#### Table 2-31 • 3.3 V LVCMOS Wide Range High Slew Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.7 V

Drive Strength	Equivalent Software Default Drive Strength Option <sup>1</sup>	Speed Grade	t <sub>dout</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>eout</sub>	t <sub>zL</sub>	t <sub>ZH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zhs</sub>	Units
100 µA	4 mA	Std.	0.66	12.19	0.04	1.83		0.43	12.19	10.17	4.16	4.00		13.57	ns
		-1	0.56	10.37	0.04	1.55	2.02	0.36	10.37	8.66	3.54	3.41	13.26	11.54	ns
		-2	0.49	9.10	0.03	1.36	1.78	0.32	9.10	7.60	3.11	2.99	11.64	10.13	ns
100 µA	8 mA	Std.	0.66	7.85	0.04	1.83	2.38	0.43	7.85	6.29	4.71	4.97	11.24	9.68	ns
		-1	0.56	6.68	0.04	1.55	2.02	0.36	6.68	5.35	4.01	4.22	9.57	8.24	ns
		-2	0.49	5.86	0.03	1.36	1.78	0.32	5.86	4.70	3.52	3.71	8.40	7.23	ns
100 µA	12 mA	Std.	0.66	5.67	0.04	1.83	2.38	0.43	5.67	4.36	5.06	5.59	9.07	7.75	ns
		-1	0.56	4.82	0.04	1.55	2.02	0.36	4.82	3.71	4.31	4.75	7.71	6.59	ns
		-2	0.49	4.24	0.03	1.36	1.78	0.32	4.24	3.25	3.78	4.17	6.77	5.79	ns
100 µA	16 mA	Std.	0.66	5.35	0.04	1.83	2.38	0.43	5.35	3.96	5.15	5.76	8.75	7.35	ns
		-1	0.56	4.55	0.04	1.55	2.02	0.36	4.55	3.36	4.38	4.90	7.44	6.25	ns
		-2	0.49	4.00	0.03	1.36	1.78	0.32	4.00	2.95	3.85	4.30	6.53	5.49	ns
100 µA	24 mA	Std.	0.66	4.96	0.04	1.83	2.38	0.43	4.96	3.27	5.23	6.38	8.35	6.67	ns
		-1	0.56	4.22	0.04	1.55	2.02	0.36	4.22	2.78	4.45	5.43	7.11	5.67	ns
		-2	0.49	3.70	0.03	1.36	1.78	0.32	3.70	2.44	3.91	4.76	6.24	4.98	ns

Notes:

 The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is ±100 μA. Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.

2. Software default selection highlighted in gray.

Drive	Equivalent Software Default Drive Strength	Speed		_											
Strength	Option <sup>1</sup>	Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>eout</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zHS</sub>	Units
100 µA	4 mA	Std.	0.66	17.02	0.04	1.83	2.38	0.43	17.02	13.74	4.16	3.78	20.42	17.14	ns
		-1	0.56	14.48	0.04	1.55	2.02	0.36	14.48	11.69	3.54	3.21	17.37	14.58	ns
		-2	0.49	12.71	0.03	1.36	1.78	0.32	12.71	10.26	3.11	2.82	15.25	12.80	ns
100 µA	8 mA	Std.	0.66	12.16	0.04	1.83	2.38	0.43	12.16	9.78	4.70	4.74	15.55	13.17	ns
		-1	0.56	10.34	0.04	1.55	2.02	0.36	10.34	8.32	4.00	4.03	13.23	11.20	ns
		-2	0.49	9.08	0.03	1.36	1.78	0.32	9.08	7.30	3.51	3.54	11.61	9.84	ns
100µA	12 mA	Std.	0.66	9.32	0.04	1.83	2.38	0.43	9.32	7.62	5.06	5.36	12.71	11.02	ns
		-1	0.56	7.93	0.04	1.55	2.02	0.36	7.93	6.48	4.31	4.56	10.81	9.37	ns
		-2	0.49	6.96	0.03	1.36	1.78	0.32	6.96	5.69	3.78	4.00	9.49	8.23	ns
100 µA	16 mA	Std.	0.66	8.69	0.04	1.83	2.38	0.43	8.69	7.17	5.14	5.53	12.08	10.57	ns
		-1	0.56	7.39	0.04	1.55	2.02	0.36	7.39	6.10	4.37	4.71	10.28	8.99	ns
		-2	0.49	6.49	0.03	1.36	1.78	0.32	6.49	5.36	3.83	4.13	9.02	7.89	ns
100 µA	24 mA	Std.	0.66	8.11	0.04	1.83	2.38	0.43	8.11	7.13	5.23	6.13	11.50	10.52	ns
		-1	0.56	6.90	0.04	1.55	2.02	0.36	6.90	6.06	4.45	5.21	9.78	8.95	ns
		-2	0.49	6.05	0.03	1.36	1.78	0.32	6.05	5.32	3.91	4.57	8.59	7.86	ns

Table 2-32 • 3.3 V LVCMOS Wide Range Low Slew Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.7 V

Notes:

The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is ±100 μA. Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.
 Software default selection highlighted in grav.

2. Software default selection highlighted in gray.

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## 2.5 V LVCMOS

Low-Voltage CMOS for 2.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 2.5 V applications.

2.5 V LVCMOS	v	ΊL	v	н	VOL	VОН	IOL	юн	IOSL	IOSH	IIL¹	IIH <sup>2</sup>
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max., V	Min. V	mA	mA	Max. mA <sup>3</sup>	Max. mA <sup>3</sup>	μA <sup>4</sup>	μA <sup>4</sup>
4 mA	-0.3	0.7	1.7	3.6	0.7	1.7	4	4	18	16	10	10
8 mA	-0.3	0.7	1.7	3.6	0.7	1.7	8	8	37	32	10	10
12 mA	-0.3	0.7	1.7	3.6	0.7	1.7	12	12	74	65	10	10
16 mA	-0.3	0.7	1.7	3.6	0.7	1.7	16	16	87	83	10	10
24 mA	-0.3	0.7	1.7	3.6	0.7	1.7	24	24	124	169	10	10

Table 2-33 • Minimum and Maximum DC Input and Output Levels

Notes:

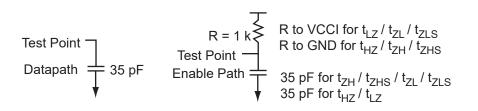
1. IIL is the input leakage current per I/O pin over recommended operation conditions where -0.3 V < VIN < VIL.

2. IIH is the input leakage current per I/O pin over recommended operating conditions VIH < VIN < VCCI. Input current is larger when operating outside recommended ranges.

3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

4. Currents are measured at 85°C junction temperature.

5. Software default selection highlighted in gray.



#### Figure 2-8 • AC Loading

#### Table 2-34 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	C <sub>LOAD</sub> (pF)
0	2.5	1.2	_	35

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### Table 2-35 • 2.5 V LVCMOS High Slew

Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.3 V

Drive Strength	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
4 mA	Std.	0.66	8.82	0.04	1.51	1.66	0.43	8.13	8.82	2.72	2.29	10.37	11.05	ns
	-1	0.56	7.50	0.04	1.29	1.41	0.36	6.92	7.50	2.31	1.95	8.82	9.40	ns
	-2	0.49	6.58	0.03	1.13	1.24	0.32	6.07	6.58	2.03	1.71	7.74	8.25	ns
8 mA	Std.	0.66	5.27	0.04	1.51	1.66	0.43	5.27	5.27	3.10	3.03	7.50	7.51	ns
	-1	0.56	4.48	0.04	1.29	1.41	0.36	4.48	4.48	2.64	2.58	6.38	6.38	ns
	-2	0.49	3.94	0.03	1.13	1.24	0.32	3.93	3.94	2.32	2.26	5.60	5.61	ns
12 mA	Std.	0.66	3.74	0.04	1.51	1.66	0.43	3.81	3.49	3.37	3.49	6.05	5.73	ns
	-1	0.56	3.18	0.04	1.29	1.41	0.36	3.24	2.97	2.86	2.97	5.15	4.87	ns
	-2	0.49	2.80	0.03	1.13	1.24	0.32	2.85	2.61	2.51	2.61	4.52	4.28	ns
16 mA	Std.	0.66	3.53	0.04	1.51	1.66	0.43	3.59	3.12	3.42	3.62	5.83	5.35	ns
	-1	0.56	3.00	0.04	1.29	1.41	0.36	3.06	2.65	2.91	3.08	4.96	4.55	ns
	-2	0.49	2.63	0.03	1.13	1.24	0.32	2.68	2.33	2.56	2.71	4.35	4.00	ns
24 mA	Std.	0.66	3.26	0.04	1.51	1.66	0.43	3.32	2.48	3.49	4.11	5.56	4.72	ns
	-1	0.56	2.77	0.04	1.29	1.41	0.36	2.83	2.11	2.97	3.49	4.73	4.01	ns
	-2	0.49	2.44	0.03	1.13	1.24	0.32	2.48	1.85	2.61	3.07	4.15	3.52	ns

Notes:

1. Software default selection highlighted in gray.

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			i	1	-				i	1		i		1
Drive Strength	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
4 mA	Std.	0.66	12.00	0.04	1.51	1.66	0.43	12.23	11.61	2.72	2.20	14.46	13.85	ns
	-1	0.56	10.21	0.04	1.29	1.41	0.36	10.40	9.88	2.31	1.87	12.30	11.78	ns
	-2	0.49	8.96	0.03	1.13	1.24	0.32	9.13	8.67	2.03	1.64	10.80	10.34	ns
8 mA	Std.	0.66	8.73	0.04	1.51	1.66	0.43	8.89	8.01	3.10	2.93	11.13	10.25	ns
	-1	0.56	7.43	0.04	1.29	1.41	0.36	7.57	6.82	2.64	2.49	9.47	8.72	ns
	-2	0.49	6.52	0.03	1.13	1.24	0.32	6.64	5.98	2.32	2.19	8.31	7.65	ns
12 mA	Std.	0.66	6.77	0.04	1.51	1.66	0.43	6.90	6.11	3.37	3.39	9.14	8.34	ns
	-1	0.56	5.76	0.04	1.29	1.41	0.36	5.87	5.20	2.86	2.89	7.77	7.10	ns
	-2	0.49	5.06	0.03	1.13	1.24	0.32	5.15	4.56	2.51	2.53	6.82	6.23	ns
16 mA	Std.	0.66	6.31	0.04	1.51	1.66	0.43	6.42	5.73	3.42	3.52	8.66	7.96	ns
	-1	0.56	5.37	0.04	1.29	1.41	0.36	5.46	4.87	2.91	3.00	7.37	6.77	ns
	-2	0.49	4.71	0.03	1.13	1.24	0.32	4.80	4.28	2.56	2.63	6.47	5.95	ns
24 mA	Std.	0.66	5.93	0.04	1.51	1.66	0.43	6.04	5.70	3.49	4.00	8.28	7.94	ns
	-1	0.56	5.05	0.04	1.29	1.41	0.36	5.14	4.85	2.97	3.40	7.04	6.75	ns
	-2	0.49	4.43	0.03	1.13	1.24	0.32	4.51	4.26	2.61	2.99	6.18	5.93	ns

# Table 2-36 • 2.5 V LVCMOS Low Slew Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.3 V

## 1.8 V LVCMOS

Low-Voltage CMOS for 1.8 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.8 V applications. It uses a 1.8 V input buffer and a push-pull output buffer.

1.8 V LVCMOS		VIL	VIH		VOL	VOH	IOL	юн	IOSL	IOSH	IIL¹	IIH <sup>2</sup>
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>3</sup>	Max. mA <sup>3</sup>	μA <sup>4</sup>	μA <sup>4</sup>
2 mA	-0.3	0.35 * VCCI	0.65 * VCCI	3.6	0.45	VCCI-0.45	2	2	11	9	10	10
4 mA	-0.3	0.35 * VCCI	0.65 * VCCI	3.6	0.45	VCCI-0.45	4	4	22	17	10	10
6 mA	-0.3	0.35 * VCCI	0.65 * VCCI	3.6	0.45	VCCI-0.45	6	6	44	35	10	10
8 mA	-0.3	0.35 * VCCI	0.65 * VCCI	3.6	0.45	VCCI-0.45	8	8	51	45	10	10
12 mA	-0.3	0.35 * VCCI	0.65 * VCCI	3.6	0.45	VCCI-0.45	12	12	74	91	10	10
16 mA	-0.3	0.35 * VCCI	0.65 * VCCI	3.6	0.45	VCCI-0.45	16	16	74	91	10	10

Table 2-37 • Minimum and Maximum DC Input and Output Levels

Notes:

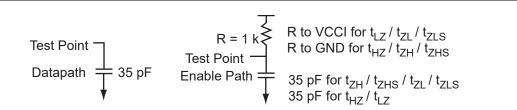
1. IIL is the input leakage current per I/O pin over recommended operation conditions where -0.3 V < VIN < VIL.

2. IIH is the input leakage current per I/O pin over recommended operating conditions VIH < VIN < VCCI. Input current is larger when operating outside recommended ranges.

3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

4. Currents are measured at 85°C junction temperature.

5. Software default selection highlighted in gray.



#### Figure 2-9 • AC Loading

#### Table 2-38 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	C <sub>LOAD</sub> (pF)
0	1.8	0.9	_	35

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

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#### **Timing Characteristics**

#### Table 2-39 • 1.8 V LVCMOS High Slew

Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 1.7 V

Drive	Speed													
Strength	Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zHS</sub>	Units
2 mA	Std.	0.66	12.10	0.04	1.45	1.91	0.43	9.59	12.10	2.78	1.64	11.83	14.34	ns
	-1	0.56	10.30	0.04	1.23	1.62	0.36	8.16	10.30	2.37	1.39	10.06	12.20	ns
	-2	0.49	9.04	0.03	1.08	1.42	0.32	7.16	9.04	2.08	1.22	8.83	10.71	ns
4 mA	Std.	0.66	7.05	0.04	1.45	1.91	0.43	6.20	7.05	3.25	2.86	8.44	9.29	ns
	-1	0.56	6.00	0.04	1.23	1.62	0.36	5.28	6.00	2.76	2.44	7.18	7.90	ns
	-2	0.49	5.27	0.03	1.08	1.42	0.32	4.63	5.27	2.43	2.14	6.30	6.94	ns
6 mA	Std.	0.66	4.52	0.04	1.45	1.91	0.43	4.47	4.52	3.57	3.47	6.70	6.76	ns
	-1	0.56	3.85	0.04	1.23	1.62	0.36	3.80	3.85	3.04	2.95	5.70	5.75	ns
	-2	0.49	3.38	0.03	1.08	1.42	0.32	3.33	3.38	2.66	2.59	5.00	5.05	ns
8 mA	Std.	0.66	4.12	0.04	1.45	1.91	0.43	4.20	3.99	3.63	3.62	6.43	6.23	ns
	-1	0.56	3.51	0.04	1.23	1.62	0.36	3.57	3.40	3.09	3.08	5.47	5.30	ns
	-2	0.49	3.08	0.03	1.08	1.42	0.32	3.14	2.98	2.71	2.71	4.81	4.65	ns
12 mA	Std.	0.66	3.80	0.04	1.45	1.91	0.43	3.87	3.09	3.73	4.24	6.10	5.32	ns
	-1	0.56	3.23	0.04	1.23	1.62	0.36	3.29	2.63	3.18	3.60	5.19	4.53	ns
	-2	0.49	2.83	0.03	1.08	1.42	0.32	2.89	2.31	2.79	3.16	4.56	3.98	ns
16 mA	Std.	0.66	3.80	0.04	1.45	1.91	0.43	3.87	3.09	3.73	4.24	6.10	5.32	ns
	-1	0.56	3.23	0.04	1.23	1.62	0.36	3.29	2.63	3.18	3.60	5.19	4.53	ns
	-2	0.49	2.83	0.03	1.08	1.42	0.32	2.89	2.31	2.79	3.16	4.56	3.98	ns

Notes:

1. Software default selection highlighted in gray.

Speed													
Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.66	15.84	0.04	1.45	1.91	0.43	15.65	15.84	2.78	1.58	17.89	18.07	ns
-1	0.56	13.47	0.04	1.23	1.62	0.36	13.31	13.47	2.37	1.35	15.22	15.37	ns
-2	0.49	11.83	0.03	1.08	1.42	0.32	11.69	11.83	2.08	1.18	13.36	13.50	ns
Std.	0.66	11.39	0.04	1.45	1.91	0.43	11.60	10.76	3.26	2.77	13.84	12.99	ns
-1	0.56	9.69	0.04	1.23	1.62	0.36	9.87	9.15	2.77	2.36	11.77	11.05	ns
-2	0.49	8.51	0.03	1.08	1.42	0.32	8.66	8.03	2.43	2.07	10.33	9.70	ns
Std.	0.66	8.97	0.04	1.45	1.91	0.43	9.14	8.10	3.57	3.36	11.37	10.33	ns
-1	0.56	7.63	0.04	1.23	1.62	0.36	7.77	6.89	3.04	2.86	9.67	8.79	ns
-2	0.49	6.70	0.03	1.08	1.42	0.32	6.82	6.05	2.66	2.51	8.49	7.72	ns
Std.	0.66	8.35	0.04	1.45	1.91	0.43	8.50	7.59	3.64	3.52	10.74	9.82	ns
-1	0.56	7.10	0.04	1.23	1.62	0.36	7.23	6.45	3.10	3.00	9.14	8.35	ns
-2	0.49	6.24	0.03	1.08	1.42	0.32	6.35	5.66	2.72	2.63	8.02	7.33	ns
Std.	0.66	7.94	0.04	1.45	1.91	0.43	8.09	7.56	3.74	4.11	10.32	9.80	ns
-1	0.56	6.75	0.04	1.23	1.62	0.36	6.88	6.43	3.18	3.49	8.78	8.33	ns
-2	0.49	5.93	0.03	1.08	1.42	0.32	6.04	5.65	2.79	3.07	7.71	7.32	ns
Std.	0.66	7.94	0.04	1.45	1.91	0.43	8.09	7.56	3.74	4.11	10.32	9.80	ns
-1	0.56	6.75	0.04	1.23	1.62	0.36	6.88	6.43	3.18	3.49	8.78	8.33	ns
-2	0.49	5.93	0.03	1.08	1.42	0.32	6.04	5.65	2.79	3.07	7.71	7.32	ns
	Std.         -1         -2         Std.	Grade         tDOUT           Std.         0.66           -1         0.56           -2         0.49           Std.         0.66           -1         0.56	Grade         t <sub>DOUT</sub> t <sub>DP</sub> Std.         0.66         15.84           -1         0.56         13.47           -2         0.49         11.83           Std.         0.66         11.39           -1         0.56         9.69           -1         0.56         9.69           -1         0.56         9.69           -2         0.49         8.51           Std.         0.66         8.97           -1         0.56         7.63           Std.         0.66         8.35           -1         0.56         7.10           Std.         0.66         8.35           -1         0.56         7.10           -2         0.49         6.24           Std.         0.66         7.94           Std.         0.66         7.94           -1         0.56         6.75           -2         0.49         5.93           Std.         0.66         7.94           -1         0.56         6.75	GradetDOUTtDPtDINStd.0.6615.840.04-10.5613.470.04-20.4911.830.03Std.0.6611.390.04-10.569.690.04-20.498.510.03Std.0.668.970.04-20.496.700.03Std.0.668.350.04-10.567.100.04-20.496.700.03Std.0.668.350.04-10.567.100.04-20.496.240.03Std.0.667.940.04-10.567.940.04-10.567.940.04-10.567.940.04-10.566.750.04-10.567.940.04-10.567.940.04	GradetDOUTtDPtDINtPYStd.0.6615.840.041.45-10.5613.470.041.23-20.4911.830.031.08Std.0.6611.390.041.45-10.569.690.041.23-20.498.510.031.08Std.0.668.970.041.23-20.498.510.031.08Std.0.668.970.041.23-10.567.630.041.23-20.496.700.031.08Std.0.668.350.041.45-10.567.100.041.23-20.496.240.031.08Std.0.667.940.041.45-10.566.750.041.23-20.495.930.031.08Std.0.667.940.041.45-10.566.750.041.23-20.495.930.031.08Std.0.667.940.041.45-10.566.750.041.45-10.566.750.041.45-10.566.750.041.45	Grade $t_{DOUT}$ $t_{DP}$ $t_{DIN}$ $t_{PY}$ $t_{PYS}$ Std.0.6615.840.041.451.91-10.5613.470.041.231.62-20.4911.830.031.081.42Std.0.6611.390.041.451.91-10.569.690.041.231.62-20.498.510.031.081.42Std.0.668.970.041.231.62-20.498.510.031.081.42Std.0.668.970.041.451.91-10.567.630.041.451.91-10.567.630.041.451.91-10.567.100.041.451.91-10.567.100.041.451.91-10.567.940.041.451.91-10.567.940.041.451.91-10.567.940.041.451.91-10.566.750.041.451.91-10.566.750.041.451.91-10.566.750.041.451.91-10.566.750.041.451.91-10.566.750.041.451.91-10.566.750.041.451.91-10.566.75 <t< td=""><td>Gradet<sub>DOUT</sub>t<sub>DP</sub>t<sub>DIN</sub>t<sub>PY</sub>t<sub>PYS</sub>t<sub>EOUT</sub>Std.0.6615.840.041.451.910.43-10.5613.470.041.231.620.36-20.4911.830.031.081.420.32Std.0.6611.390.041.451.910.43-10.569.690.041.231.620.36-20.498.510.031.081.420.32Std.0.668.970.041.451.910.43-10.567.630.041.451.910.43-10.567.630.041.451.910.43-10.567.630.041.451.910.43-10.567.630.041.451.910.43-10.567.100.031.081.420.32Std.0.668.350.041.451.910.43-10.567.100.041.451.910.43-10.566.750.041.451.910.43-10.566.750.041.451.910.43-10.566.750.041.451.910.43-10.566.750.041.451.910.43-10.566.750.041.451.910.43-10.566.750.04<!--</td--><td>Gradet<sub>DOUT</sub>t<sub>DP</sub>t<sub>DIN</sub>t<sub>PY</sub>t<sub>PYS</sub>t<sub>EOUT</sub>t<sub>ZL</sub>Std.0.6615.840.041.451.910.4315.65-10.5613.470.041.231.620.3613.31-20.4911.830.031.081.420.3211.69Std.0.6611.390.041.451.910.4311.60-10.569.690.041.231.620.369.87-10.569.690.041.231.620.369.87-20.498.510.031.081.420.328.66Std.0.668.970.041.451.910.439.14-10.567.630.041.451.910.439.14-10.567.630.041.451.910.438.60Std.0.668.350.041.451.910.438.50-10.567.100.041.451.910.438.50-10.567.940.041.451.910.438.09-10.566.750.041.231.620.366.88-20.495.930.031.081.420.326.04Std.0.667.940.041.451.910.438.09-10.566.750.041.231.620.366.88<t< td=""><td>Gradet_DOUTt_DPt_DINt_PYt_PYSt_EOUTt_ZLt_ZHStd.0.6615.840.041.451.910.4315.6515.84-10.5613.470.041.231.620.3613.3113.47-20.4911.830.031.081.420.3211.6911.83Std.0.6611.390.041.451.910.4311.6010.76-10.569.690.041.231.620.369.879.15-20.498.510.031.081.420.328.668.03Std.0.668.970.041.451.910.439.148.10-10.567.630.041.451.910.439.148.10-10.567.630.041.451.910.439.148.10-10.567.630.041.451.910.438.507.59-20.496.700.031.081.420.326.826.05Std.0.668.350.041.451.910.438.097.56-10.567.940.041.451.910.438.097.56-10.566.750.041.231.620.366.886.43-20.495.930.031.081.420.326.045.65Std.0.66</td><td>Gradet_DOUTt_DPt_DINt_PYt_PYSt_EOUTt_ZLt_ZHt_LZStd.0.6615.840.041.451.910.4315.6515.842.78-10.5613.470.041.231.620.3613.3113.472.37-20.4911.830.031.081.420.3211.6911.832.08Std.0.6611.390.041.451.910.4311.6010.763.26-10.569.690.041.231.620.369.879.152.77-20.498.510.031.081.420.328.668.032.43Std.0.668.970.041.451.910.439.148.103.57-10.567.630.041.451.910.439.148.103.57-10.567.630.041.451.910.439.148.103.57-10.567.630.041.451.910.438.507.593.64-20.496.700.031.081.420.326.826.052.66Std.0.668.350.041.451.910.438.097.563.74-20.496.240.031.081.420.326.355.662.72Std.0.667.940.041.451.910.43&lt;</td><td>Gradet<sub>DOUT</sub>t<sub>DP</sub>t<sub>DIN</sub>t<sub>PY</sub>t<sub>PYS</sub>t<sub>EOUT</sub>t<sub>ZL</sub>t<sub>ZH</sub>t<sub>LZ</sub>t<sub>HZ</sub>Std.0.6615.840.041.451.910.4315.6515.842.781.58-10.5613.470.041.231.620.3613.3113.472.371.35-20.4911.830.031.081.420.3211.6911.832.081.18Std.0.6611.390.041.451.910.4311.6010.763.262.77-10.569.690.041.231.620.369.879.152.772.36-20.498.510.031.081.420.328.668.032.432.07Std.0.668.970.041.451.910.439.148.103.573.36-10.567.630.041.451.910.439.148.103.573.36-10.567.630.041.231.620.367.776.893.042.86-20.496.700.031.081.420.326.826.052.662.51Std.0.668.350.041.451.910.438.507.593.643.10-10.567.940.041.451.910.438.097.563.744.11-10.566.750.04</td><td>GradetoouttoptointoptoptoptoptoptoptoptoptoptoptoptoptopStd.0.6615.840.041.451.910.4315.6515.842.781.5817.89-10.5613.470.041.231.620.3613.3113.472.371.3515.22-20.4911.830.031.081.420.3211.6911.832.081.1813.36Std.0.6611.390.041.451.910.4311.6010.763.262.7713.84-10.569.690.041.231.620.369.879.152.772.3611.77-20.498.510.031.081.420.328.668.032.432.0710.33Std.0.668.970.041.451.910.439.148.103.573.3611.37-10.567.630.041.451.910.439.148.103.573.669.67-20.496.700.031.081.420.326.826.052.662.518.49-10.567.600.041.451.910.438.507.593.643.5210.74-10.567.100.041.451.910.438.507.563.103.009.14&lt;</td><td>Gradetoouttoptontoptoptoptoouttz<thttd></thttd></td></t<></td></td></t<>	Gradet <sub>DOUT</sub> t <sub>DP</sub> t <sub>DIN</sub> t <sub>PY</sub> t <sub>PYS</sub> t <sub>EOUT</sub> Std.0.6615.840.041.451.910.43-10.5613.470.041.231.620.36-20.4911.830.031.081.420.32Std.0.6611.390.041.451.910.43-10.569.690.041.231.620.36-20.498.510.031.081.420.32Std.0.668.970.041.451.910.43-10.567.630.041.451.910.43-10.567.630.041.451.910.43-10.567.630.041.451.910.43-10.567.630.041.451.910.43-10.567.100.031.081.420.32Std.0.668.350.041.451.910.43-10.567.100.041.451.910.43-10.566.750.041.451.910.43-10.566.750.041.451.910.43-10.566.750.041.451.910.43-10.566.750.041.451.910.43-10.566.750.041.451.910.43-10.566.750.04 </td <td>Gradet<sub>DOUT</sub>t<sub>DP</sub>t<sub>DIN</sub>t<sub>PY</sub>t<sub>PYS</sub>t<sub>EOUT</sub>t<sub>ZL</sub>Std.0.6615.840.041.451.910.4315.65-10.5613.470.041.231.620.3613.31-20.4911.830.031.081.420.3211.69Std.0.6611.390.041.451.910.4311.60-10.569.690.041.231.620.369.87-10.569.690.041.231.620.369.87-20.498.510.031.081.420.328.66Std.0.668.970.041.451.910.439.14-10.567.630.041.451.910.439.14-10.567.630.041.451.910.438.60Std.0.668.350.041.451.910.438.50-10.567.100.041.451.910.438.50-10.567.940.041.451.910.438.09-10.566.750.041.231.620.366.88-20.495.930.031.081.420.326.04Std.0.667.940.041.451.910.438.09-10.566.750.041.231.620.366.88<t< td=""><td>Gradet_DOUTt_DPt_DINt_PYt_PYSt_EOUTt_ZLt_ZHStd.0.6615.840.041.451.910.4315.6515.84-10.5613.470.041.231.620.3613.3113.47-20.4911.830.031.081.420.3211.6911.83Std.0.6611.390.041.451.910.4311.6010.76-10.569.690.041.231.620.369.879.15-20.498.510.031.081.420.328.668.03Std.0.668.970.041.451.910.439.148.10-10.567.630.041.451.910.439.148.10-10.567.630.041.451.910.439.148.10-10.567.630.041.451.910.438.507.59-20.496.700.031.081.420.326.826.05Std.0.668.350.041.451.910.438.097.56-10.567.940.041.451.910.438.097.56-10.566.750.041.231.620.366.886.43-20.495.930.031.081.420.326.045.65Std.0.66</td><td>Gradet_DOUTt_DPt_DINt_PYt_PYSt_EOUTt_ZLt_ZHt_LZStd.0.6615.840.041.451.910.4315.6515.842.78-10.5613.470.041.231.620.3613.3113.472.37-20.4911.830.031.081.420.3211.6911.832.08Std.0.6611.390.041.451.910.4311.6010.763.26-10.569.690.041.231.620.369.879.152.77-20.498.510.031.081.420.328.668.032.43Std.0.668.970.041.451.910.439.148.103.57-10.567.630.041.451.910.439.148.103.57-10.567.630.041.451.910.439.148.103.57-10.567.630.041.451.910.438.507.593.64-20.496.700.031.081.420.326.826.052.66Std.0.668.350.041.451.910.438.097.563.74-20.496.240.031.081.420.326.355.662.72Std.0.667.940.041.451.910.43&lt;</td><td>Gradet<sub>DOUT</sub>t<sub>DP</sub>t<sub>DIN</sub>t<sub>PY</sub>t<sub>PYS</sub>t<sub>EOUT</sub>t<sub>ZL</sub>t<sub>ZH</sub>t<sub>LZ</sub>t<sub>HZ</sub>Std.0.6615.840.041.451.910.4315.6515.842.781.58-10.5613.470.041.231.620.3613.3113.472.371.35-20.4911.830.031.081.420.3211.6911.832.081.18Std.0.6611.390.041.451.910.4311.6010.763.262.77-10.569.690.041.231.620.369.879.152.772.36-20.498.510.031.081.420.328.668.032.432.07Std.0.668.970.041.451.910.439.148.103.573.36-10.567.630.041.451.910.439.148.103.573.36-10.567.630.041.231.620.367.776.893.042.86-20.496.700.031.081.420.326.826.052.662.51Std.0.668.350.041.451.910.438.507.593.643.10-10.567.940.041.451.910.438.097.563.744.11-10.566.750.04</td><td>GradetoouttoptointoptoptoptoptoptoptoptoptoptoptoptoptopStd.0.6615.840.041.451.910.4315.6515.842.781.5817.89-10.5613.470.041.231.620.3613.3113.472.371.3515.22-20.4911.830.031.081.420.3211.6911.832.081.1813.36Std.0.6611.390.041.451.910.4311.6010.763.262.7713.84-10.569.690.041.231.620.369.879.152.772.3611.77-20.498.510.031.081.420.328.668.032.432.0710.33Std.0.668.970.041.451.910.439.148.103.573.3611.37-10.567.630.041.451.910.439.148.103.573.669.67-20.496.700.031.081.420.326.826.052.662.518.49-10.567.600.041.451.910.438.507.593.643.5210.74-10.567.100.041.451.910.438.507.563.103.009.14&lt;</td><td>Gradetoouttoptontoptoptoptoouttz<thttd></thttd></td></t<></td>	Gradet <sub>DOUT</sub> t <sub>DP</sub> t <sub>DIN</sub> t <sub>PY</sub> t <sub>PYS</sub> t <sub>EOUT</sub> t <sub>ZL</sub> Std.0.6615.840.041.451.910.4315.65-10.5613.470.041.231.620.3613.31-20.4911.830.031.081.420.3211.69Std.0.6611.390.041.451.910.4311.60-10.569.690.041.231.620.369.87-10.569.690.041.231.620.369.87-20.498.510.031.081.420.328.66Std.0.668.970.041.451.910.439.14-10.567.630.041.451.910.439.14-10.567.630.041.451.910.438.60Std.0.668.350.041.451.910.438.50-10.567.100.041.451.910.438.50-10.567.940.041.451.910.438.09-10.566.750.041.231.620.366.88-20.495.930.031.081.420.326.04Std.0.667.940.041.451.910.438.09-10.566.750.041.231.620.366.88 <t< 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# Table 2-40 • 1.8 V LVCMOS Low SlewCommercial-Case Conditions: TJ = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 1.7 V

## 1.5 V LVCMOS (JESD8-11)

Low-Voltage CMOS for 1.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.5 V applications. It uses a 1.5 V input buffer and a push-pull output buffer.

1.5 V LVCMOS		VIL	VIH		VOL VOH		IOL	юн	IOSL	IOSH	IIL¹	IIH <sup>2</sup>
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>3</sup>	Max. mA <sup>3</sup>	μA <sup>4</sup>	μA <sup>4</sup>
2 mA	-0.3	0.30 * VCCI	0.7 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	2	2	16	13	10	10
4 mA	-0.3	0.30 * VCCI	0.7 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	4	4	33	25	10	10
6 mA	-0.3	0.30 * VCCI	0.7 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	6	6	39	32	10	10
8 mA	-0.3	0.30 * VCCI	0.7 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	8	8	55	66	10	10
12 mA	-0.3	0.30 * VCCI	0.7 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	12	12	55	66	10	10

Table 2-41 • Minimum and Maximum DC Input and Output Levels

Notes:

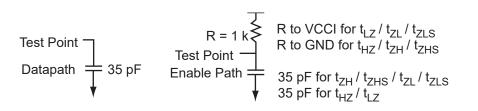
1. IIL is the input leakage current per I/O pin over recommended operation conditions where -0.3 V < VIN < VIL.

2. IIH is the input leakage current per I/O pin over recommended operating conditions VIH < VIN < VCCI. Input current is larger when operating outside recommended ranges.

3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

4. Currents are measured at 85°C junction temperature.

5. Software default selection highlighted in gray.



#### Figure 2-10 • AC Loading

#### Table 2-42 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	C <sub>LOAD</sub> (pF)
0	1.5	0.75	_	35

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### Table 2-43 • 1.5 V LVCMOS High Slew

Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 1.4 V

Drive Strength	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>zL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zHS</sub>	Units
2 mA	Std.	0.66	8.53	0.04	1.70	2.14	0.43	7.26	8.53	3.39	2.79	9.50	10.77	ns
	-1	0.56	7.26	0.04	1.44	1.82	0.36	6.18	7.26	2.89	2.37	8.08	9.16	ns
	-2	0.49	6.37	0.03	1.27	1.60	0.32	5.42	6.37	2.53	2.08	7.09	8.04	ns
4 mA	Std.	0.66	5.41	0.04	1.70	2.14	0.43	5.22	5.41	3.75	3.48	7.45	7.65	ns
	-1	0.56	4.60	0.04	1.44	1.82	0.36	4.44	4.60	3.19	2.96	6.34	6.50	ns
	-2	0.49	4.04	0.03	1.27	1.60	0.32	3.89	4.04	2.80	2.60	5.56	5.71	ns
6 mA	Std.	0.66	4.80	0.04	1.70	2.14	0.43	4.89	4.75	3.83	3.67	7.13	6.98	ns
	-1	0.56	4.09	0.04	1.44	1.82	0.36	4.16	4.04	3.26	3.12	6.06	5.94	ns
	-2	0.49	3.59	0.03	1.27	1.60	0.32	3.65	3.54	2.86	2.74	5.32	5.21	ns
8 mA	Std.	0.66	4.42	0.04	1.70	2.14	0.43	4.50	3.62	3.96	4.37	6.74	5.86	ns
	-1	0.56	3.76	0.04	1.44	1.82	0.36	3.83	3.08	3.37	3.72	5.73	4.98	ns
	-2	0.49	3.30	0.03	1.27	1.60	0.32	3.36	2.70	2.96	3.27	5.03	4.37	ns
12 mA	Std.	0.66	4.42	0.04	1.70	2.14	0.43	4.50	3.62	3.96	4.37	6.74	5.86	ns
	-1	0.56	3.76	0.04	1.44	1.82	0.36	3.83	3.08	3.37	3.72	5.73	4.98	ns
	-2	0.49	3.30	0.03	1.27	1.60	0.32	3.36	2.70	2.96	3.27	5.03	4.37	ns

Notes:

1. Software default selection highlighted in gray.

2. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

	i	ercial-Ca												 
Drive Strength	Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zHS</sub>	Units
2 mA	Std.	0.66	14.11	0.04	1.70	2.14	0.43	14.37	13.14	3.40	2.68	16.61	15.37	ns
	-1	0.56	12.00	0.04	1.44	1.82	0.36	12.22	11.17	2.90	2.28	14.13	13.08	ns
	-2	0.49	10.54	0.03	1.27	1.60	0.32	10.73	9.81	2.54	2.00	12.40	11.48	ns
4 mA	Std.	0.66	11.23	0.04	1.70	2.14	0.43	11.44	9.87	3.77	3.36	13.68	12.10	ns
	-1	0.56	9.55	0.04	1.44	1.82	0.36	9.73	8.39	3.21	2.86	11.63	10.29	ns
	-2	0.49	8.39	0.03	1.27	1.60	0.32	8.54	7.37	2.81	2.51	10.21	9.04	ns
6 mA	Std.	0.66	10.45	0.04	1.70	2.14	0.43	10.65	9.24	3.84	3.55	12.88	11.48	ns
	-1	0.56	8.89	0.04	1.44	1.82	0.36	9.06	7.86	3.27	3.02	10.96	9.76	ns
	-2	0.49	7.81	0.03	1.27	1.60	0.32	7.95	6.90	2.87	2.65	9.62	8.57	ns
8 mA	Std.	0.66	10.02	0.04	1.70	2.14	0.43	10.20	9.23	3.97	4.22	12.44	11.47	ns
	-1	0.56	8.52	0.04	1.44	1.82	0.36	8.68	7.85	3.38	3.59	10.58	9.75	ns
	-2	0.49	7.48	0.03	1.27	1.60	0.32	7.62	6.89	2.97	3.15	9.29	8.56	ns
12 mA	Std.	0.66	10.02	0.04	1.70	2.14	0.43	10.20	9.23	3.97	4.22	12.44	11.47	ns
	-1	0.56	8.52	0.04	1.44	1.82	0.36	8.68	7.85	3.38	3.59	10.58	9.75	ns
	-2	0.49	7.48	0.03	1.27	1.60	0.32	7.62	6.89	2.97	3.15	9.29	8.56	ns

#### Table 2-44 • 1.5 V LVCMOS Low Slew

Commercial-Case Conditions: T = 70°C, Worst-Case VCC = 1,425 V, Worst-Case VCCI = 1,4 V

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

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## 3.3 V PCI, 3.3 V PCI-X

Peripheral Component Interface for 3.3 V standard specifies support for 33 MHz and 66 MHz PCI Bus applications.

3.3 V PCI/PCI-X	VIL		VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL <sup>1</sup>	IIH <sup>2</sup>
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>3</sup>	Max. mA <sup>3</sup>	μA <sup>4</sup>	μA <sup>4</sup>
Per PCI specification					Per PCI	curves					10	10

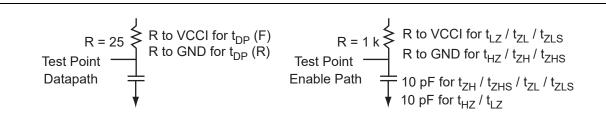
#### Table 2-45 • Minimum and Maximum DC Input and Output Levels

Notes:

1. IIL is the input leakage current per I/O pin over recommended operation conditions where -0.3 V < VIN < VIL.

- 2. IIH is the input leakage current per I/O pin over recommended operating conditions VIH < VIN< VCCI. Input current is larger when operating outside recommended ranges.
- 3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.
- 4. Currents are measured at 85°C junction temperature.

AC loadings are defined per the PCI/PCI-X specifications for the datapath; Microsemi loadings for enable path characterization are described in Figure 2-11.



#### Figure 2-11 • AC Loading

AC loadings are defined per PCI/PCI-X specifications for the datapath; Microsemi loading for tristate is described in Table 2-46.

#### Table 2-46 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	C <sub>LOAD</sub> (pF)
0	3.3	0.285 * VCCI for t <sub>DP(R)</sub>	-	10
		0.615 * VCCI for t <sub>DP(F)</sub>		

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

Table 2-47 • 3.3 V PCI/PCI-X

Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>PYS</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zHS</sub>	Units
Std.	0.66	2.81	0.04	1.05	1.67	0.43	2.86	2.00	3.28	3.61	5.09	4.23	ns
-1	0.56	2.39	0.04	0.89	1.42	0.36	2.43	1.70	2.79	3.07	4.33	3.60	ns
-2	0.49	2.09	0.03	0.78	1.25	0.32	2.13	1.49	2.45	2.70	3.80	3.16	ns

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

## **Voltage-Referenced I/O Characteristics**

### 3.3 V GTL

Gunning Transceiver Logic is a high-speed bus standard (JESD8-3). It provides a differential amplifier input buffer and an open-drain output buffer. The VCCI pin should be connected to 3.3 V.

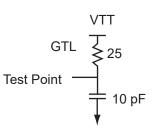
3.3 V GTL		VIL	/IL VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
20 mA <sup>3</sup>	-0.3	VREF – 0.05	VREF + 0.05	3.6	0.4	_	20	20	181	268	10	10

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.

3. Output drive strength is below JEDEC specification.



#### Figure 2-12 • AC Loading

#### Table 2-49 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.05	VREF + 0.05	0.8	0.8	1.2	10

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### Table 2-50 • 3.3 V GTL Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V VREF = 0.8 V

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.60	2.08	0.04	2.93	0.43	2.04	2.08			4.27	4.31	ns
-1	0.51	1.77	0.04	2.50	0.36	1.73	1.77			3.63	3.67	ns
-2	0.45	1.55	0.03	2.19	0.32	1.52	1.55			3.19	3.22	ns

## 2.5 V GTL

Gunning Transceiver Logic is a high-speed bus standard (JESD8-3). It provides a differential amplifier input buffer and an open-drain output buffer. The VCCI pin should be connected to 2.5 V.

Table 2-51 • Minimum and Maximum DC Input and Output Levels

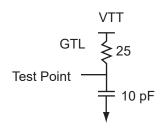
2.5 GTL		VIL	VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL	IIH
Drive Strength	Min., V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
20 mA <sup>3</sup>	-0.3	VREF – 0.05	VREF + 0.05	3.6	0.4	-	20	20	124	169	10	10

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.

3. Output drive strength is below JEDEC specification.



#### Figure 2-13 • AC Loading

#### Table 2-52 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.05	VREF + 0.05	0.8	0.8	1.2	10

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### Timing Characteristics

Table 2-53 • 2.5 V GTL

```
Commercial-Case Conditions: T_J = 70^{\circ}C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V VREF = 0.8 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.60	2.13	0.04	2.46	0.43	2.16	2.13			4.40	4.36	ns
-1	0.51	1.81	0.04	2.09	0.36	1.84	1.81			3.74	3.71	ns
-2	0.45	1.59	0.03	1.83	0.32	1.61	1.59			3.28	3.26	ns

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## 3.3 V GTL+

Gunning Transceiver Logic Plus is a high-speed bus standard (JESD8-3). It provides a differential amplifier input buffer and an open-drain output buffer. The VCCI pin should be connected to 3.3 V.

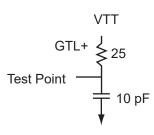
3.3 V GTL+		VIL	VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
35 mA	-0.3	VREF – 0.1	VREF + 0.1	3.6	0.6	Ι	35	35	181	268	10	10

Table 2-54 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.



#### Figure 2-14 • AC Loading

Table 2-55 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.1	VREF + 0.1	1.0	1.0	1.5	10

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### **Timing Characteristics**

Table 2-56 • 3.3 V GTL+

```
Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V,
Worst-Case VCCI = 3.0 V, VREF = 1.0 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.60	2.06	0.04	1.59	0.43	2.09	2.06			4.33	4.29	ns
-1	0.51	1.75	0.04	1.35	0.36	1.78	1.75			3.68	3.65	ns
-2	0.45	1.53	0.03	1.19	0.32	1.56	1.53			3.23	3.20	ns

## 2.5 V GTL+

Gunning Transceiver Logic Plus is a high-speed bus standard (JESD8-3). It provides a differential amplifier input buffer and an open-drain output buffer. The VCCI pin should be connected to 2.5 V.

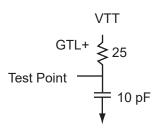
Table 2-57 • Minimum and Maximum	n DC Input and Output Levels
----------------------------------	------------------------------

2.5 V GTL+		VIL	VIH		VOL	VOH	IOL	IOH	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
33 mA	-0.3	VREF – 0.1	VREF + 0.1	3.6	0.6	1	33	33	124	169	10	10

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.



#### Figure 2-15 • AC Loading

Table 2-58 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.1	VREF + 0.1	1.0	1.0	1.5	10

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### **Timing Characteristics**

Table 2-59 • 2.5 V GTL+

```
Commercial-Case Conditions: T_J = 70^{\circ}C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.3 V, VREF = 1.0 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.60	2.21	0.04	1.51	0.43	2.25	2.10			4.48	4.34	ns
-1	0.51	1.88	0.04	1.29	0.36	1.91	1.79			3.81	3.69	ns
-2	0.45	1.65	0.03	1.13	0.32	1.68	1.57			3.35	3.24	ns



## **HSTL Class I**

High-Speed Transceiver Logic is a general-purpose high-speed 1.5 V bus standard (EIA/JESD8-6). ProASIC3E devices support Class I. This provides a differential amplifier input buffer and a push-pull output buffer.

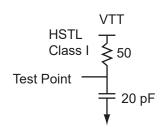
HSTL Class I		VIL	VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
8 mA	-0.3	VREF – 0.1	VREF + 0.1	3.6	0.4	VCCI - 0.4	8	8	39	32	10	10

Table 2-60 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.



#### Figure 2-16 • AC Loading

Table 2-61 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.1	VREF + 0.1	0.75	0.75	0.75	20

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### **Timing Characteristics**

#### Table 2-62 • HSTL Class I

```
Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V,
Worst-Case VCCI = .4 V, VREF = 0.75 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.66	3.18	0.04	2.12	0.43	3.24	3.14			5.47	5.38	ns
-1	0.56	2.70	0.04	1.81	0.36	2.75	2.67			4.66	4.58	ns
-2	0.49	2.37	0.03	1.59	0.32	2.42	2.35			4.09	4.02	ns

## HSTL Class II

High-Speed Transceiver Logic is a general-purpose high-speed 1.5 V bus standard (EIA/JESD8-6). ProASIC3E devices support Class II. This provides a differential amplifier input buffer and a push-pull output buffer.

HSTL Class II		VIL	VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max., V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
15 mA <sup>3</sup>	-0.3	VREF – 0.1	VREF + 0.1	3.6	0.4	VCCI – 0.4	15	15	55	66	10	10

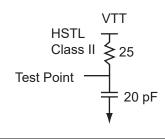
Table 2-63 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.

3. Output drive strength is below JEDEC specification.



#### Figure 2-17 • AC Loading

#### Table 2-64 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.1	VREF + 0.1	0.75	0.75	0.75	20

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### **Timing Characteristics**

Table 2-65 • HSTL Class II

```
Commercial-Case Conditions: T_J = 70^{\circ}C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 1.4 V, VREF = 0.75 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.66	3.02	0.04	2.12	0.43	3.08	2.71			5.32	4.95	ns
-1	0.56	2.57	0.04	1.81	0.36	2.62	2.31			4.52	4.21	ns
-2	0.49	2.26	0.03	1.59	0.32	2.30	2.03			3.97	3.70	ns

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## SSTL2 Class I

Stub-Speed Terminated Logic for 2.5 V memory bus standard (JESD8-9). ProASIC3E devices support Class I. This provides a differential amplifier input buffer and a push-pull output buffer.

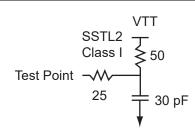
SSTL2 Class I		VIL	VIH		VOL	VOH	IOL	IOH	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
15 mA	-0.3	VREF – 0.2	VREF + 0.2	3.6	0.54	VCCI – 0.62	15	15	87	83	10	10

Table 2-66 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.



#### Figure 2-18 • AC Loading

#### Table 2-67 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.2	VREF + 0.2	1.25	1.25	1.25	30

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### **Timing Characteristics**

#### Table 2-68 • SSTL 2 Class I Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.3 V, VREF = 1.25 V

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.66	2.13	0.04	1.33	0.43	2.17	1.85			4.40	4.08	ns
-1	0.56	1.81	0.04	1.14	0.36	1.84	1.57			3.74	3.47	ns
-2	0.49	1.59	0.03	1.00	0.32	1.62	1.38			3.29	3.05	ns

## SSTL2 Class II

Stub-Speed Terminated Logic for 2.5 V memory bus standard (JESD8-9). ProASIC3E devices support Class II. This provides a differential amplifier input buffer and a push-pull output buffer.

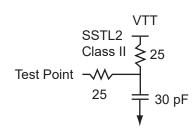
SSTL2 Class II		VIL	VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
18 mA	-0.3	VREF – 0.2	VREF + 0.2	3.6	0.35	VCCI - 0.43	18	18	124	169	10	10

Table 2-69 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.



#### Figure 2-19 • AC Loading

#### Table 2-70 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.2	VREF + 0.2	1.25	1.25	1.25	30

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### **Timing Characteristics**

## Table 2-71 • SSTL 2 Class II

```
Commercial-Case Conditions: T_J = 70^{\circ}C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.3 V, VREF = 1.25 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>zLS</sub>	t <sub>zHS</sub>	Units
Std.	0.66	0.66	2.17	0.04	1.33	0.43	2.21	1.77			4.44	ns
-1	0.56	0.56	1.84	0.04	1.14	0.36	1.88	1.51			3.78	ns
-2	0.49	0.49	1.62	0.03	1.00	0.32	1.65	1.32			3.32	ns

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

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## SSTL3 Class I

Stub-Speed Terminated Logic for 3.3 V memory bus standard (JESD8-8). ProASIC3E devices support Class I. This provides a differential amplifier input buffer and a push-pull output buffer.

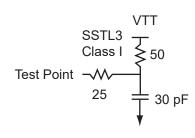
SSTL3 Class I		VIL	VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
14 mA	-0.3	VREF – 0.2	VREF + 0.2	3.6	0.7	VCCI – 1.1	14	14	54	51	10	10

Table 2-72 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.



#### Figure 2-20 • AC Loading

#### Table 2-73 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.2	VREF + 0.2	1.5	1.5	1.485	30

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### **Timing Characteristics**

#### Table 2-74 • SSTL3 Class I

```
Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V,
Worst-Case VCCI = 3.0 V, VREF = 1.5 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.66	2.31	0.04	1.25	0.43	2.35	1.84			4.59	4.07	ns
-1	0.56	1.96	0.04	1.06	0.36	2.00	1.56			3.90	3.46	ns
-2	0.49	1.72	0.03	0.93	0.32	1.75	1.37			3.42	3.04	ns

## SSTL3 Class II

Stub-Speed Terminated Logic for 3.3 V memory bus standard (JESD8-8). ProASIC3E devices support Class II. This provides a differential amplifier input buffer and a push-pull output buffer.

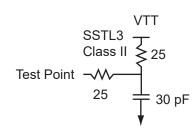
SSTL3 Class II		VIL	VIH		VOL	VOH	IOL	ЮН	IOSL	IOSH	IIL	IIH
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA <sup>1</sup>	Max. mA <sup>1</sup>	μA²	μA²
21 mA	-0.3	VREF – 0.2	VREF + 0.2	3.6	0.5	VCCI – 0.9	21	21	109	103	10	10

Table 2-75 • Minimum and Maximum DC Input and Output Levels

Notes:

1. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.

2. Currents are measured at 85°C junction temperature.



#### Figure 2-21 • AC Loading

#### Table 2-76 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)	VTT (typ.) (V)	C <sub>LOAD</sub> (pF)
VREF – 0.2	VREF + 0.2	1.5	1.5	1.485	30

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### **Timing Characteristics**

#### Table 2-77 • SSTL3 Class II

```
Commercial-Case Conditions: T<sub>.1</sub> = 70°C, Worst-Case VCC = 1.425 V,
Worst-Case VCCI = 3.0 V, VREF = 1.5 V
```

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	t <sub>EOUT</sub>	t <sub>ZL</sub>	t <sub>zH</sub>	t <sub>LZ</sub>	t <sub>HZ</sub>	t <sub>ZLS</sub>	t <sub>zHS</sub>	Units
Std.	0.66	2.07	0.04	1.25	0.43	2.10	1.67			4.34	3.91	ns
-1	0.56	1.76	0.04	1.06	0.36	1.79	1.42			3.69	3.32	ns
-2	0.49	1.54	0.03	0.93	0.32	1.57	1.25			3.24	2.92	ns

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

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**Revision 16** 

**Місгозеті** а Фисвоснір company ProASIC3E Flash Family FPGAs

## **Differential I/O Characteristics**

## **Physical Implementation**

Configuration of the I/O modules as a differential pair is handled by the Designer software when the user instantiates a differential I/O macro in the design.

Differential I/Os can also be used in conjunction with the embedded Input Register (InReg), Output Register (OutReg), Enable Register (EnReg), and DDR. However, there is no support for bidirectional I/Os or tristates with the LVPECL standards.

## LVDS

Low-Voltage Differential Signaling (ANSI/TIA/EIA-644) is a high-speed, differential I/O standard. It requires that one data bit be carried through two signal lines, so two pins are needed. It also requires external resistor termination.

The full implementation of the LVDS transmitter and receiver is shown in an example in Figure 2-22. The building blocks of the LVDS transmitter-receiver are one transmitter macro, one receiver macro, three board resistors at the transmitter end, and one resistor at the receiver end. The values for the three driver resistors are different from those used in the LVPECL implementation because the output standard specifications are different.

Along with LVDS I/O, ProASIC3E also supports Bus LVDS structure and Multipoint LVDS (M-LVDS) configuration (up to 40 nodes).

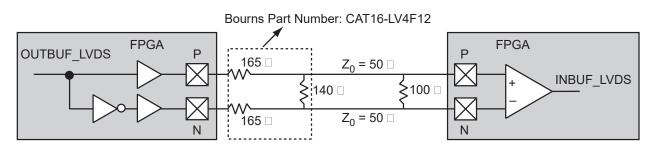


Figure 2-22 • LVDS Circuit Diagram and Board-Level Implementation

DC Parameter	Description	Min.	Тур.	Max.	Units
VCCI	Supply Voltage	2.375	2.5	2.625	V
VOL	Output Low Voltage	0.9	1.075	1.25	V
VOH	Output High Voltage	1.25	1.425	1.6	V
IOL <sup>1</sup>	Output Lower Current	0.65	0.91	1.16	mA
IOH <sup>1</sup>	Output High Current	0.65	0.91	1.16	mA
VI	Input Voltage	0		2.925	V
IIH <sup>2</sup>	Input High Leakage Current			10	μA
IIL <sup>2</sup>	Input Low Leakage Current			10	μA
VODIFF	Differential Output Voltage	250	350	450	mV
VOCM	Output Common Mode Voltage	1.125	1.25	1.375	V
VICM	Input Common Mode Voltage	0.05	1.25	2.35	V
VIDIFF	Input Differential Voltage <sup>2</sup>	100	350		mV

#### Table 2-78 • LVDS Minimum and Maximum DC Input and Output Levels

Notes:

1. IOL/IOH defined by VODIFF/(Resistor Network).

2. Currents are measured at 85°C junction temperature.

#### Table 2-79 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)
1.075	1.325	Cross point	-

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

#### Table 2-80 • LVDS

Commercial-Case Conditions: TJ = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.3 V

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	Units
Std.	0.66	1.87	0.04	1.82	ns
-1	0.56	1.59	0.04	1.55	ns
-2	0.49	1.40	0.03	1.36	ns

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

## **B-LVDS/M-LVDS**

Bus LVDS (B-LVDS) and Multipoint LVDS (M-LVDS) specifications extend the existing LVDS standard to highperformance multipoint bus applications. Multidrop and multipoint bus configurations may contain any combination of drivers, receivers, and transceivers. Microsemi LVDS drivers provide the higher drive current required by B-LVDS and M-LVDS to accommodate the loading. The drivers require series terminations for better signal quality and to control voltage swing. Termination is also required at both ends of the bus since the driver can be located anywhere on the bus. These configurations can be implemented using the TRIBUF\_LVDS and BIBUF\_LVDS macros along with appropriate terminations. Multipoint designs using Microsemi LVDS macros can achieve up to 200 MHz with a maximum of 20 loads. A sample application is given in Figure 2-23. The input and output buffer delays are available in the LVDS section in Table 2-80.

Example: For a bus consisting of 20 equidistant loads, the following terminations provide the required differential voltage, in worst-case Industrial operating conditions, at the farthest receiver:  $R_S = 60 \Omega$  and  $R_T = 70 \Omega$ , given  $Z_0 = 50 \Omega$  (2") and  $Z_{stub} = 50 \Omega$  (~1.5").

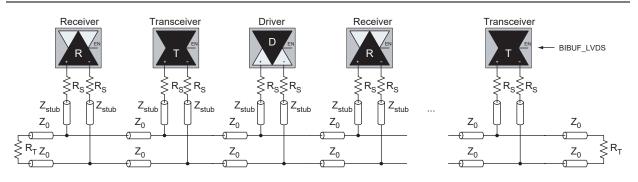


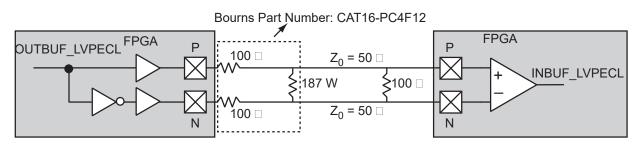
Figure 2-23 • B-LVDS/M-LVDS Multipoint Application Using LVDS I/O Buffers



## LVPECL

Low-Voltage Positive Emitter-Coupled Logic (LVPECL) is another differential I/O standard. It requires that one data bit be carried through two signal lines. Like LVDS, two pins are needed. It also requires external resistor termination.

The full implementation of the LVDS transmitter and receiver is shown in an example in Figure 2-24. The building blocks of the LVPECL transmitter-receiver are one transmitter macro, one receiver macro, three board resistors at the transmitter end, and one resistor at the receiver end. The values for the three driver resistors are different from those used in the LVDS implementation because the output standard specifications are different.



#### Figure 2-24 • LVPECL Circuit Diagram and Board-Level Implementation

DC Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
VCCI	Supply Voltage	3	.0	3.	3	3.	6	V
VOL	Output Low Voltage	0.96	1.27	1.06	1.43	1.30	1.57	V
VOH	Output High Voltage	1.8	2.11	1.92	2.28	2.13	2.41	V
VIL, VIH	Input Low, Input High Voltages	0	3.6	0	3.6	0	3.6	V
VODIFF	Differential Output Voltage	0.625	0.97	0.625	0.97	0.625	0.97	V
VOCM	Output Common-Mode Voltage	1.762	1.98	1.762	1.98	1.762	1.98	V
VICM	Input Common-Mode Voltage	1.01	2.57	1.01	2.57	1.01	2.57	V
VIDIFF	Input Differential Voltage	300		300		300		mV

#### Table 2-81 • Minimum and Maximum DC Input and Output Levels

Table 2-82 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ.) (V)
1.64	1.94	Cross point	_

Note: \*Measuring point = Vtrip. See Table 2-15 on page 2-19 for a complete table of trip points.

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#### Table 2-83 • LVPECL

Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V

Speed Grade	t <sub>DOUT</sub>	t <sub>DP</sub>	t <sub>DIN</sub>	t <sub>PY</sub>	Units
Std.	0.66	1.83	0.04	1.63	ns
-1	0.56	1.55	0.04	1.39	ns
-2	0.49	1.36	0.03	1.22	ns

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

## **I/O Register Specifications**

# Fully Registered I/O Buffers with Synchronous Enable and Asynchronous Preset

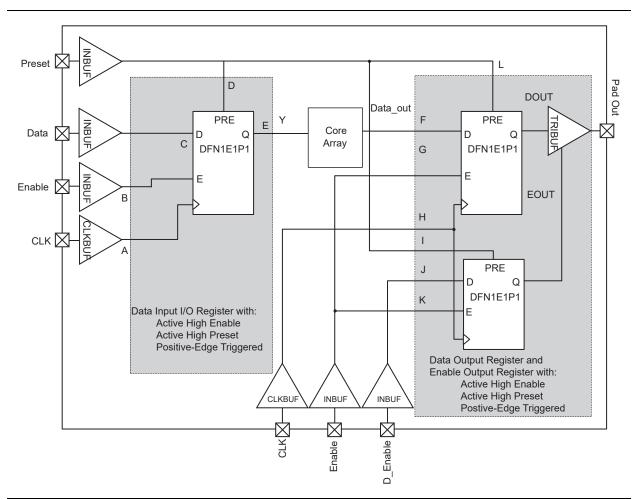


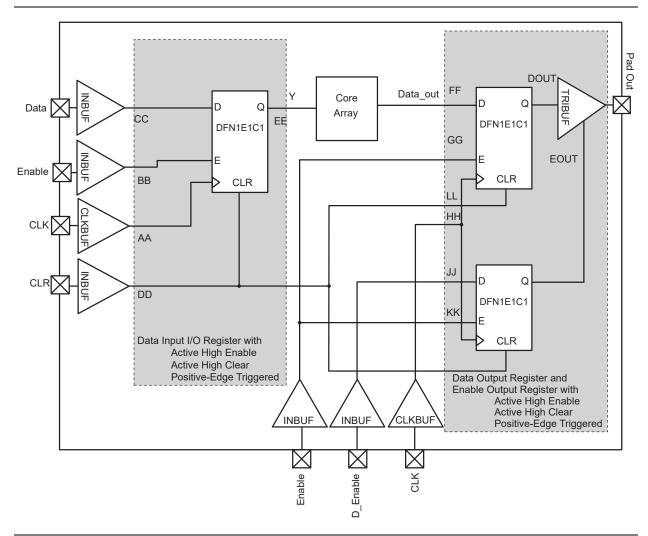
Figure 2-25 • Timing Model of Registered I/O Buffers with Synchronous Enable and Asynchronous Preset

Parameter Name	Parameter Definition	Measuring Nodes (from, to)*		
t <sub>oclkq</sub>	Clock-to-Q of the Output Data Register	H, DOUT		
tosud	Data Setup Time for the Output Data Register	F, H		
t <sub>OHD</sub>	Data Hold Time for the Output Data Register	F, H		
t <sub>OSUE</sub>	Enable Setup Time for the Output Data Register	G, H		
t <sub>OHE</sub>	Enable Hold Time for the Output Data Register	G, H		
t <sub>OPRE2Q</sub>	Asynchronous Preset-to-Q of the Output Data Register	L, DOUT		
t <sub>OREMPRE</sub>	Asynchronous Preset Removal Time for the Output Data Register	L, H		
t <sub>ORECPRE</sub>	Asynchronous Preset Recovery Time for the Output Data Register	L, H		
t <sub>oeclkq</sub>	Clock-to-Q of the Output Enable Register	H, EOUT		
toesud	Data Setup Time for the Output Enable Register	J, H		
t <sub>OEHD</sub>	Data Hold Time for the Output Enable Register	J, H		
toesue	Enable Setup Time for the Output Enable Register	K, H		
t <sub>OEHE</sub>	Enable Hold Time for the Output Enable Register	K, H		
t <sub>OEPRE2Q</sub>	Asynchronous Preset-to-Q of the Output Enable Register	I, EOUT		
t <sub>OEREMPRE</sub>	Asynchronous Preset Removal Time for the Output Enable Register	I, H		
t <sub>OERECPRE</sub>	Asynchronous Preset Recovery Time for the Output Enable Register	I, H		
t <sub>ICLKQ</sub>	Clock-to-Q of the Input Data Register	A, E		
t <sub>ISUD</sub>	Data Setup Time for the Input Data Register	C, A		
t <sub>IHD</sub>	Data Hold Time for the Input Data Register	C, A		
t <sub>ISUE</sub>	Enable Setup Time for the Input Data Register	B, A		
t <sub>IHE</sub>	Enable Hold Time for the Input Data Register	B, A		
t <sub>IPRE2Q</sub>	Asynchronous Preset-to-Q of the Input Data Register	D, E		
t <sub>IREMPRE</sub>	Asynchronous Preset Removal Time for the Input Data Register	D, A		
t <sub>IRECPRE</sub>	Asynchronous Preset Recovery Time for the Input Data Register	D, A		

#### Table 2-84 • Parameter Definition and Measuring Nodes

*Note:* \*See Figure 2-25 on page 2-55 for more information.





# Fully Registered I/O Buffers with Synchronous Enable and Asynchronous Clear

Figure 2-26 • Timing Model of the Registered I/O Buffers with Synchronous Enable and Asynchronous Clear

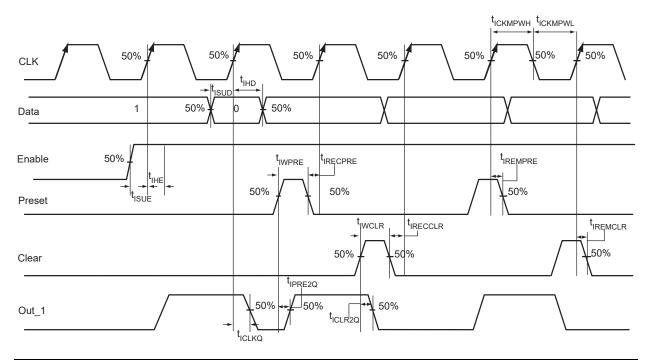
Parameter Name	Parameter Definition	Measuring Nodes (from, to)*		
t <sub>oclkq</sub>	Clock-to-Q of the Output Data Register	HH, DOUT		
tosud	Data Setup Time for the Output Data Register	FF, HH		
t <sub>OHD</sub>	Data Hold Time for the Output Data Register	FF, HH		
t <sub>OSUE</sub>	Enable Setup Time for the Output Data Register	GG, HH		
t <sub>OHE</sub>	Enable Hold Time for the Output Data Register	GG, HH		
t <sub>OCLR2Q</sub>	Asynchronous Clear-to-Q of the Output Data Register	LL, DOUT		
t <sub>OREMCLR</sub>	Asynchronous Clear Removal Time for the Output Data Register	LL, HH		
t <sub>ORECCLR</sub>	Asynchronous Clear Recovery Time for the Output Data Register	LL, HH		
t <sub>oeclkq</sub>	Clock-to-Q of the Output Enable Register	HH, EOUT		
t <sub>OESUD</sub>	Data Setup Time for the Output Enable Register	JJ, HH		
t <sub>OEHD</sub>	Data Hold Time for the Output Enable Register	JJ, HH		
t <sub>OESUE</sub>	Enable Setup Time for the Output Enable Register	KK, HH		
t <sub>OEHE</sub>	Enable Hold Time for the Output Enable Register	KK, HH		
t <sub>OECLR2Q</sub>	Asynchronous Clear-to-Q of the Output Enable Register	II, EOUT		
t <sub>OEREMCLR</sub>	Asynchronous Clear Removal Time for the Output Enable Register	II, HH		
t <sub>OERECCLR</sub>	Asynchronous Clear Recovery Time for the Output Enable Register	II, HH		
t <sub>ICLKQ</sub>	Clock-to-Q of the Input Data Register	AA, EE		
t <sub>ISUD</sub>	Data Setup Time for the Input Data Register	CC, AA		
t <sub>IHD</sub>	Data Hold Time for the Input Data Register	CC, AA		
t <sub>ISUE</sub>	Enable Setup Time for the Input Data Register	BB, AA		
t <sub>IHE</sub>	Enable Hold Time for the Input Data Register	BB, AA		
t <sub>ICLR2Q</sub>	Asynchronous Clear-to-Q of the Input Data Register	DD, EE		
t <sub>IREMCLR</sub>	Asynchronous Clear Removal Time for the Input Data Register	DD, AA		
t <sub>IRECCLR</sub>	Asynchronous Clear Recovery Time for the Input Data Register	DD, AA		

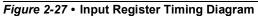
#### Table 2-85 • Parameter Definition and Measuring Nodes

Note: \*See Figure 2-26 on page 2-57 for more information.



## Input Register



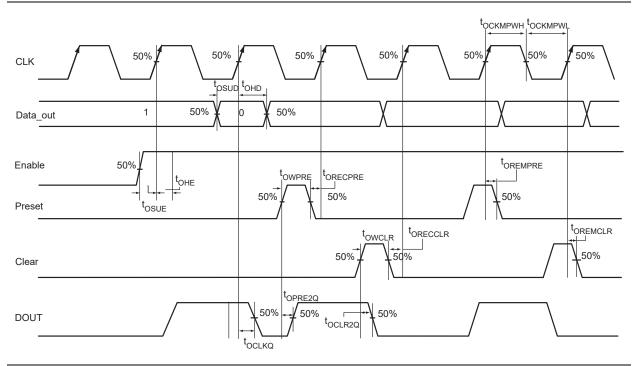


#### Timing Characteristics

# Table 2-86 • Input Data Register Propagation DelaysCommercial-Case Conditions: TJ = 70°C, Worst-Case VCC = 1.425 V

Parameter	Description	-2	-1	Std.	Units
t <sub>ICLKQ</sub>	Clock-to-Q of the Input Data Register	0.24	0.27	0.32	ns
t <sub>ISUD</sub>	Data Setup Time for the Input Data Register	0.26	0.30	0.35	ns
t <sub>IHD</sub>	Data Hold Time for the Input Data Register	0.00	0.00	0.00	ns
t <sub>ISUE</sub>	Enable Setup Time for the Input Data Register	0.37	0.42	0.50	ns
t <sub>IHE</sub>	Enable Hold Time for the Input Data Register	0.00	0.00	0.00	ns
t <sub>ICLR2Q</sub>	Asynchronous Clear-to-Q of the Input Data Register	0.45	0.52	0.61	ns
t <sub>IPRE2Q</sub>	Asynchronous Preset-to-Q of the Input Data Register	0.45	0.52	0.61	ns
t <sub>IREMCLR</sub>	Asynchronous Clear Removal Time for the Input Data Register	0.00	0.00	0.00	ns
t <sub>IRECCLR</sub>	Asynchronous Clear Recovery Time for the Input Data Register	0.22	0.25	0.30	ns
t <sub>IREMPRE</sub>	Asynchronous Preset Removal Time for the Input Data Register	0.00	0.00	0.00	ns
t <sub>IRECPRE</sub>	Asynchronous Preset Recovery Time for the Input Data Register	0.22	0.25	0.30	ns
t <sub>IWCLR</sub>	Asynchronous Clear Minimum Pulse Width for the Input Data Register	0.22	0.25	0.30	ns
t <sub>IWPRE</sub>	Asynchronous Preset Minimum Pulse Width for the Input Data Register	0.22	0.25	0.30	ns
t <sub>ICKMPWH</sub>	Clock Minimum Pulse Width High for the Input Data Register	0.36	0.41	0.48	ns
t <sub>ICKMPWL</sub>	Clock Minimum Pulse Width Low for the Input Data Register	0.32	0.37	0.43	ns

## **Output Register**



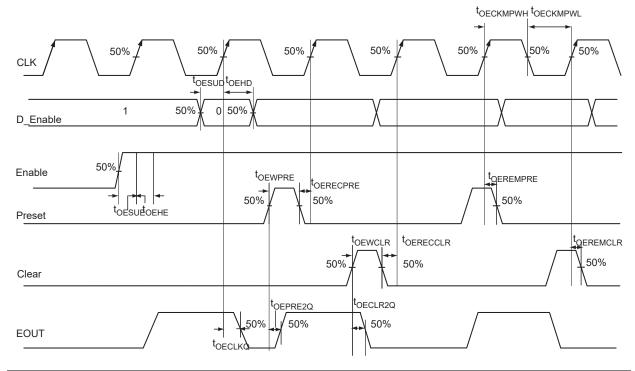


#### Timing Characteristics

#### Table 2-87 • Output Data Register Propagation Delays Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V

Parameter	Description	-2	-1	Std.	Units
t <sub>OCLKQ</sub>	Clock-to-Q of the Output Data Register	0.59	0.67	0.79	ns
t <sub>OSUD</sub>	Data Setup Time for the Output Data Register	0.31	0.36	0.42	ns
t <sub>OHD</sub>	Data Hold Time for the Output Data Register	0.00	0.00	0.00	ns
t <sub>OSUE</sub>	Enable Setup Time for the Output Data Register	0.44	0.50	0.59	ns
t <sub>OHE</sub>	Enable Hold Time for the Output Data Register	0.00	0.00	0.00	ns
t <sub>OCLR2Q</sub>	Asynchronous Clear-to-Q of the Output Data Register	0.80	0.91	1.07	ns
t <sub>OPRE2Q</sub>	Asynchronous Preset-to-Q of the Output Data Register	0.80	0.91	1.07	ns
t <sub>OREMCLR</sub>	Asynchronous Clear Removal Time for the Output Data Register	0.00	0.00	0.00	ns
t <sub>ORECCLR</sub>	Asynchronous Clear Recovery Time for the Output Data Register	0.22	0.25	0.30	ns
t <sub>OREMPRE</sub>	Asynchronous Preset Removal Time for the Output Data Register	0.00	0.00	0.00	ns
t <sub>ORECPRE</sub>	Asynchronous Preset Recovery Time for the Output Data Register	0.22	0.25	0.30	ns
t <sub>OWCLR</sub>	Asynchronous Clear Minimum Pulse Width for the Output Data Register	0.22	0.25	0.30	ns
t <sub>OWPRE</sub>	Asynchronous Preset Minimum Pulse Width for the Output Data Register	0.22	0.25	0.30	ns
t <sub>OCKMPWH</sub>	Clock Minimum Pulse Width High for the Output Data Register	0.36	0.41	0.48	ns
t <sub>OCKMPWL</sub>	Clock Minimum Pulse Width Low for the Output Data Register	0.32	0.37	0.43	ns





## **Output Enable Register**

#### Figure 2-29 • Output Enable Register Timing Diagram

#### **Timing Characteristics**

# Table 2-88 • Output Enable Register Propagation DelaysCommercial-Case Conditions: TJ = 70°C, Worst-Case VCC = 1.425 V

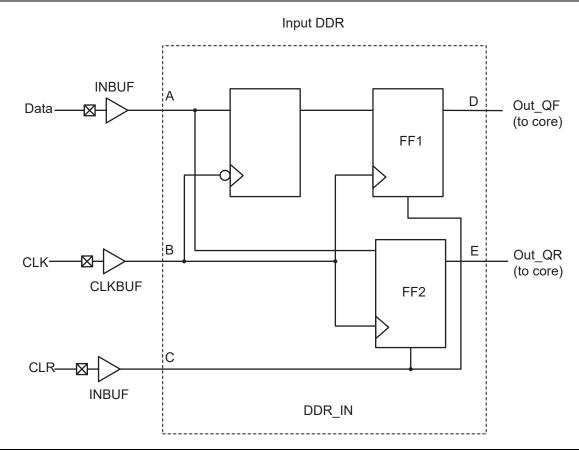
Parameter	Description	-2	-1	Std.	Units
t <sub>OECLKQ</sub>	Clock-to-Q of the Output Enable Register	0.59	0.67	0.79	ns
t <sub>OESUD</sub>	Data Setup Time for the Output Enable Register	0.31	0.36	0.42	ns
t <sub>OEHD</sub>	Data Hold Time for the Output Enable Register	0.00	0.00	0.00	ns
t <sub>OESUE</sub>	Enable Setup Time for the Output Enable Register	0.44	0.50	0.58	ns
t <sub>OEHE</sub>	Enable Hold Time for the Output Enable Register	0.00	0.00	0.00	ns
t <sub>OECLR2Q</sub>	Asynchronous Clear-to-Q of the Output Enable Register	0.67	0.76	0.89	ns
t <sub>OEPRE2Q</sub>	Asynchronous Preset-to-Q of the Output Enable Register	0.67	0.76	0.89	ns
t <sub>OEREMCLR</sub>	Asynchronous Clear Removal Time for the Output Enable Register	0.00	0.00	0.00	ns
t <sub>OERECCLR</sub>	Asynchronous Clear Recovery Time for the Output Enable Register	0.22	0.25	0.30	ns
t <sub>OEREMPRE</sub>	Asynchronous Preset Removal Time for the Output Enable Register	0.00	0.00	0.00	ns
t <sub>OERECPRE</sub>	Asynchronous Preset Recovery Time for the Output Enable Register	0.22	0.25	0.30	ns
t <sub>OEWCLR</sub>	Asynchronous Clear Minimum Pulse Width for the Output Enable Register	0.22	0.25	0.30	ns
t <sub>OEWPRE</sub>	Asynchronous Preset Minimum Pulse Width for the Output Enable Register	0.22	0.25	0.30	ns
t <sub>OECKMPWH</sub>	Clock Minimum Pulse Width High for the Output Enable Register	0.36	0.41	0.48	ns
t <sub>OECKMPWL</sub>	Clock Minimum Pulse Width Low for the Output Enable Register	0.32	0.37	0.43	ns

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

## **DDR Module Specifications**



### Input DDR Module



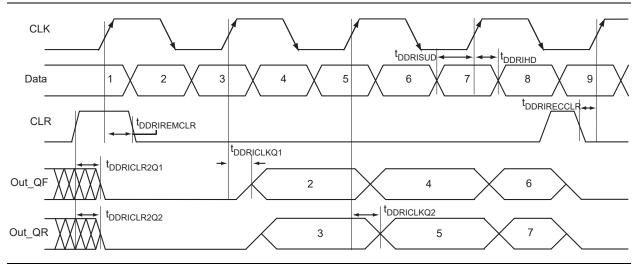
### Figure 2-30 • Input DDR Timing Model

#### Table 2-89 • Parameter Definitions

Parameter Name	Parameter Definition	Measuring Nodes (from, to)
t <sub>DDRICLKQ1</sub>	Clock-to-Out Out_QR	B, D
t <sub>DDRICLKQ2</sub>	Clock-to-Out Out_QF	B, E
t <sub>DDRISUD</sub>	Data Setup Time of DDR input	A, B
	Data Hold Time of DDR input	А, В
t <sub>DDRICLR2Q1</sub>	Clear-to-Out Out_QR	C, D
t <sub>DDRICLR2Q2</sub>	Clear-to-Out Out_QF	C, E
t <sub>DDRIREMCLR</sub>	Clear Removal	С, В
t <sub>DDRIRECCLR</sub>	Clear Recovery	С, В

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#### Figure 2-31 • Input DDR Timing Diagram

#### Timing Characteristics

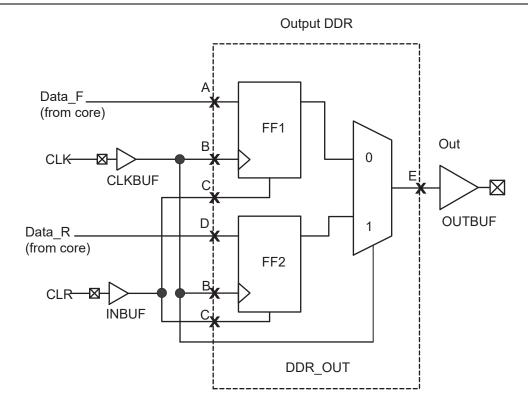
#### Table 2-90 • Input DDR Propagation Delays Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V

Parameter	Description	-2	-1	Std.	Units
t <sub>DDRICLKQ1</sub>	Clock-to-Out Out_QR for Input DDR	0.39	0.44	0.52	ns
t <sub>DDRICLKQ2</sub>	Clock-to-Out Out_QF for Input DDR	0.27	0.31	0.37	ns
t <sub>DDRISUD</sub>	Data Setup for Input DDR	0.28	0.32	0.38	ns
t <sub>DDRIHD</sub>	Data Hold for Input DDR	0.00	0.00	0.00	ns
t <sub>DDRICLR2Q1</sub>	Asynchronous Clear to Out Out_QR for Input DDR	0.57	0.65	0.76	ns
t <sub>DDRICLR2Q2</sub>	Asynchronous Clear-to-Out Out_QF for Input DDR	0.46	0.53	0.62	ns
t <sub>DDRIREMCLR</sub>	Asynchronous Clear Removal Time for Input DDR	0.00	0.00	0.00	ns
t <sub>DDRIRECCLR</sub>	Asynchronous Clear Recovery Time for Input DDR	0.22	0.25	0.30	ns
t <sub>DDRIWCLR</sub>	Asynchronous Clear Minimum Pulse Width for Input DDR	0.22	0.25	0.30	ns
t <sub>DDRICKMPWH</sub>	Clock Minimum Pulse Width High for Input DDR	0.36	0.41	0.48	ns
t <sub>DDRICKMPWL</sub>	Clock Minimum Pulse Width Low for Input DDR	0.32	0.37	0.43	ns
F <sub>DDRIMAX</sub>	Maximum Frequency for Input DDR	1404	1232	1048	MHz

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.



### **Output DDR Module**



#### Figure 2-32 • Output DDR Timing Model

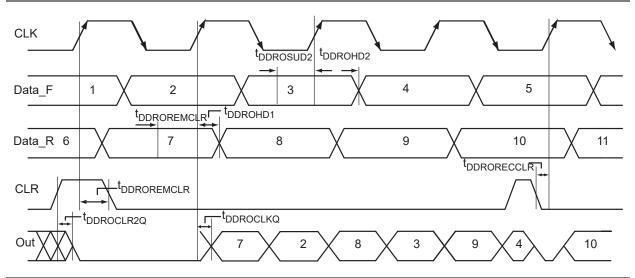
#### Table 2-91 • Parameter Definitions

Parameter Name	Parameter Definition	Measuring Nodes (from, to)
t <sub>DDROCLKQ</sub>	Clock-to-Out	B, E
t <sub>DDROCLR2Q</sub>	Asynchronous Clear-to-Out	C, E
t <sub>DDROREMCLR</sub>	Clear Removal	C, B
t <sub>DDRORECCLR</sub>	Clear Recovery	С, В
t <sub>DDROSUD1</sub>	Data Setup Data_F	A, B
t <sub>DDROSUD2</sub>	Data Setup Data_R	D, B
t <sub>DDROHD1</sub>	Data Hold Data_F	A, B
t <sub>DDROHD2</sub>	Data Hold Data_R	D, B

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ProASIC3E Flash Family FPGAs



#### Figure 2-33 • Output DDR Timing Diagram

#### **Timing Characteristics**

#### Table 2-92 • Output DDR Propagation Delays Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V

Parameter	Description	-2	-1	Std.	Units
t <sub>DDROCLKQ</sub>	Clock-to-Out of DDR for Output DDR	0.70	0.80	0.94	ns
t <sub>DDROSUD1</sub>	Data_F Data Setup for Output DDR	0.38	0.43	0.51	ns
t <sub>DDROSUD2</sub>	Data_R Data Setup for Output DDR	0.38	0.43	0.51	ns
t <sub>DDROHD1</sub>	Data_F Data Hold for Output DDR	0.00	0.00	0.00	ns
t <sub>DDROHD2</sub>	Data_R Data Hold for Output DDR	0.00	0.00	0.00	ns
t <sub>DDROCLR2Q</sub>	Asynchronous Clear-to-Out for Output DDR	0.80	0.91	1.07	ns
t <sub>DDROREMCLR</sub>	Asynchronous Clear Removal Time for Output DDR	0.00	0.00	0.00	ns
t <sub>DDRORECCLR</sub>	Asynchronous Clear Recovery Time for Output DDR	0.22	0.25	0.30	ns
t <sub>DDROWCLR1</sub>	Asynchronous Clear Minimum Pulse Width for Output DDR	0.22	0.25	0.30	ns
t <sub>DDROCKMPWH</sub>	Clock Minimum Pulse Width High for the Output DDR	0.36	0.41	0.48	ns
t <sub>DDROCKMPWL</sub>	Clock Minimum Pulse Width Low for the Output DDR	0.32	0.37	0.43	ns
F <sub>DDOMAX</sub>	Maximum Frequency for the Output DDR	1404	1232	1048	MHz

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

### **VersaTile Characteristics**

### VersaTile Specifications as a Combinatorial Module

The ProASIC3E library offers all combinations of LUT-3 combinatorial functions. In this section, timing characteristics are presented for a sample of the library. For more details, refer to the *Fusion, IGLOO®/e, and ProASIC3/E Macro Library Guide*.

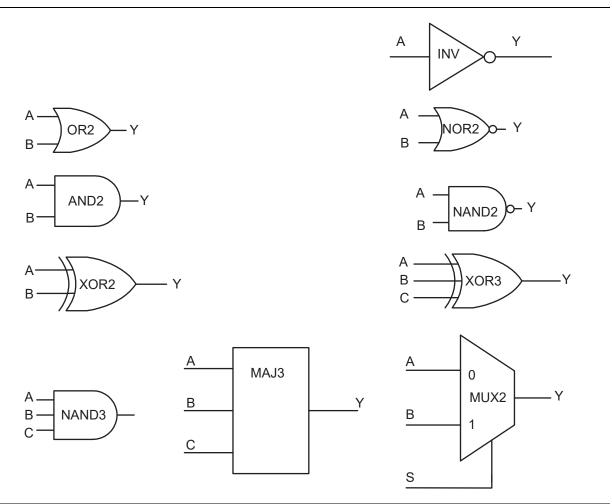


Figure 2-34 • Sample of Combinatorial Cells



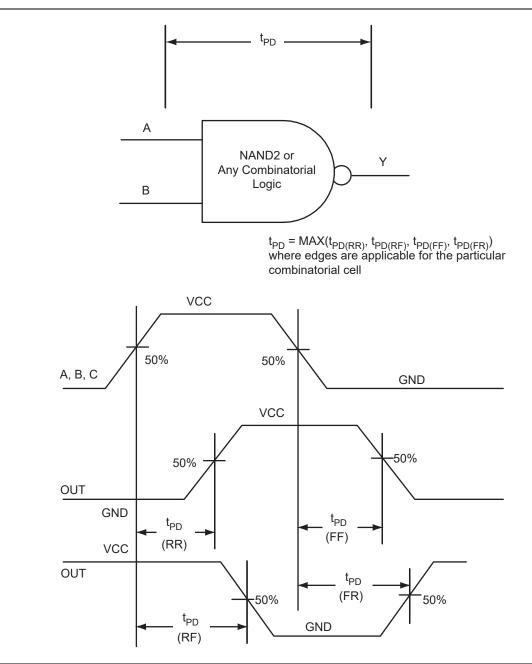


Figure 2-35 • Timing Model and Waveforms

### Timing Characteristics

Combinatorial Cell	Equation	Parameter	-2	-1	Std.	Units
INV	Y = !A	t <sub>PD</sub>	0.40	0.46	0.54	ns
AND2	$Y = A \cdot B$	t <sub>PD</sub>	0.47	0.54	0.63	ns
NAND2	Y = !(A · B)	t <sub>PD</sub>	0.47	0.54	0.63	ns
OR2	Y = A + B	t <sub>PD</sub>	0.49	0.55	0.65	ns
NOR2	Y = !(A + B)	t <sub>PD</sub>	0.49	0.55	0.65	ns
XOR2	Y = A ⊕ B	t <sub>PD</sub>	0.74	0.84	0.99	ns
MAJ3	Y = MAJ(A , B, C)	t <sub>PD</sub>	0.70	0.79	0.93	ns
XOR3	$Y = A \oplus B \oplus C$	t <sub>PD</sub>	0.87	1.00	1.17	ns
MUX2	Y = A !S + B S	t <sub>PD</sub>	0.51	0.58	0.68	ns
AND3	$Y = A \cdot B \cdot C$	t <sub>PD</sub>	0.56	0.64	0.75	ns

Table 2-93 • Combinatorial Cell Propagation Delays

Commercial-Case Conditions: T<sub>1</sub> = 70°C, Worst-Case VCC = 1.425 V

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

### VersaTile Specifications as a Sequential Module

The ProASIC3E library offers a wide variety of sequential cells, including flip-flops and latches. Each has a data input and optional enable, clear, or preset. In this section, timing characteristics are presented for a representative sample from the library. For more details, refer to the Fusion, IGLOO/e, and ProASIC3/E Macro Library Guide.

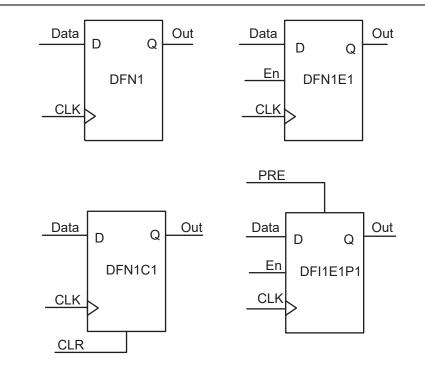


Figure 2-36 • Sample of Sequential Cells

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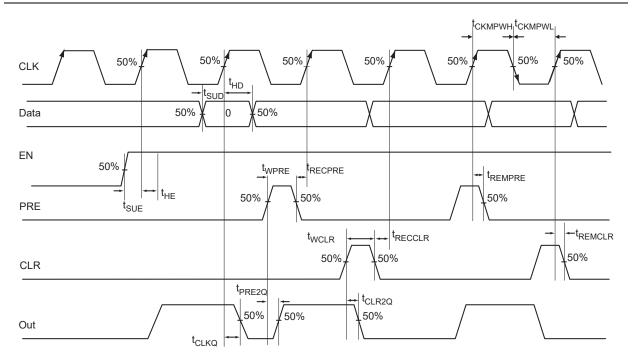


Figure 2-37 • Timing Model and Waveforms

### **Timing Characteristics**

#### Table 2-94 • Register Delays

#### Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V

Parameter	Description	-2	-1	Std.	Units
t <sub>CLKQ</sub>	Clock-to-Q of the Core Register	0.55	0.63	0.74	ns
t <sub>SUD</sub>	Data Setup Time for the Core Register	0.43	0.49	0.57	ns
t <sub>HD</sub>	Data Hold Time for the Core Register	0.00	0.00	0.00	ns
t <sub>SUE</sub>	Enable Setup Time for the Core Register	0.45	0.52	0.61	ns
t <sub>HE</sub>	Enable Hold Time for the Core Register	0.00	0.00	0.00	ns
t <sub>CLR2Q</sub>	Asynchronous Clear-to-Q of the Core Register	0.40	0.45	0.53	ns
t <sub>PRE2Q</sub>	Asynchronous Preset-to-Q of the Core Register	0.40	0.45	0.53	ns
t <sub>REMCLR</sub>	Asynchronous Clear Removal Time for the Core Register	0.00	0.00	0.00	ns
t <sub>RECCLR</sub>	Asynchronous Clear Recovery Time for the Core Register	0.22	0.25	0.30	ns
t <sub>REMPRE</sub>	Asynchronous Preset Removal Time for the Core Register	0.00	0.00	0.00	ns
t <sub>RECPRE</sub>	Asynchronous Preset Recovery Time for the Core Register	0.22	0.25	0.30	ns
t <sub>WCLR</sub>	Asynchronous Clear Minimum Pulse Width for the Core Register	0.22	0.25	0.30	ns
t <sub>WPRE</sub>	Asynchronous Preset Minimum Pulse Width for the Core Register	0.22	0.25	0.30	ns
t <sub>CKMPWH</sub>	Clock Minimum Pulse Width High for the Core Register	0.32	0.37	0.43	ns
t <sub>CKMPWL</sub>	Clock Minimum Pulse Width Low for the Core Register	0.36	0.41	0.48	ns

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

### **Global Resource Characteristics**

### A3PE600 Clock Tree Topology

Clock delays are device-specific. Figure 2-38 is an example of a global tree used for clock routing. The global tree presented in Figure 2-38 is driven by a CCC located on the west side of the A3PE600 device. It is used to drive all D-



flip-flops in the device.

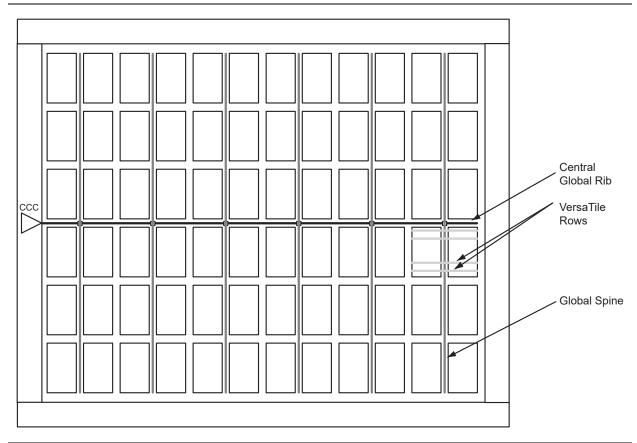


Figure 2-38 • Example of Global Tree Use in an A3PE600 Device for Clock Routing

### **Global Tree Timing Characteristics**

Global clock delays include the central rib delay, the spine delay, and the row delay. Delays do not include I/O input buffer clock delays, as these are I/O standard–dependent, and the clock may be driven and conditioned internally by the CCC module. For more details on clock conditioning capabilities, refer to the "Clock Conditioning Circuits" section on page 2-73. Table 2-95 on page 2-72, Table 2-96 on page 2-72, and Table 2-97 on page 2-72 present minimum and maximum global clock delays within the device. Minimum and maximum delays are measured with minimum and maximum loading.

#### **Timing Characteristics**

#### Table 2-95 • A3PE600 Global Resource

#### Commercial-Case Conditions: T<sub>J</sub> = 70°C, VCC = 1.425 V

		-2		-2 –1		Std.		
Parameter	Description	Min. <sup>1</sup>	Max. <sup>2</sup>	Min. <sup>1</sup>	Max. <sup>2</sup>	Min. <sup>1</sup>	Max. <sup>2</sup>	Units
t <sub>RCKL</sub>	Input Low Delay for Global Clock	0.83	1.04	0.94	1.18	1.11	1.39	ns
t <sub>RCKH</sub>	Input High Delay for Global Clock	0.81	1.06	0.93	1.21	1.09	1.42	ns
t <sub>RCKMPWH</sub>	Minimum Pulse Width High for Global Clock	0.75		0.85		1.00		ns
t <sub>RCKMPWL</sub>	Minimum Pulse Width Low for Global Clock	0.85		0.96		1.13		ns
t <sub>RCKSW</sub>	Maximum Skew for Global Clock		0.25		0.28		0.33	ns

Notes:

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

3. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

#### Table 2-96 • A3PE1500 Global Resource

Commercial-Case Conditions: T<sub>J</sub> = 70°C, VCC = 1.425 V

		-2		-2 -1		Std.		
Parameter	Description	Min. <sup>1</sup>	Max. <sup>2</sup>	Min. <sup>1</sup>	Max. <sup>2</sup>	Min. <sup>1</sup>	Max. <sup>2</sup>	Units
t <sub>RCKL</sub>	Input Low Delay for Global Clock	1.07	1.29	1.22	1.47	1.43	1.72	ns
t <sub>RCKH</sub>	Input High Delay for Global Clock	1.06	1.32	1.21	1.50	1.42	1.76	ns
t <sub>RCKMPWH</sub>	Minimum Pulse Width High for Global Clock	0.75		0.85		1.00		ns
t <sub>RCKMPWL</sub>	Minimum Pulse Width Low for Global Clock	0.85		0.96		1.13		ns
t <sub>RCKSW</sub>	Maximum Skew for Global Clock		0.26		0.29		0.34	ns

Notes:

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

Units

ns

ns

ns

ns

ns

3. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

#### Commercial-Case Conditions: T<sub>J</sub> = 70°C, VCC = 1.425 V -2 -1 Std. Max.<sup>2</sup> Max.<sup>2</sup> Max.<sup>2</sup> Parameter Description Min.<sup>1</sup> Min. Min.<sup>1</sup> Input Low Delay for Global Clock 1.41 1.62 1.60 1.85 1.88 2.17 <sup>I</sup>RCKL 1.40 Input High Delay for Global Clock 1.66 1.59 1.89 1.87 2.22 t<sub>RCKH</sub> Minimum Pulse Width High for Global Clock 0.75 0.85 1.00 t<sub>RCKMPWH</sub> Minimum Pulse Width Low for Global Clock 0.85 0.96 1.13 t<sub>RCKMPWL</sub> Maximum Skew for Global Clock 0.26 0.29 0.35 t<sub>RCKSW</sub>

### Table 2-97 • A3PE3000 Global Resource

Notes:

1. Value reflects minimum load. The delay is measured from the CCC output to the clock pin of a sequential element, located in a lightly loaded row (single element is connected to the global net).

2. Value reflects maximum load. The delay is measured on the clock pin of the farthest sequential element, located in a fully loaded row (all available flip-flops are connected to the global net in the row).

3. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

### **Clock Conditioning Circuits**

#### **CCC Electrical Specifications**

#### **Timing Characteristics**

#### Table 2-98 • ProASIC3E CCC/PLL Specification

Parameter		Minimum	Typical	Maximum	Units
Clock Conditioning Circuitry In	out Frequency f <sub>IN_CCC</sub>	1.5		350	MHz
Clock Conditioning Circuitry O	utput Frequency f <sub>OUT_CCC</sub>	0.75		350	MHz
Delay Increments in Programm	nable Delay Blocks <sup>1, 2</sup>		160 <sup>3</sup>		ps
Serial Clock (SCLK) for Dynam	nic PLL <sup>4</sup>			125	MHz
Number of Programmable Valu Programmable Delay Block	ies in Each			32	
Input Period Jitter				1.5	ns
CCC Output Peak-to-Peak Per	iod Jitter F <sub>CCC_OUT</sub>	Max	⟨Peak-to-Pe	ak Period Jitter	
		1 Global Network Used		3 Global Networks Used	
0.75 MHz to 24 MHz		0.50%		0.70%	
24 MHz to 100 MHz		1.00%		1.20%	
100 MHz to 250 MHz		1.75%		2.00%	
250 MHz to 350 MHz		2.50%		5.60%	
Acquisition Time	LockControl = 0			300	μs
	LockControl = 1			6.0	ms
Tracking Jitter <sup>5</sup>	LockControl = 0			1.6	ns
	LockControl = 1			0.8	ns
Output Duty Cycle		48.5		51.5	%
Delay Range in Block: Program	nmable Delay 1 <sup>1, 2</sup>	0.6		5.56	ns
Delay Range in Block: Program	nmable Delay 2 <sup>1,2</sup>	0.025		5.56	ns
Delay Range in Block: Fixed D	elay <sup>1,4</sup>		2.2		ns

Notes:

1. This delay is a function of voltage and temperature. See Table 2-6 on page 2-6 for deratings

2.  $T_J = 25^{\circ}C$ , VCC = 1.5 V.

3. When the CCC/PLL core is generated by Microsemi core generator software, not all delay values of the specified delay increments are available. Refer to the Libero SoC Online Help for more information.

4. Maximum value obtained for a –2 speed-grade device in worst-case commercial conditions. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

5. Tracking jitter is defined as the variation in clock edge position of PLL outputs with reference to the PLL input clock edge. Tracking jitter does not measure the variation in PLL output period, which is covered by the period jitter parameter.



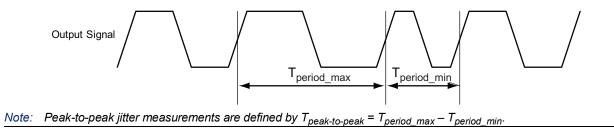


Figure 2-39 • Peak-to-Peak Jitter Definition



### **Embedded SRAM and FIFO Characteristics**

### SRAM

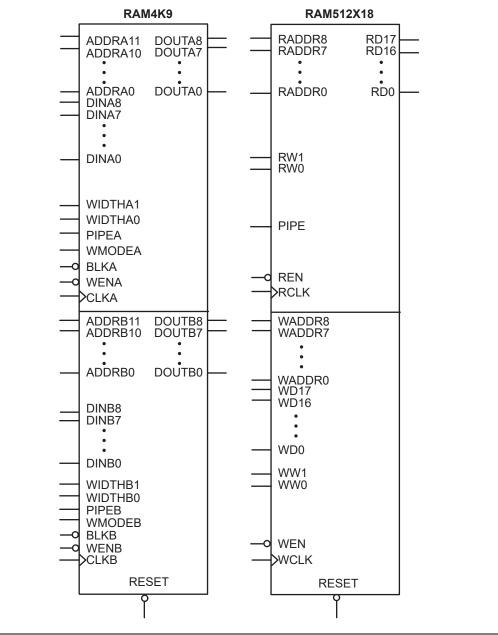
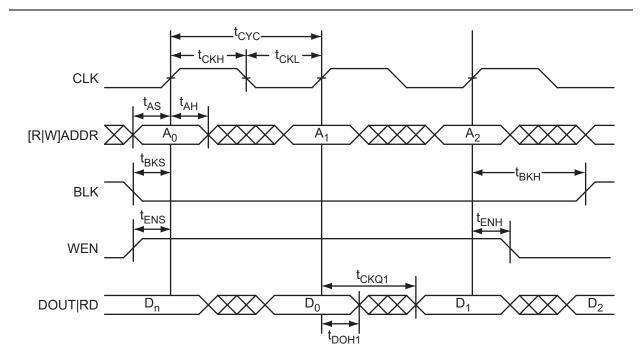
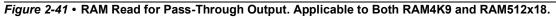


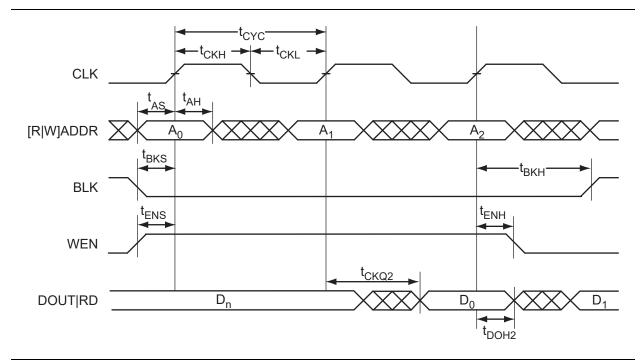
Figure 2-40 • RAM Models



### Timing Waveforms

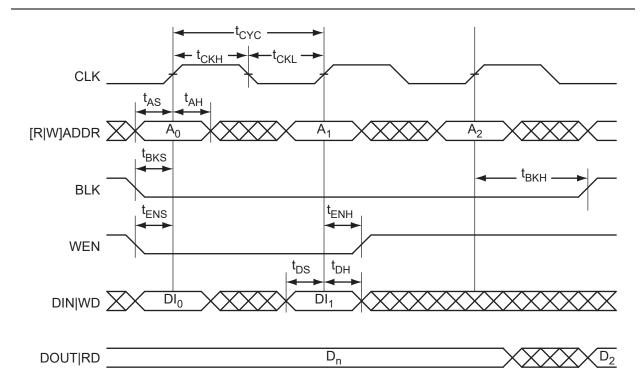


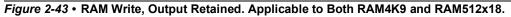


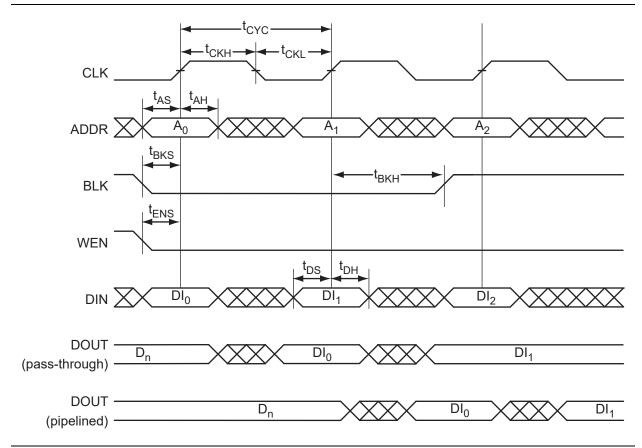
















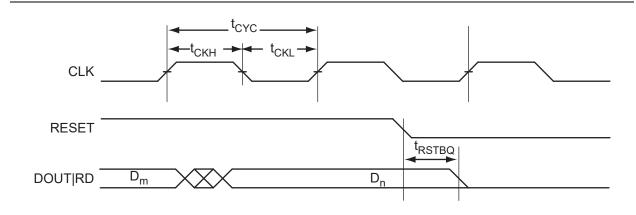


Figure 2-45 • RAM Reset. Applicable to Both RAM4K9 and RAM512x18.



### **Timing Characteristics**

#### Table 2-99 • RAM4K9

Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V

Parameter	Description	-2	-1	Std.	Units
t <sub>AS</sub>	Address setup time	0.25	0.28	0.33	ns
t <sub>AH</sub>	Address hold time	0.00	0.00	0.00	ns
t <sub>ENS</sub>	REN, WEN setup time	0.14	0.16	0.19	ns
t <sub>ENH</sub>	REN, WEN hold time	0.10	0.11	0.13	ns
t <sub>BKS</sub>	BLK setup time	0.23	0.27	0.31	ns
t <sub>BKH</sub>	BLK hold time	0.02	0.02	0.02	ns
t <sub>DS</sub>	Input data (DIN) setup time	0.18	0.21	0.25	ns
t <sub>DH</sub>	Input data (DIN) hold time	0.00	0.00	0.00	ns
t <sub>CKQ1</sub>	Clock High to new data valid on DOUT (output retained, WMODE = 0)	1.79	2.03	2.39	ns
	Clock High to new data valid on DOUT (flow-through, WMODE = 1)	2.36	2.68	3.15	ns
t <sub>CKQ2</sub>	Clock High to new data valid on DOUT (pipelined)	0.89	1.02	1.20	ns
t <sub>C2CWWL</sub> 1	Address collision clk-to-clk delay for reliable write after write on same address—Applicable to Closing Edge	0.33	0.28	0.25	ns
t <sub>C2CWWH</sub> 1	Address collision clk-to-clk delay for reliable write after write on same address—Applicable to Rising Edge	0.30	0.26	0.23	ns
t <sub>C2CRWH</sub> 1	Address collision clk-to-clk delay for reliable read access after write on same address—Applicable to Opening Edge	0.45	0.38	0.34	ns
t <sub>C2CWRH</sub> 1	Address collision clk-to-clk delay for reliable write access after read on same address— Applicable to Opening Edge	0.49	0.42	0.37	ns
t <sub>RSTBQ</sub>	RESET Low to data out Low on DO (flow-through)	0.92	1.05	1.23	ns
	RESET Low to Data Out Low on DO (pipelined)	0.92	1.05	1.23	ns
t <sub>REMRSTB</sub>	RESET removal	0.29	0.33	0.38	ns
t <sub>RECRSTB</sub>	RESET recovery	1.50	1.71	2.01	ns
t <sub>MPWRSTB</sub>	RESET minimum pulse width	0.21	0.24	0.29	ns
t <sub>CYC</sub>	Clock cycle time	3.23	3.68	4.32	ns
F <sub>MAX</sub>	Maximum frequency	310	272	231	MHz

Notes:

1. For more information, refer to the application note Simultaneous Read-Write Operations in Dual-Port SRAM for Flash-Based cSoCs and FPGAs.

2. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

Parameter	Description	-2	-1	Std.	Units
t <sub>AS</sub>	Address setup time	0.25	0.28	0.33	ns
t <sub>AH</sub>	Address hold time	0.00	0.00	0.00	ns
t <sub>ENS</sub>	REN, WEN setup time	0.18	0.20	0.24	ns
t <sub>ENH</sub>	REN, WEN hold time	0.06	0.07	0.08	ns
t <sub>DS</sub>	Input data (WD) setup time	0.18	0.21	0.25	ns
t <sub>DH</sub>	Input data (WD) hold time	0.00	0.00	0.00	ns
t <sub>CKQ1</sub>	Clock High to new data valid on RD (output retained)	2.16	2.46	2.89	ns
t <sub>CKQ2</sub>	Clock High to new data valid on RD (pipelined)	0.90	1.02	1.20	ns
t <sub>C2CRWH</sub> 1	Address collision clk-to-clk delay for reliable read access after write on same address—Applicable to Opening Edge	0.50	0.43	0.38	ns
t <sub>C2CWRH</sub> 1	Address collision clk-to-clk delay for reliable write access after read on same address— Applicable to Opening Edge	0.59	0.50	0.44	ns
t <sub>RSTBQ</sub>	RESET Low to data out Low on RD (flow-through)	0.92	1.05	1.23	ns
	RESET Low to data out Low on RD (pipelined)	0.92	1.05	1.23	ns
t <sub>REMRSTB</sub>	RESET removal	0.29	0.33	0.38	ns
t <sub>RECRSTB</sub>	RESET recovery	1.50	1.71	2.01	ns
t <sub>MPWRSTB</sub>	RESET minimum pulse width	0.21	0.24	0.29	ns
t <sub>CYC</sub>	Clock cycle time	3.23	3.68	4.32	ns
F <sub>MAX</sub>	Maximum frequency	310	272	231	MHz

#### Table 2-100 • RAM512X18 Commercial-Case Conditions: T<sub>J</sub> = 70°C, Worst-Case VCC = 1.425 V

Notes:

1. For more information, refer to the application note Simultaneous Read-Write Operations in Dual-Port SRAM for Flash-Based cSoCs and FPGAs.

2. For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.



**FIFO** 

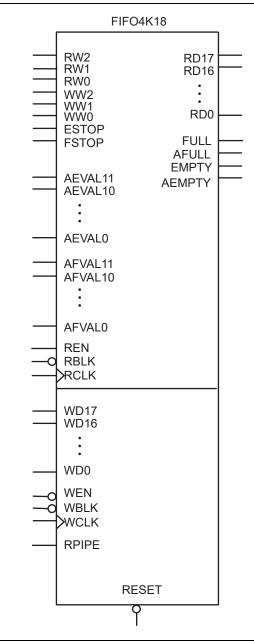
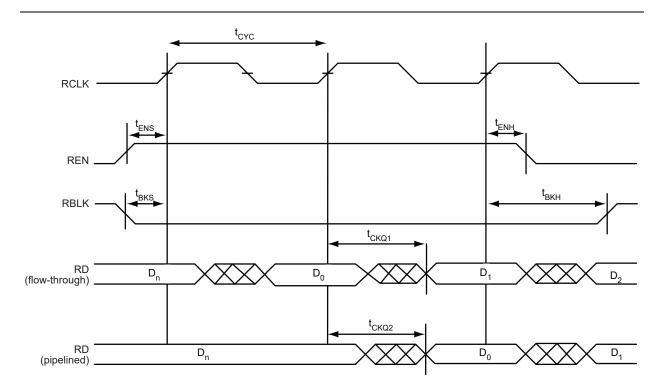


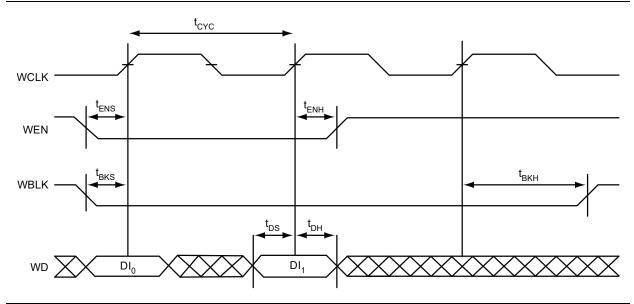
Figure 2-46 • FIFO Model

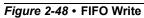


### **Timing Waveforms**









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82

СС Microsemi. a СМіскоснір company ProASIC3E Flash Family FPGAs

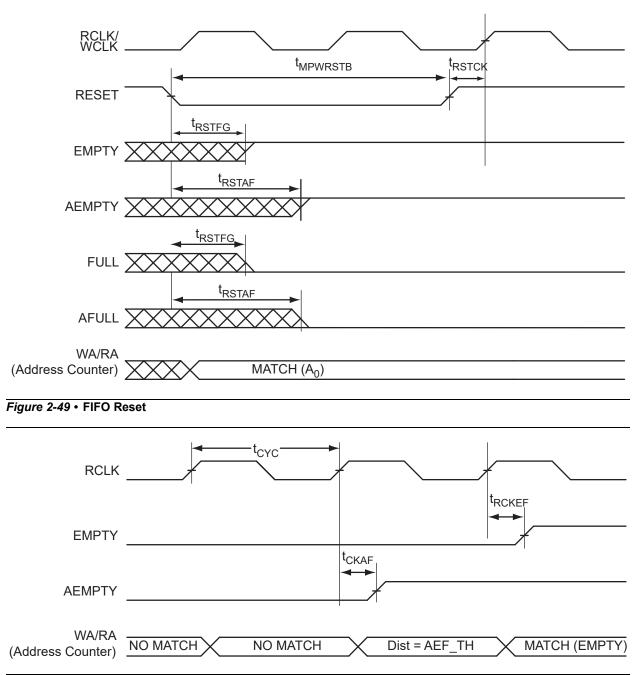
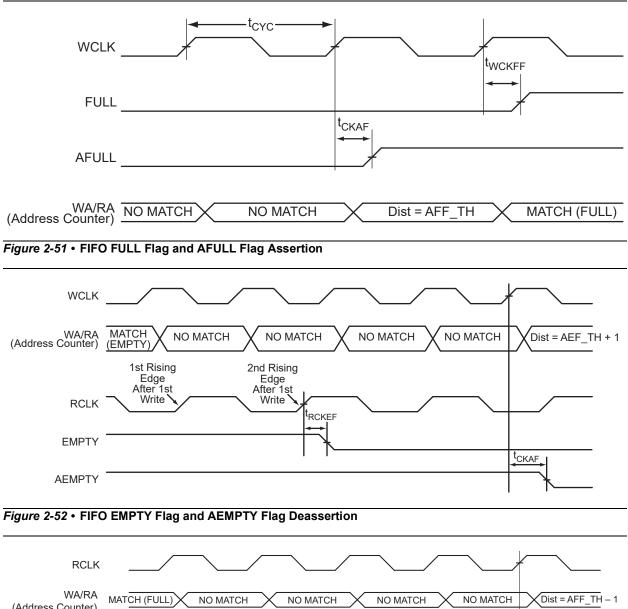
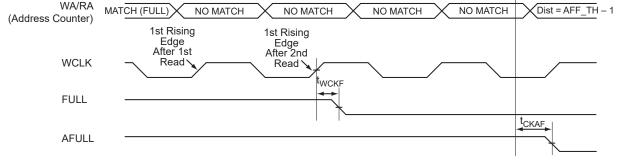
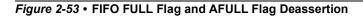


Figure 2-50 • FIFO EMPTY Flag and AEMPTY Flag Assertion











### **Timing Characteristics**

#### Table 2-101 • FIFO

Commercial-Case Conditions: T<sub>J</sub> = 70°C, VCC = 1.425 V

Parameter	Description	-2	-1	Std.	Units
t <sub>ENS</sub>	REN, WEN Setup Time	1.38	1.57	1.84	ns
t <sub>ENH</sub>	REN, WEN Hold Time	0.02	0.02	0.02	ns
t <sub>BKS</sub>	BLK Setup Time	0.19	0.22	0.26	ns
t <sub>BKH</sub>	BLK Hold Time	0.00	0.00	0.00	ns
t <sub>DS</sub>	Input Data (WD) Setup Time	0.18	0.21	0.25	ns
t <sub>DH</sub>	Input Data (WD) Hold Time	0.00	0.00	0.00	ns
t <sub>CKQ1</sub>	Clock High to New Data Valid on RD (pass-through)	2.36	2.68	3.15	ns
t <sub>CKQ2</sub>	Clock High to New Data Valid on RD (pipelined)	0.89	1.02	1.20	ns
t <sub>RCKEF</sub>	RCLK High to Empty Flag Valid	1.72	1.96	2.30	ns
t <sub>WCKFF</sub>	WCLK High to Full Flag Valid	1.63	1.86	2.18	ns
t <sub>CKAF</sub>	Clock High to Almost Empty/Full Flag Valid	6.19	7.05	8.29	ns
t <sub>RSTFG</sub>	RESET Low to Empty/Full Flag Valid	1.69	1.93	2.27	ns
t <sub>RSTAF</sub>	RESET Low to Almost Empty/Full Flag Valid	6.13	6.98	8.20	ns
t <sub>RSTBQ</sub>	RESET Low to Data Out Low on RD (pass-through)	0.92	1.05	1.23	ns
	RESET Low to Data Out Low on RD (pipelined)	0.92	1.05	1.23	ns
t <sub>REMRSTB</sub>	RESET Removal	0.29	0.33	0.38	ns
t <sub>RECRSTB</sub>	RESET Recovery	1.50	1.71	2.01	ns
t <sub>MPWRSTB</sub>	RESET Minimum Pulse Width	0.21	0.24	0.29	ns
t <sub>CYC</sub>	Clock Cycle Time	3.23	3.68	4.32	ns
F <sub>MAX</sub>	Maximum Frequency	310	272	231	MHz

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.



# 3 – Pin Descriptions and Packaging

### **Supply Pins**

#### GND

#### Ground

Ground supply voltage to the core, I/O outputs, and I/O logic.

#### GNDQ

#### Ground (quiet)

Quiet ground supply voltage to input buffers of I/O banks. Within the package, the GNDQ plane is decoupled from the simultaneous switching noise originated from the output buffer ground domain. This minimizes the noise transfer within the package and improves input signal integrity. GNDQ must always be connected to GND on the board.

#### vcc

#### Core Supply Voltage

Supply voltage to the FPGA core, nominally 1.5 V. VCC is required for powering the JTAG state machine in addition to VJTAG. Even when a device is in bypass mode in a JTAG chain of interconnected devices, both VCC and VJTAG must remain powered to allow JTAG signals to pass through the device.

#### VCCIBx I/O Supply Voltage

Supply voltage to the bank's I/O output buffers and I/O logic. Bx is the I/O bank number. There are up to eight I/O banks on low power flash devices plus a dedicated VJTAG bank. Each bank can have a separate VCCI connection. All I/Os in a bank will run off the same VCCIBx supply. VCCI can be 1.5 V, 1.8 V, 2.5 V, or 3.3 V, nominal voltage. In general, unused I/O banks should have their corresponding VCCIX pins tied to GND. If an output pad is terminated to ground through any resistor and if the corresponding VCCIX is left floating, then the leakage current to ground is ~ 0uA. However, if an output pad is terminated to ground is ~ 3 uA. For unused banks the aforementioned behavior is to be taken into account while deciding if it's better to float VCCIX of unused bank or tie it to GND.

#### VMVx

#### I/O Supply Voltage (quiet)

Quiet supply voltage to the input buffers of each I/O bank. *x* is the bank number. Within the package, the VMV plane biases the input stage of the I/Os in the I/O banks. This minimizes the noise transfer within the package and improves input signal integrity. Each bank must have at least one VMV connection, and no VMV should be left unconnected. All I/Os in a bank run off the same VMVx supply. VMV is used to provide a quiet supply voltage to the input buffers of each I/O bank. VMVx can be 1.5 V, 1.8 V, 2.5 V, or 3.3 V, nominal voltage. Unused I/O banks should have their corresponding VMV pins tied to GND. VMV and VCCI should be at the same voltage within a given I/O bank. Used VMV pins must be connected to the corresponding VCCI pins of the same bank (i.e., VMV0 to VCCIB0, VMV1 to VCCIB1, etc.).

#### VCCPLA/B/C/D/E/F PLL Supply Voltage

Supply voltage to analog PLL, nominally 1.5 V.

When the PLLs are not used, the place-and-route tool automatically disables the unused PLLs to lower power consumption. The user should tie unused VCCPLx and VCOMPLx pins to ground. Microsemi recommends tying VCCPLx to VCC and using proper filtering circuits to decouple VCC noise from the PLLs. Refer to the PLL Power Supply Decoupling section of the "Clock Conditioning Circuits in Low Power Flash Devices and Mixed Signal FPGAs" chapter of the *ProASIC3E FPGA Fabric User's Guide* for a complete board solution for the PLL analog power supply and ground.

There are six VCCPLX pins on ProASIC3E devices.

#### VCOMPLA/B/C/D/E/F PLL Ground

Ground to analog PLL power supplies. When the PLLs are not used, the place-and-route tool automatically disables the unused PLLs to lower power consumption. The user should tie unused VCCPLx and VCOMPLx pins to ground.

There are six VCOMPL pins (PLL ground) on ProASIC3E devices.

#### VJTAG JTAG Supply Voltage

Low power flash devices have a separate bank for the dedicated JTAG pins. The JTAG pins can be run at any voltage from 1.5 V to 3.3 V (nominal). Isolating the JTAG power supply in a separate I/O bank gives greater flexibility in supply selection and simplifies power supply and PCB design. If the JTAG



interface is neither used nor planned for use, the VJTAG pin together with the TRST pin could be tied to GND. It should be noted that VCC is required to be powered for JTAG operation; VJTAG alone is insufficient. If a device is in a JTAG chain of interconnected boards, the board containing the device can be powered down, provided both VJTAG and VCC to the part remain powered; otherwise, JTAG signals will not be able to transition the device, even in bypass mode.

Microsemi recommends that VPUMP and VJTAG power supplies be kept separate with independent filtering capacitors rather than supplying them from a common rail.

#### VPUMP

#### Programming Supply Voltage

For programming, VPUMP should be 3.3 V nominal. During normal device operation, VPUMP can be left floating or can be tied (pulled up) to any voltage between 0 V and the VPUMP maximum. Programming power supply voltage (VPUMP) range is listed in the datasheet.

When the VPUMP pin is tied to ground, it will shut off the charge pump circuitry, resulting in no sources of oscillation from the charge pump circuitry.

For proper programming, 0.01  $\mu$ F and 0.33  $\mu$ F capacitors (both rated at 16 V) are to be connected in parallel across VPUMP and GND, and positioned as close to the FPGA pins as possible.

Microsemi recommends that VPUMP and VJTAG power supplies be kept separate with independent filtering capacitors rather than supplying them from a common rail.

### **User-Defined Supply Pins**

#### VREF

#### I/O Voltage Reference

Reference voltage for I/O minibanks. VREF pins are configured by the user from regular I/Os, and any I/O in a bank, except JTAG I/Os, can be designated the voltage reference I/O. Only certain I/O standards require a voltage reference—HSTL (I) and (II), SSTL2 (I) and (II), SSTL3 (I) and (II), and GTL/GTL+. One VREF pin can support the number of I/Os available in its minibank.

### **User Pins**

#### I/O

#### User Input/Output

The I/O pin functions as an input, output, tristate, or bidirectional buffer. Input and output signal levels are compatible with the I/O standard selected.

During programming, I/Os become tristated and weakly pulled up to VCCI. With VCCI, VMV, and VCC supplies continuously powered up, when the device transitions from programming to operating mode, the I/Os are instantly configured to the desired user configuration.

Unused I/Os are configured as follows:

- Output buffer is disabled (with tristate value of high impedance)
- Input buffer is disabled (with tristate value of high impedance)
- Weak pull-up is programmed

#### GL Globals

GL I/Os have access to certain clock conditioning circuitry (and the PLL) and/or have direct access to the global network (spines). Additionally, the global I/Os can be used as regular I/Os, since they have identical capabilities. Unused GL pins are configured as inputs with pull-up resistors.

See more detailed descriptions of global I/O connectivity in the "Clock Conditioning Circuits in Low Power Flash Devices and Mixed Signal FPGAs" chapter of the *ProASIC3E FPGA Fabric User's Guide*. All inputs labeled GC/GF are direct inputs into the quadrant clocks. For example, if GAA0 is used for an input, GAA1 and GAA2 are no longer available for input to the quadrant globals. All inputs labeled GC/GF are direct inputs into the chip-level globals, and the rest are connected to the quadrant globals. The inputs to the global network are multiplexed, and only one input can be used as a global input.

Refer to the I/O Structure section of the *ProASIC3E FPGA Fabric User's Guide* for an explanation of the naming of global pins.



### **JTAG Pins**

Low power flash devices have a separate bank for the dedicated JTAG pins. The JTAG pins can be run at any voltage from 1.5 V to 3.3 V (nominal). VCC must also be powered for the JTAG state machine to operate, even if the device is in bypass mode; VJTAG alone is insufficient. Both VJTAG and VCC to the part must be supplied to allow JTAG signals to transition the device. Isolating the JTAG power supply in a separate I/O bank gives greater flexibility in supply selection and simplifies power supply and PCB design. If the JTAG interface is neither used nor planned for use, the VJTAG pin together with the TRST pin could be tied to GND.

#### Test Clock

Test clock input for JTAG boundary scan, ISP, and UJTAG. The TCK pin does not have an internal pullup/-down resistor. If JTAG is not used, Microsemi recommends tying off TCK to GND through a resistor placed close to the FPGA pin. This prevents JTAG operation in case TMS enters an undesired state.

Note that to operate at all VJTAG voltages, 500 W to 1 k $\Omega$  will satisfy the requirements. Refer to Table 3-1 for more information.

VJTAG	Tie-Off Resistance			
VJTAG at 3.3 V	200 Ω to 1 kΩ			
VJTAG at 2.5 V	200 Ω to 1 kΩ			
VJTAG at 1.8 V	500 $\Omega$ to 1 k $\Omega$			
VJTAG at 1.5 V	500 Ω to 1 kΩ			

Notes:

тск

- 1. Equivalent parallel resistance if more than one device is on the JTAG chain
- 2. The TCK pin can be pulled up/down.
- 3. The TRST pin is pulled down.

#### TDI

#### Test Data Input

Serial input for JTAG boundary scan, ISP, and UJTAG usage. There is an internal weak pull-up resistor on the TDI pin.

#### TDO

Test Data Output

Serial output for JTAG boundary scan, ISP, and UJTAG usage.

#### TMS

#### Test Mode Select

The TMS pin controls the use of the IEEE 1532 boundary scan pins (TCK, TDI, TDO, TRST). There is an internal weak pull-up resistor on the TMS pin.

#### TRST

#### Boundary Scan Reset Pin

The TRST pin functions as an active-low input to asynchronously initialize (or reset) the boundary scan circuitry. There is an internal weak pull-up resistor on the TRST pin. If JTAG is not used, an external pull-down resistor could be included to ensure the test access port (TAP) is held in reset mode. The resistor values must be chosen from Table 3-1 and must satisfy the parallel resistance value requirement. The values in Table 3-1 correspond to the resistor recommended when a single device is used, and the equivalent parallel resistor when multiple devices are connected via a JTAG chain.

In critical applications, an upset in the JTAG circuit could allow entrance to an undesired JTAG state. In such cases, Microsemi recommends tying off TRST to GND through a resistor placed close to the FPGA pin.

Note that to operate at all VJTAG voltages, 500  $\Omega$  to 1 k $\Omega$  will satisfy the requirements.

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### **Special Function Pins**

#### NC

#### No Connect

This pin is not connected to circuitry within the device. These pins can be driven to any voltage or can be left floating with no effect on the operation of the device.

DC

Do Not Connect

This pin should not be connected to any signals on the PCB. These pins should be left unconnected.

### Packaging

Semiconductor technology is constantly shrinking in size while growing in capability and functional integration. To enable next-generation silicon technologies, semiconductor packages have also evolved to provide improved performance and flexibility.

Microsemi consistently delivers packages that provide the necessary mechanical and environmental protection to ensure consistent reliability and performance. Microsemi IC packaging technology efficiently supports high-density FPGAs with large-pin-count Ball Grid Arrays (BGAs), but is also flexible enough to accommodate stringent form factor requirements for Chip Scale Packaging (CSP). In addition, Microsemi offers a variety of packages designed to meet your most demanding application and economic requirements for today's embedded and mobile systems.

### **Related Documents**

#### **User's Guides**

ProASIC3E FPGA Fabric User's Guide http://www.microsemi.com/document-portal/doc\_download/130883-proasic3e-fpga-fabric-user-s-guide

### Packaging

The following documents provide packaging information and device selection for low power flash devices.

#### **Product Catalog**

#### http://www.microsemi.com/soc/documents/ProdCat\_PIB.pdf

Lists devices currently recommended for new designs and the packages available for each member of the family. Use this document or the datasheet tables to determine the best package for your design, and which package drawing to use.

#### Package Mechanical Drawings

http://www.microsemi.com/document-portal/doc\_download/131095-package-mechanical-drawings

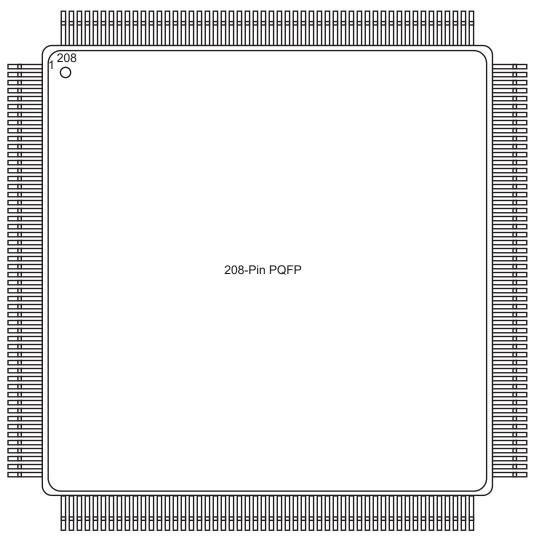
This document contains the package mechanical drawings for all packages currently or previously supplied by Microsemi. Use the bookmarks to navigate to the package mechanical drawings.

Additional packaging materials: http://www.microsemi.com/products/fpga-soc/solutions.



# 4 – Package Pin Assignments

## PQ208



*Note:* This is the top view of the package.

#### Note

For Package Manufacturing and Environmental information, visit the Resource Center at *http://www.microsemi.com/products/fpga-soc/solutions*.



Package Pin Assignments

PQ208		PQ208			PQ208	
Pin Number A3PE1500 Function		Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function	
1	GND	37	IO184PDB6V2	73	IO145NDB5V1	
2	GNDQ	38	IO184NDB6V2	74	IO145PDB5V1	
3	VMV7	39	IO180PSB6V1	75	IO143NDB5V1	
4	GAB2/IO220PSB7V3	40	VCCIB6	76	IO143PDB5V1	
5	GAA2/IO221PDB7V3	41	GND	77	IO137NDB5V0	
6	IO221NDB7V3	42	IO176PDB6V1	78	IO137PDB5V0	
7	GAC2/IO219PDB7V3	43	IO176NDB6V1	79	IO135NDB5V0	
8	IO219NDB7V3	44	GEC1/IO169PDB6V0	80	IO135PDB5V0	
9	IO215PDB7V3	45	GEC0/IO169NDB6V0	81	GND	
10	IO215NDB7V3	46	GEB1/IO168PPB6V0	82	IO131NDB4V2	
11	IO212PDB7V2	47	GEA1/IO167PPB6V0	83	IO131PDB4V2	
12	IO212NDB7V2	48	GEB0/IO168NPB6V0	84	IO129NDB4V2	
13	IO208PDB7V2	49	GEA0/IO167NPB6V0	85	IO129PDB4V2	
14	IO208NDB7V2	50	VMV6	86	IO127NDB4V2	
15	IO204PSB7V1	51	GNDQ	87	IO127PDB4V2	
16	VCC	52	GND	88	VCC	
17	GND	53	VMV5	89	VCCIB4	
18	VCCIB7	54	GNDQ	90	IO121NDB4V1	
19	IO200PDB7V1	55	IO166NDB5V3	91	IO121PDB4V1	
20	IO200NDB7V1	56	GEA2/IO166PDB5V3	92	IO119NDB4V1	
21	IO196PSB7V0	57	IO165NDB5V3	93	IO119PDB4V1	
22	GFC1/IO192PSB7V0	58	GEB2/IO165PDB5V3	94	IO113NDB4V0	
23	GFB1/IO191PDB7V0	59	IO164NDB5V3	95	GDC2/IO113PDB4V0	
24	GFB0/IO191NDB7V0	60	GEC2/IO164PDB5V3	96	IO112NDB4V0	
25	VCOMPLF	61	IO163PSB5V3	97	GND	
26	GFA0/IO190NPB6V2	62	VCCIB5	98	GDB2/IO112PDB4V0	
27	VCCPLF	63	IO161PSB5V3	99	GDA2/IO111PSB4V0	
28	GFA1/IO190PPB6V2	64	IO157NDB5V2	100	GNDQ	
29	GND	65	GND	101	TCK	
30	GFA2/IO189PDB6V2	66	IO157PDB5V2	102	TDI	
31	IO189NDB6V2	67	IO153NDB5V2	103	TMS	
32	GFB2/IO188PPB6V2	68	IO153PDB5V2	104	VMV4	
33	GFC2/IO187PPB6V2	69	IO149NDB5V1	105	GND	
34	IO188NPB6V2	70	IO149PDB5V1	106	VPUMP	
35	IO187NPB6V2	71	VCC	107	GNDQ	
36	VCC	72	VCCIB5	108	TDO	

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ProASIC3E Flash Family FPGAs

PQ208		PQ208			PQ208	
Pin Number A3PE1500 Function		Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function	
109	TRST	145	IO71NDB2V2	181	IO29NDB0V3	
110	VJTAG	146	IO71PDB2V2	182	IO27PDB0V3	
111	VMV3	147	IO67NDB2V1	183	IO27NDB0V3	
112	GDA0/IO110NPB3V2	148	IO67PDB2V1	184	IO23PDB0V2	
113	GDB0/IO109NPB3V2	149	IO65NDB2V1	185	IO23NDB0V2	
114	GDA1/IO110PPB3V2	150	IO65PDB2V1	186	VCCIB0	
115	GDB1/IO109PPB3V2	151	GBC2/IO60PSB2V0	187	VCC	
116	GDC0/IO108NDB3V2	152	GBA2/IO58PSB2V0	188	IO18PDB0V2	
117	GDC1/IO108PDB3V2	153	GBB2/IO59PSB2V0	189	IO18NDB0V2	
118	IO105NDB3V2	154	VMV2	190	IO15PDB0V1	
119	IO105PDB3V2	155	GNDQ	191	IO15NDB0V1	
120	IO101NDB3V1	156	GND	192	IO12PSB0V1	
121	IO101PDB3V1	157	VMV1	193	IO11PDB0V1	
122	GND	158	GNDQ	194	IO11NDB0V1	
123	VCCIB3	159	GBA1/IO57PDB1V3	195	GND	
124	GCC2/IO90PSB3V0	160	GBA0/IO57NDB1V3	196	IO08PDB0V1	
125	GCB2/IO89PSB3V0	161	GBB1/IO56PDB1V3	197	IO08NDB0V1	
126	NC	162	GND	198	IO05PDB0V0	
127	IO88NDB3V0	163	GBB0/IO56NDB1V3	199	IO05NDB0V0	
128	GCA2/IO88PDB3V0	164	GBC1/IO55PDB1V3	200	VCCIB0	
129	GCA1/IO87PPB3V0	165	GBC0/IO55NDB1V3	201	GAC1/IO02PDB0V0	
130	GND	166	IO51PDB1V2	202	GAC0/IO02NDB0V0	
131	VCCPLC	167	IO51NDB1V2	203	GAB1/IO01PDB0V0	
132	GCA0/IO87NPB3V0	168	IO47PDB1V1	204	GAB0/IO01NDB0V0	
133	VCOMPLC	169	IO47NDB1V1	205	GAA1/IO00PDB0V0	
134	GCB0/IO86NDB2V3	170	VCCIB1	206	GAA0/IO00NDB0V0	
135	GCB1/IO86PDB2V3	171	VCC	207	GNDQ	
136	GCC1/IO85PSB2V3	172	IO43PSB1V1	208	VMV0	
137	IO83NDB2V3	173	IO41PDB1V1	L	L	
138	IO83PDB2V3	174	IO41NDB1V1			
139	IO81PSB2V3	175	IO35PDB1V0			
140	VCCIB2	176	IO35NDB1V0			
141	GND	177	IO31PDB0V3			
142	VCC	178	GND			
143	IO73NDB2V2	179	IO31NDB0V3			
144	IO73PDB2V2	180	IO29PDB0V3			

**Revision 16** 



Package Pin Assignments

PQ208		PQ208		PQ208	
Pin Number A3PE3000 Function		Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
1	GND	40	VCCIB6	79	IO194NDB5V0
2	GNDQ	41	GND	80	IO194PDB5V0
3	VMV7	42	IO244PDB6V1	81	GND
4	GAB2/IO308PSB7V4	43	IO244NDB6V1	82	IO184NDB4V3
5	GAA2/IO309PDB7V4	44	GEC1/IO236PDB6V0	83	IO184PDB4V3
6	IO309NDB7V4	45	GEC0/IO236NDB6V0	84	IO180NDB4V3
7	GAC2/IO307PDB7V4	46	GEB1/IO235PPB6V0	85	IO180PDB4V3
8	IO307NDB7V4	47	GEA1/IO234PPB6V0	86	IO176NDB4V2
9	IO303PDB7V3	48	GEB0/IO235NPB6V0	87	IO176PDB4V2
10	IO303NDB7V3	49	GEA0/IO234NPB6V0	88	VCC
11	IO299PDB7V3	50	VMV6	89	VCCIB4
12	IO299NDB7V3	51	GNDQ	90	IO170NDB4V2
13	IO295PDB7V2	52	GND	91	IO170PDB4V2
14	IO295NDB7V2	53	VMV5	92	IO166NDB4V1
15	IO291PSB7V2	54	GNDQ	93	IO166PDB4V1
16	VCC	55	IO233NDB5V4	94	IO156NDB4V0
17	GND	56	GEA2/IO233PDB5V4	95	GDC2/IO156PDB4V0
18	VCCIB7	57	IO232NDB5V4	96	IO154NPB4V0
19	IO285PDB7V1	58	GEB2/IO232PDB5V4	97	GND
20	IO285NDB7V1	59	IO231NDB5V4	98	GDB2/IO155PSB4V0
21	IO279PSB7V0	60	GEC2/IO231PDB5V4	99	GDA2/IO154PPB4V0
22	GFC1/IO275PSB7V0	61	IO230PSB5V4	100	GNDQ
23	GFB1/IO274PDB7V0	62	VCCIB5	101	ТСК
24	GFB0/IO274NDB7V0	63	IO218NDB5V3	102	TDI
25	VCOMPLF	64	IO218PDB5V3	103	TMS
26	GFA0/IO273NPB6V4	65	GND	104	VMV4
27	VCCPLF	66	IO214PSB5V2	105	GND
28	GFA1/IO273PPB6V4	67	IO212NDB5V2	106	VPUMP
29	GND	68	IO212PDB5V2	107	GNDQ
30	GFA2/IO272PDB6V4	69	IO208NDB5V1	108	TDO
31	IO272NDB6V4	70	IO208PDB5V1	109	TRST
32	GFB2/IO271PPB6V4	71	VCC	110	VJTAG
33	GFC2/IO270PPB6V4	72	VCCIB5	111	VMV3
34	IO271NPB6V4	73	IO202NDB5V1	112	GDA0/IO153NPB3V4
35	IO270NPB6V4	74	IO202PDB5V1	113	GDB0/IO152NPB3V4
36	VCC	75	IO198NDB5V0	114	GDA1/IO153PPB3V4
37	IO252PDB6V2	76	IO198PDB5V0	115	GDB1/IO152PPB3V4
38	IO252NDB6V2	77	IO197NDB5V0	116	GDC0/IO151NDB3V4
39	IO248PSB6V1	78	IO197PDB5V0	117	GDC1/IO151PDB3V4

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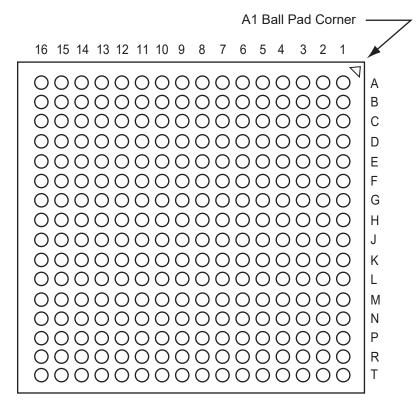
ProASIC3E Flash Family FPGAs

	PQ208		PQ208			
Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function			
118	IO134NDB3V2	157	VMV1			
119	IO134PDB3V2	158	GNDQ			
120	IO132NDB3V2	159	GBA1/IO81PDB1V4			
121	IO132PDB3V2	160	GBA0/IO81NDB1V4			
122	GND	161	GBB1/IO80PDB1V4			
123	VCCIB3	162	GND			
124	GCC2/IO117PSB3V0	163	GBB0/IO80NDB1V4			
125	GCB2/IO116PSB3V0	164	GBC1/IO79PDB1V4			
126	NC	165	GBC0/IO79NDB1V4			
127	IO115NDB3V0	166	IO74PDB1V4			
128	GCA2/IO115PDB3V0	167	IO74NDB1V4			
129	GCA1/IO114PPB3V0	168	IO70PDB1V3			
130	GND	169	IO70NDB1V3			
131	VCCPLC	170	VCCIB1			
132	GCA0/IO114NPB3V0	171	VCC			
133	VCOMPLC	172	IO56PSB1V1			
134	GCB0/IO113NDB2V3	173	IO55PDB1V1			
135	GCB1/IO113PDB2V3	174	IO55NDB1V1			
136	GCC1/IO112PSB2V3	175	IO54PDB1V1			
137	IO110NDB2V3	176	IO54NDB1V1			
138	IO110PDB2V3	177	IO40PDB0V4			
139	IO106PSB2V3	178	GND			
140	VCCIB2	179	IO40NDB0V4			
141	GND	180	IO37PDB0V4			
142	VCC	181	IO37NDB0V4			
143	IO99NDB2V2	182	IO35PDB0V4			
144	IO99PDB2V2	183	IO35NDB0V4			
145	IO96NDB2V1	184	IO32PDB0V3			
146	IO96PDB2V1	185	IO32NDB0V3			
147	IO91NDB2V1	186	VCCIB0			
148	IO91PDB2V1	187	VCC			
149	IO88NDB2V0	188	IO28PDB0V3			
150	IO88PDB2V0	189	IO28NDB0V3			
151	GBC2/IO84PSB2V0	190	IO24PDB0V2			
152	GBA2/IO82PSB2V0	191	IO24NDB0V2			
153	GBB2/IO83PSB2V0	192	IO21PSB0V2			
154	VMV2	193	IO16PDB0V1			
155	GNDQ	194	IO16NDB0V1			
156	GND	195	GND			

PQ208						
Pin Number A3PE3000 Function						
196	IO11PDB0V1					
197	IO11NDB0V1					
198	IO08PDB0V0					
199	IO08NDB0V0					
200	VCCIB0					
201	GAC1/IO02PDB0V0					
202	GAC0/IO02NDB0V0					
203	GAB1/IO01PDB0V0					
204	GAB0/IO01NDB0V0					
205	GAA1/IO00PDB0V0					
206	GAA0/IO00NDB0V0					
207	GNDQ					
208	VMV0					



### FG256



*Note:* This is the bottom view of the package.

#### Note

For Package Manufacturing and Environmental information, visit the Resource Center at *http://www.microsemi.com/products/fpga-soc/solutions.* 



ProASIC3E Flash Family FPGAs

FG256		FG256			FG256	
Pin Number A3PE600 Function		Pin Number	A3PE600 Function	Pin Number	A3PE600 Function	
A1	GND	C5	GAC0/IO02NDB0V0	E9	IO21NDB1V0	
A2	GAA0/IO00NDB0V0	C6	GAC1/IO02PDB0V0	E10	VCCIB1	
A3	GAA1/IO00PDB0V0	C7	IO15NDB0V2	E11	VCCIB1	
A4	GAB0/IO01NDB0V0	C8	IO15PDB0V2	E12	VMV1	
A5	IO05PDB0V0	C9	IO20PDB1V0	E13	GBC2/IO38PDB2V0	
A6	IO10PDB0V1	C10	IO25NDB1V0	E14	IO37NDB2V0	
A7	IO12PDB0V2	C11	IO27PDB1V0	E15	IO41NDB2V0	
A8	IO16NDB0V2	C12	GBC0/IO33NDB1V1	E16	IO41PDB2V0	
A9	IO23NDB1V0	C13	VCCPLB	F1	IO124PDB7V0	
A10	IO23PDB1V0	C14	VMV2	F2	IO125PDB7V0	
A11	IO28NDB1V1	C15	IO36NDB2V0	F3	IO126PDB7V0	
A12	IO28PDB1V1	C16	IO42PDB2V0	F4	IO130NDB7V1	
A13	GBB1/IO34PDB1V1	D1	IO128PDB7V1	F5	VCCIB7	
A14	GBA0/IO35NDB1V1	D2	IO129PDB7V1	F6	GND	
A15	GBA1/IO35PDB1V1	D3	GAC2/IO132PDB7V1	F7	VCC	
A16	GND	D4	VCOMPLA	F8	VCC	
B1	GAB2/IO133PDB7V1	D5	GNDQ	F9	VCC	
B2	GAA2/IO134PDB7V1	D6	IO09NDB0V1	F10	VCC	
B3	GNDQ	D7	IO09PDB0V1	F11	GND	
B4	GAB1/IO01PDB0V0	D8	IO13PDB0V2	F12	VCCIB2	
B5	IO05NDB0V0	D9	IO21PDB1V0	F13	IO38NDB2V0	
B6	IO10NDB0V1	D10	IO25PDB1V0	F14	IO40NDB2V0	
B7	IO12NDB0V2	D11	IO27NDB1V0	F15	IO40PDB2V0	
B8	IO16PDB0V2	D12	GNDQ	F16	IO45PSB2V1	
B9	IO20NDB1V0	D13	VCOMPLB	G1	IO124NDB7V0	
B10	IO24NDB1V0	D14	GBB2/IO37PDB2V0	G2	IO125NDB7V0	
B11	IO24PDB1V0	D15	IO39PDB2V0	G3	IO126NDB7V0	
B12	GBC1/IO33PDB1V1	D16	IO39NDB2V0	G4	GFC1/IO120PPB7V0	
B13	GBB0/IO34NDB1V1	E1	IO128NDB7V1	G5	VCCIB7	
B14	GNDQ	E2	IO129NDB7V1	G6	VCC	
B15	GBA2/IO36PDB2V0	E3	IO132NDB7V1	G7	GND	
B16	IO42NDB2V0	E4	IO130PDB7V1	G8	GND	
C1	IO133NDB7V1	E5	VMV0	G9	GND	
C2	IO134NDB7V1	E6	VCCIB0	G10	GND	
C3	VMV7	E7	VCCIB0	G11	VCC	
C4	VCCPLA	E8	IO13NDB0V2	G12	VCCIB2	



Package Pin Assignments

FG256		FG256		FG256	
Pin Number A3PE600 Function		Pin Number	A3PE600 Function	Pin Number	A3PE600 Function
G13	GCC1/IO50PPB2V1	K1	GFC2/IO115PSB6V1	M5	VMV5
G14	IO44NDB2V1	K2	IO113PPB6V1	M6	VCCIB5
G15	IO44PDB2V1	K3	IO112PDB6V1	M7	VCCIB5
G16	IO49NSB2V1	K4	IO112NDB6V1	M8	IO84NDB5V0
H1	GFB0/IO119NPB7V0	K5	VCCIB6	M9	IO84PDB5V0
H2	GFA0/IO118NDB6V1	K6	VCC	M10	VCCIB4
H3	GFB1/IO119PPB7V0	K7	GND	M11	VCCIB4
H4	VCOMPLF	K8	GND	M12	VMV3
H5	GFC0/IO120NPB7V0	K9	GND	M13	VCCPLD
H6	VCC	K10	GND	M14	GDB1/IO66PPB3V1
H7	GND	K11	VCC	M15	GDC1/IO65PDB3V1
H8	GND	K12	VCCIB3	M16	IO61NDB3V1
H9	GND	K13	IO54NPB3V0	N1	IO105PDB6V0
H10	GND	K14	IO57NPB3V0	N2	IO105NDB6V0
H11	VCC	K15	IO55NPB3V0	N3	GEC1/IO104PPB6V0
H12	GCC0/IO50NPB2V1	K16	IO57PPB3V0	N4	VCOMPLE
H13	GCB1/IO51PPB2V1	L1	IO113NPB6V1	N5	GNDQ
H14	GCA0/IO52NPB3V0	L2	IO109PPB6V0	N6	GEA2/IO101PPB5V2
H15	VCOMPLC	L3	IO108PDB6V0	N7	IO92NDB5V1
H16	GCB0/IO51NPB2V1	L4	IO108NDB6V0	N8	IO90NDB5V1
J1	GFA2/IO117PSB6V1	L5	VCCIB6	N9	IO82NDB5V0
J2	GFA1/IO118PDB6V1	L6	GND	N10	IO74NDB4V1
J3	VCCPLF	L7	VCC	N11	IO74PDB4V1
J4	IO116NDB6V1	L8	VCC	N12	GNDQ
J5	GFB2/IO116PDB6V1	L9	VCC	N13	VCOMPLD
J6	VCC	L10	VCC	N14	VJTAG
J7	GND	L11	GND	N15	GDC0/IO65NDB3V1
J8	GND	L12	VCCIB3	N16	GDA1/IO67PDB3V1
J9	GND	L13	GDB0/IO66NPB3V1	P1	GEB1/IO103PDB6V0
J10	GND	L14	IO60NDB3V1	P2	GEB0/IO103NDB6V0
J11	VCC	L15	IO60PDB3V1	P3	VMV6
J12	GCB2/IO54PPB3V0	L16	IO61PDB3V1	P4	VCCPLE
J13	GCA1/IO52PPB3V0	M1	IO109NPB6V0	P5	IO101NPB5V2
J14	GCC2/IO55PPB3V0	M2	IO106NDB6V0	P6	IO95PPB5V1
J15	VCCPLC	M3	IO106PDB6V0	P7	IO92PDB5V1
J16	GCA2/IO53PSB3V0	M4	GEC0/IO104NPB6V0	P8	IO90PDB5V1

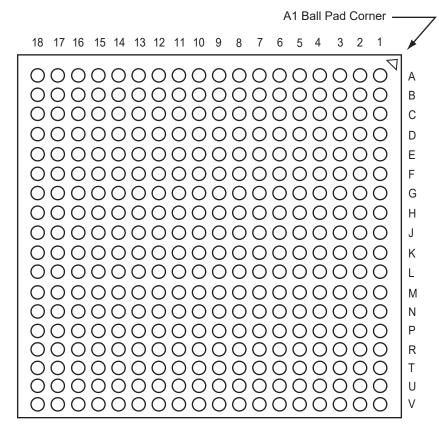
СС Microsemi. a С Міскоснір company ProASIC3E Flash Family FPGAs

FG256				
Pin Number	A3PE600 Function			
P9	IO82PDB5V0			
P10	IO76NDB4V1			
P11	IO76PDB4V1			
P12	VMV4			
P13	ТСК			
P14	VPUMP			
P15	TRST			
P16	GDA0/IO67NDB3V1			
R1	GEA1/IO102PDB6V0			
R2	GEA0/IO102NDB6V0			
R3	GNDQ			
R4	GEC2/IO99PDB5V2			
R5	IO95NPB5V1			
R6	IO91NDB5V1			
R7	IO91PDB5V1			
R8	IO83NDB5V0			
R9	IO83PDB5V0			
R10	IO77NDB4V1			
R11	IO77PDB4V1			
R12	IO69NDB4V0			
R13	GDB2/IO69PDB4V0			
R14	TDI			
R15	GNDQ			
R16	TDO			
T1	GND			
T2	IO100NDB5V2			
Т3	GEB2/IO100PDB5V2			
T4	IO99NDB5V2			
T5	IO88NDB5V0			
Т6	IO88PDB5V0			
T7	IO89NSB5V0			
Т8	IO80NSB4V1			
Т9	IO81NDB4V1			
T10	IO81PDB4V1			
T11	IO70NDB4V0			
T12	GDC2/IO70PDB4V0			

	FG256		
Pin Number	A3PE600 Function		
T13	IO68NDB4V0		
T14	GDA2/IO68PDB4V0		
T15	TMS		
T16	GND		



# FG324



Note: This is the bottom view of the package.

### Note

For Package Manufacturing and Environmental information, visit the Resource Center at *http://www.microsemi.com/products/fpga-soc/solutions*.



	FG324	FG324			FG324
Pin Number	A3PE3000 FBGA	Pin Number	A3PE3000 FBGA	Pin Number	A3PE3000 FBGA
A1	GND	C1	IO305NDB7V3	E1	IO303NDB7V3
A2	IO08NDB0V0	C2	IO308NDB7V4	E2	GNDQ
A3	IO08PDB0V0	C3	GAA2/IO309PPB7V4	E3	VMV7
A4	IO10NDB0V1	C4	GAA1/IO00PPB0V0	E4	IO307NPB7V4
A5	IO10PDB0V1	C5	VMV0	E5	VCCPLA
A6	IO12PDB0V1	C6	IO14NDB0V1	E6	GAB0/IO01NPB0V0
A7	GND	C7	IO18PDB0V2	E7	VCCIB0
A8	IO32NDB0V3	C8	IO40NDB0V4	E8	GND
A9	IO32PDB0V3	C9	IO40PDB0V4	E9	IO28NDB0V3
A10	IO42PPB1V0	C10	IO44PDB1V0	E10	IO48PDB1V0
A11	IO52NPB1V1	C11	IO56NDB1V1	E11	GND
A12	GND	C12	IO64NDB1V2	E12	VCCIB1
A13	IO66NDB1V3	C13	IO64PDB1V2	E13	IO60NPB1V2
A14	IO72NDB1V3	C14	VMV1	E14	VCCPLB
A15	IO72PDB1V3	C15	GBC0/IO79NDB1V4	E15	IO82NDB2V0
A16	IO74NDB1V4	C16	GBC1/IO79PDB1V4	E16	VMV2
A17	IO74PDB1V4	C17	GBB2/IO83PPB2V0	E17	GNDQ
A18	GND	C18	IO88NDB2V0	E18	IO90NDB2V1
B1	IO305PDB7V3	D1	IO303PDB7V3	F1	IO299NDB7V3
B2	GAB2/IO308PDB7V4	D2	VCCIB7	F2	IO299PDB7V3
B3	GAA0/IO00NPB0V0	D3	GAC2/IO307PPB7V4	F3	IO295PDB7V2
B4	VCCIB0	D4	IO309NPB7V4	F4	IO295NDB7V2
B5	GNDQ	D5	GAB1/IO01PPB0V0	F5	VCOMPLA
B6	IO12NDB0V1	D6	IO14PDB0V1	F6	IO291PPB7V2
B7	IO18NDB0V2	D7	IO24NDB0V2	F7	GAC0/IO02NDB0V0
B8	VCCIB0	D8	IO24PDB0V2	F8	GAC1/IO02PDB0V0
B9	IO42NPB1V0	D9	IO28PDB0V3	F9	IO26PDB0V3
B10	IO44NDB1V0	D10	IO48NDB1V0	F10	IO34PDB0V4
B11	VCCIB1	D11	IO56PDB1V1	F11	IO58NDB1V2
B12	IO52PPB1V1	D12	IO60PPB1V2	F12	IO58PDB1V2
B13	IO66PDB1V3	D13	GBB0/IO80NDB1V4	F13	IO94PPB2V1
B14	GNDQ	D14	GBB1/IO80PDB1V4	F14	VCOMPLB
B15	VCCIB1	D15	GBA2/IO82PDB2V0	F15	GBC2/IO84PDB2V0
B16	GBA0/IO81NDB1V4	D16	IO83NPB2V0	F16	IO84NDB2V0
B17	GBA1/IO81PDB1V4	D17	VCCIB2	F17	IO92NDB2V1
B18	IO88PDB2V0	D18	IO90PDB2V1	F18	IO92PDB2V1



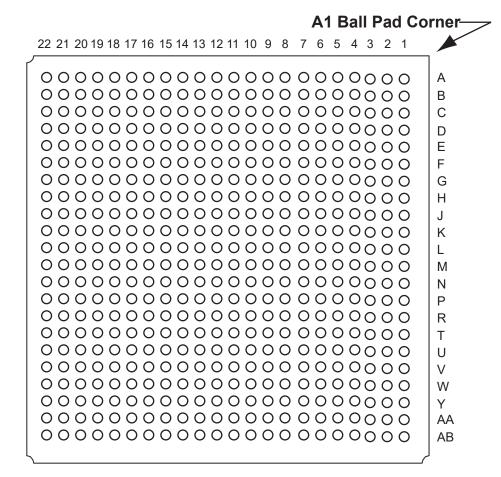
	FG324		FG324		FG324
Pin Number	A3PE3000 FBGA	Pin Number	A3PE3000 FBGA	Pin Number	A3PE3000 FBGA
G1	GND	J1	IO267NDB6V4	L1	IO263NDB6V3
G2	IO287PDB7V1	J2	GFA0/IO273NDB6V4	L2	VCCIB6
G3	IO287NDB7V1	J3	VCOMPLF	L3	IO259PDB6V3
G4	IO283PPB7V1	J4	GFA2/IO272PDB6V4	L4	IO259NDB6V3
G5	VCCIB7	J5	GFB0/IO274NPB7V0	L5	GND
G6	IO279PDB7V0	J6	GFC0/IO275NDB7V0	L6	IO270NPB6V4
G7	IO291NPB7V2	J7	GFC1/IO275PDB7V0	L7	VCC
G8	VCC	J8	GND	L8	VCC
G9	IO26NDB0V3	J9	GND	L9	GND
G10	IO34NDB0V4	J10	GND	L10	GND
G11	VCC	J11	GND	L11	VCC
G12	IO94NPB2V1	J12	GCA2/IO115PDB3V0	L12	VCC
G13	IO98PDB2V2	J13	GCA1/IO114PDB3V0	L13	IO132PDB3V2
G14	VCCIB2	J14	GCA0/IO114NDB3V0	L14	GND
G15	GCC0/IO112NPB2V3	J15	GCB0/IO113NDB2V3	L15	IO117NDB3V0
G16	IO104PDB2V2	J16	VCOMPLC	L16	IO128NPB3V1
G17	IO104NDB2V2	J17	IO120NPB3V0	L17	VCCIB3
G18	GND	J18	IO108NDB2V3	L18	IO124PPB3V1
H1	IO267PDB6V4	K1	IO263PDB6V3	M1	GND
H2	VCCIB7	K2	GFA1/IO273PDB6V4	M2	IO255PDB6V2
H3	IO283NPB7V1	K3	VCCPLF	M3	IO255NDB6V2
H4	GFB1/IO274PPB7V0	K4	IO272NDB6V4	M4	IO251PPB6V2
H5	GND	K5	GFC2/IO270PPB6V4	M5	VCCIB6
H6	IO279NDB7V0	K6	GFB2/IO271PDB6V4	M6	GEB0/IO235NDB6V0
H7	VCC	K7	IO271NDB6V4	M7	GEB1/IO235PDB6V0
H8	VCC	K8	GND	M8	VCC
H9	GND	K9	GND	M9	IO192PPB4V4
H10	GND	K10	GND	M10	IO154NPB4V0
H11	VCC	K11	GND	M11	VCC
H12	VCC	K12	IO115NDB3V0	M12	GDA0/IO153NPB3V4
H13	IO98NDB2V2	K13	GCB2/IO116PDB3V0	M13	IO132NDB3V2
H14	GND	K14	IO116NDB3V0	M14	VCCIB3
H15	GCB1/IO113PDB2V3	K15	GCC2/IO117PDB3V0	M15	IO134NDB3V2
H16	GCC1/IO112PPB2V3	K16	VCCPLC	M16	IO134PDB3V2
H17	VCCIB2	K17	IO124NPB3V1	M17	IO128PPB3V1
H18	IO108PDB2V3	K18	IO120PPB3V0	M18	GND



	FG324		FG324		FG324
Pin Number	A3PE3000 FBGA	Pin Number	A3PE3000 FBGA	Pin Number	A3PE3000 FBGA
N1	IO247NDB6V1	R1	IO245NDB6V1	U1	IO241NDB6V0
N2	IO247PDB6V1	R2	VCCIB6	U2	GEA2/IO233PPB5V4
N3	IO251NPB6V2	R3	GEA1/IO234PPB6V0	U3	GEC2/IO231PPB5V4
N4	GEC0/IO236NDB6V0	R4	IO232NDB5V4	U4	VCCIB5
N5	VCOMPLE	R5	GEB2/IO232PDB5V4	U5	GNDQ
N6	IO212NDB5V2	R6	IO214NDB5V2	U6	IO208PDB5V1
N7	IO212PDB5V2	R7	IO202PDB5V1	U7	IO198PPB5V0
N8	IO192NPB4V4	R8	IO194PDB5V0	U8	VCCIB5
N9	IO174PDB4V2	R9	IO186PDB4V4	U9	IO182NPB4V3
N10	IO170PDB4V2	R10	IO178PDB4V3	U10	IO180NPB4V3
N11	GDA2/IO154PPB4V0	R11	IO168NSB4V1	U11	VCCIB4
N12	GDB2/IO155PPB4V0	R12	IO164PDB4V1	U12	IO166PPB4V1
N13	GDA1/IO153PPB3V4	R13	GDC2/IO156PDB4V0	U13	IO162PDB4V1
N14	VCOMPLD	R14	ТСК	U14	GNDQ
N15	GDB0/IO152NDB3V4	R15	VPUMP	U15	VCCIB4
N16	GDB1/IO152PDB3V4	R16	TRST	U16	TMS
N17	IO138NDB3V3	R17	VCCIB3	U17	VMV3
N18	IO138PDB3V3	R18	IO142NDB3V3	U18	IO146NDB3V4
P1	IO245PDB6V1	T1	IO241PDB6V0	V1	GND
P2	GNDQ	T2	GEA0/IO234NPB6V0	V2	IO218NDB5V3
P3	VMV6	Т3	IO233NPB5V4	V3	IO218PDB5V3
P4	GEC1/IO236PDB6V0	T4	IO231NPB5V4	V4	IO206NDB5V1
P5	VCCPLE	T5	VMV5	V5	IO206PDB5V1
P6	IO214PDB5V2	Т6	IO208NDB5V1	V6	IO198NPB5V0
P7	VCCIB5	T7	IO202NDB5V1	V7	GND
P8	GND	Т8	IO194NDB5V0	V8	IO190NDB4V4
P9	IO174NDB4V2	Т9	IO186NDB4V4	V9	IO190PDB4V4
P10	IO170NDB4V2	T10	IO178NDB4V3	V10	IO182PPB4V3
P11	GND	T11	IO166NPB4V1	V11	IO180PPB4V3
P12	VCCIB4	T12	IO164NDB4V1	V12	GND
P13	IO155NPB4V0	T13	IO156NDB4V0	V13	IO162NDB4V1
P14	VCCPLD	T14	VMV4	V14	IO160NDB4V0
P15	VJTAG	T15	TDI	V15	IO160PDB4V0
P16	GDC0/IO151NDB3V4	T16	GNDQ	V16	IO158NDB4V0
P17	GDC1/IO151PDB3V4	T17	TDO	V17	IO158PDB4V0
P18	IO142PDB3V3	T18	IO146PDB3V4	V18	GND



## FG484



Note: This is the bottom view of the package.

### Note

For Package Manufacturing and Environmental information, visit the Resource Center at *http://www.microsemi.com/products/fpga-soc/solutions*.

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	FG484		F
Pin Number	A3PE600 Function	Pin Number	
A1	GND	AA15	
A2	GND	AA16	
A3	VCCIB0	AA17	
A4	IO06NDB0V1	AA18	
A5	IO06PDB0V1	AA19	
A6	IO08NDB0V1	AA20	
A7	IO08PDB0V1	AA21	
A8	IO11PDB0V1	AA22	
A9	IO17PDB0V2	AB1	
A10	IO18NDB0V2	AB2	
A11	IO18PDB0V2	AB3	
A12	IO22PDB1V0	AB4	
A13	IO26PDB1V0	AB5	
A14	IO29NDB1V1	AB6	
A15	IO29PDB1V1	AB7	
A16	IO31NDB1V1	AB8	
A17	IO31PDB1V1	AB9	
A18	IO32NDB1V1	AB10	
A19	NC	AB11	
A20	VCCIB1	AB12	
A21	GND	AB13	
A22	GND	AB14	
AA1	GND	AB15	
AA2	VCCIB6	AB16	
AA3	NC	AB17	
AA4	IO98PDB5V2	AB18	
AA5	IO96NDB5V2	AB19	
AA6	IO96PDB5V2	AB20	
AA7	IO86NDB5V0	AB21	
AA8	IO86PDB5V0	AB22	
AA9	IO85PDB5V0	B1	
AA10	IO85NDB5V0	B2	
AA11	IO78PPB4V1	B3	
AA12	IO79NDB4V1	B4	
AA13	IO79PDB4V1	B5	
AA14	NC	B6	

A3PE600 Function         Pin Number           NC         B7           IO71NDB4V0         B8           IO71PDB4V0         B9           NC         B10           NC         B10           NC         B10           NC         B11           NC         B12           VCCIB3         B13           GND         B16           GND         B16           GND         B16           IO97NDB5V2         B18           IO97NDB5V1         B20           IO93NDB5V1         B21           IO93NDB5V1         B21           IO87NDB5V0         C1           IO87NDB5V0         C1           IO75NDB4V1         C4           IO75NDB4V1         C5           IO72NDB4V0         C7           IO73NDB4V0         C8           IO73NDB4V0         C8           IO73PDB4V0         C10           NC         C10		FG484	
IO71NDB4V0         B8           IO71PDB4V0         B9           NC         B10           NC         B11           NC         B12           VCCIB3         B13           GND         B14           GND         B16           VCCIB5         B17           IO97NDB5V2         B18           IO97NDB5V2         B18           IO97NDB5V1         B20           IO93NDB5V1         B21           IO87NDB5V0         B21           IO87NDB5V0         B22           IO87NDB5V0         B22           IO75NDB4V1         C4           IO75NDB4V1         C4           IO75PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C10           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C13           GND         C13           GND         C13           GND         C14      GND         C15	r	A3PE600 Function	Pin Number
IO71PDB4V0         B9           NC         B10           NC         B11           NC         B12           VCCIB3         B13           GND         B14           GND         B15           GND         B16           VCCIB5         B17           IO97NDB5V2         B19           IO97NDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         C1           IO87NDB5V0         C1           IO75NDB4V1         C4           IO75PDB4V1         C5           IO73NDB4V0         C8           IO73PDB4V0         C7           IO73PDB4V0         C9           NC         C10           NC         C13           GND<		NC	B7
NC         B10           NC         B11           NC         B12           VCCIB3         B13           GND         B14           GND         B15           GND         B16           VCCIB5         B17           IO97NDB5V2         B18           IO97NDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B22           IO87NDB5V0         B22           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C4           IO75NDB4V1         C5           IO72NDB4V0         C7           IO73NDB4V0         C8           IO73NDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19 <th></th> <td>IO71NDB4V0</td> <td>B8</td>		IO71NDB4V0	B8
NC         B11           NC         B12           VCCIB3         B13           GND         B14           GND         B15           GND         B16           VCCIB5         B17           IO97NDB5V2         B18           IO97PDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B22           IO87NDB5V0         B22           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C4           IO72NDB4V0         C6           IO73NDB4V0         C8           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C13           GND         C14           QND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C18		IO71PDB4V0	B9
NC         B12           VCCIB3         B13           GND         B14           GND         B15           GND         B16           VCCIB5         B17           IO97NDB5V2         B18           IO97PDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B22           IO87NDB5V0         B22           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C4           IO72NDB4V0         C6           IO72NDB4V0         C6           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C14 <td< td=""><th></th><td>NC</td><td>B10</td></td<>		NC	B10
VCCIB3         B13           GND         B14           GND         B15           GND         B16           VCCIB5         B17           IO97NDB5V2         B18           IO97PDB5V2         B19           IO93NDB5V1         B20           IO93NDB5V1         B21           IO93PDB5V0         C1           IO87NDB5V0         B22           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C5           IO75NDB4V1         C5           IO72NDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		NC	B11
GND         B14           GND         B15           GND         B16           VCCIB5         B17           IO97NDB5V2         B18           IO97PDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B22           IO87NDB5V0         B22           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C5           IO72NDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C10           NC         C10           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		NC	B12
GND         B15           GND         B16           VCCIB5         B17           IO97NDB5V2         B18           IO97PDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B22           IO87NDB5V0         B22           IO87NDB5V0         B22           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C5           IO72NDB4V0         C6           IO72NDB4V0         C6           IO73NDB4V0         C8           IO73NDB4V0         C9           NC         C10           NC         C13           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		VCCIB3	B13
GND         B16           VCCIB5         B17           IO97NDB5V2         B18           IO97PDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B12           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C5           IO72NDB4V0         C6           IO72NDB4V0         C7           IO73NDB4V0         C8           IO73NDB4V0         C9           NC         C10           NC         C1           VCCIB4         C12           GND         C13           GND         C14           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C18		GND	B14
VCCIB5         B17           IO97NDB5V2         B18           IO97PDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B22           IO87NDB5V0         B22           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C5           IO72NDB4V0         C6           IO72NDB4V0         C6           IO73NDB4V0         C8           IO73NDB4V0         C9           NC         C10           NC         C10           NC         C1           IO72NDB4V0         C6           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		GND	B15
IO97NDB5V2         B18           IO97PDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO93PDB5V0         C1           IO87PDB5V0         C1           IO87PDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C4           IO75PDB4V1         C6           IO72NDB4V0         C7           IO73NDB4V0         C8           IO73NDB4V0         C9           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C13           QND         C10           NC         C10           NC         C10           NC         C11           VCCIB4         C12           QND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		GND	B16
IO97PDB5V2         B19           IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B22           IO87NDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C5           IO75NDB4V1         C5           IO72NDB4V0         C6           IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C10           NC         C10           IO72NDB4V0         C6           IO73PDB4V0         C10           NC         C10           NC         C10           NC         C11           VCCIB4         C12           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		VCCIB5	B17
IO93NDB5V1         B20           IO93PDB5V1         B21           IO87NDB5V0         B22           IO87PDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C4           IO75NDB4V1         C5           IO72NDB4V0         C6           IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C10           NC         C1           IO72NDB4V0         C6           IO73NDB4V0         C8           IO73NDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO97NDB5V2	B18
IO93PDB5V1         B21           IO87NDB5V0         B22           IO87PDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C4           IO75PDB4V1         C5           IO72NDB4V0         C6           IO72NDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO97PDB5V2	B19
IO87NDB5V0         B22           IO87PDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C4           IO75PDB4V1         C5           IO72NDB4V0         C6           IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C11           VC01B4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO93NDB5V1	B20
IO87PDB5V0         C1           NC         C2           NC         C3           IO75NDB4V1         C4           IO75PDB4V1         C5           IO72NDB4V0         C6           IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C10           NC         C10           NC         C10           NC         C10           NC         C11           VCCIB4         C12           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO93PDB5V1	B21
NC         C2           NC         C3           IO75NDB4V1         C4           IO75PDB4V1         C5           IO72NDB4V0         C6           IO72NDB4V0         C7           IO73NDB4V0         C7           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO87NDB5V0	B22
NC         C3           IO75NDB4V1         C4           IO75PDB4V1         C5           IO72NDB4V0         C6           IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO87PDB5V0	C1
IO75NDB4V1         C4           IO75PDB4V1         C5           IO72NDB4V0         C6           IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		NC	C2
IO75PDB4V1         C5           IO72NDB4V0         C6           IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		NC	C3
IO72NDB4V0         C6           IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO75NDB4V1	C4
IO72PDB4V0         C7           IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO75PDB4V1	C5
IO73NDB4V0         C8           IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO72NDB4V0	C6
IO73PDB4V0         C9           NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO72PDB4V0	C7
NC         C10           NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO73NDB4V0	C8
NC         C11           VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		IO73PDB4V0	C9
VCCIB4         C12           GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		NC	C10
GND         C13           GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		NC	C11
GND         C14           GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		VCCIB4	C12
GND         C15           VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		GND	C13
VCCIB7         C16           NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		GND	C14
NC         C17           IO03NDB0V0         C18           IO03PDB0V0         C19		GND	C15
IO03NDB0V0         C18           IO03PDB0V0         C19		VCCIB7	C16
IO03PDB0V0 C19		NC	C17
		IO03NDB0V0	C18
IO07NDB0V1 C20	_	IO03PDB0V0	C19
		IO07NDB0V1	C20

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Pin Number	A3PE600 Function				
B7	IO07PDB0V1				
B8	IO11NDB0V1				
B9	IO17NDB0V2				
B10	IO14PDB0V2				
B11	IO19PDB0V2				
B12	IO22NDB1V0				
B13	IO26NDB1V0				
B14	NC				
B15	NC				
B16	IO30NDB1V1				
B17	IO30PDB1V1				
B18	IO32PDB1V1				
B19	NC				
B20	NC				
B21	VCCIB2				
B22	GND				
C1	VCCIB7				
C2 NC					
C3	NC				
C4	NC				
C5	GND				
C6	IO04NDB0V0				
C7	IO04PDB0V0				
C8	VCC				
C9	VCC				
C10	IO14NDB0V2				
C11	IO19NDB0V2				
C12	NC				
C13	NC				
C14	VCC				
C15	VCC				
C16	NC				
C17	NC				
C18	GND				
C19	NC				
C20	NC				



	FG484		FG484		FG484
Pin Number	A3PE600 Function	Pin Number	A3PE600 Function	Pin Number	A3PE600 Function
C21	NC	E13	IO24NDB1V0	G5	IO129PDB7V1
C22	VCCIB2	E14	IO24PDB1V0	G6	GAC2/IO132PDB7V1
D1	NC	E15	GBC1/IO33PDB1V1	G7	VCOMPLA
D2	NC	E16	GBB0/IO34NDB1V1	G8	GNDQ
D3	NC	E17	GNDQ	G9	IO09NDB0V1
D4	GND	E18	GBA2/IO36PDB2V0	G10	IO09PDB0V1
D5	GAA0/IO00NDB0V0	E19	IO42NDB2V0	G11	IO13PDB0V2
D6	GAA1/IO00PDB0V0	E20	GND	G12	IO21PDB1V0
D7	GAB0/IO01NDB0V0	E21	NC	G13	IO25PDB1V0
D8	IO05PDB0V0	E22	NC	G14	IO27NDB1V0
D9	IO10PDB0V1	F1	NC	G15	GNDQ
D10	IO12PDB0V2	F2	IO131NDB7V1	G16	VCOMPLB
D11	IO16NDB0V2	F3	IO131PDB7V1	G17	GBB2/IO37PDB2V0
D12	IO23NDB1V0	F4	IO133NDB7V1	G18	IO39PDB2V0
D13	IO23PDB1V0	F5	IO134NDB7V1	G19	IO39NDB2V0
D14	IO28NDB1V1	F6	VMV7	G20	IO43PDB2V0
D15	IO28PDB1V1	F7	VCCPLA	G21	IO43NDB2V0
D16	GBB1/IO34PDB1V1	F8	GAC0/IO02NDB0V0	G22	NC
D17	GBA0/IO35NDB1V1	F9	GAC1/IO02PDB0V0	H1	NC
D18	GBA1/IO35PDB1V1	F10	IO15NDB0V2	H2	NC
D19	GND	F11	IO15PDB0V2	H3	VCC
D20	NC	F12	IO20PDB1V0	H4	IO128NDB7V1
D21	NC	F13	IO25NDB1V0	H5	IO129NDB7V1
D22	NC	F14	IO27PDB1V0	H6	IO132NDB7V1
E1	NC	F15	GBC0/IO33NDB1V1	H7	IO130PDB7V1
E2	NC	F16	VCCPLB	H8	VMV0
E3	GND	F17	VMV2	H9	VCCIB0
E4	GAB2/IO133PDB7V1	F18	IO36NDB2V0	H10	VCCIB0
E5	GAA2/IO134PDB7V1	F19	IO42PDB2V0	H11	IO13NDB0V2
E6	GNDQ	F20	NC	H12	IO21NDB1V0
E7	GAB1/IO01PDB0V0	F21	NC	H13	VCCIB1
E8	IO05NDB0V0	F22	NC	H14	VCCIB1
E9	IO10NDB0V1	G1	IO127NDB7V1	H15	VMV1
E10	IO12NDB0V2	G2	IO127PDB7V1	H16	GBC2/IO38PDB2V0
E11	IO16PDB0V2	G3	NC	H17	IO37NDB2V0
E12	IO20NDB1V0	G4	IO128PDB7V1	H18	IO41NDB2V0

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Pin Number	A3PE600 Function	Pin Number
H19	IO41PDB2V0	K11
H20	VCC	K12
H21	NC	K13
H22	NC	K14
J1	IO123NDB7V0	K15
J2	IO123PDB7V0	K16
J3	NC	K17
J4	IO124PDB7V0	K18
J5	IO125PDB7V0	K19
J6	IO126PDB7V0	K20
J7	IO130NDB7V1	K21
J8	VCCIB7	K22
J9	GND	L1
J10	VCC	L2
J11	VCC	L3
J12	VCC	L4
J13	VCC	L5
J14	GND	L6
J15	VCCIB2	L7
J16	IO38NDB2V0	L8
J17	IO40NDB2V0	L9
J18	IO40PDB2V0	L10
J19	IO45PPB2V1	L11
J20	NC	L12
J21	IO48PDB2V1	L13
J22	IO46PDB2V1	L14
K1	IO121NDB7V0	L15
K2	IO121PDB7V0	L16
K3	NC	L17
K4	IO124NDB7V0	L18
K5	IO125NDB7V0	L19
K6	IO126NDB7V0	L20
K7	GFC1/IO120PPB7V0	L21
K8	VCCIB7	L22
K9	VCC	M1
K10	GND	M2

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Pin Number	A3PE600 Function
K11	GND
K12	GND
K13	GND
K14	VCC
K15	VCCIB2
K16	GCC1/IO50PPB2V1
K17	IO44NDB2V1
K18	IO44PDB2V1
K19	IO49NPB2V1
K20	IO45NPB2V1
K21	IO48NDB2V1
K22	IO46NDB2V1
L1	NC
L2	IO122PDB7V0
L3	IO122NDB7V0
L4	GFB0/IO119NPB7V0
L5	GFA0/IO118NDB6V1
L6	GFB1/IO119PPB7V0
L7	VCOMPLF
L8	GFC0/IO120NPB7V0
L9	VCC
L10	GND
L11	GND
L12	GND
L13	GND
L14	VCC
L15	GCC0/IO50NPB2V1
L16	GCB1/IO51PPB2V1
L17	GCA0/IO52NPB3V0
L18	VCOMPLC
L19	GCB0/IO51NPB2V1
L20	IO49PPB2V1
L21	IO47NDB2V1
L22	IO47PDB2V1
M1	NC
M2	IO114NPB6V1

FG484				
Pin Number	A3PE600 Function			
M3	IO117NDB6V1			
M4	GFA2/IO117PDB6V1			
M5	GFA1/IO118PDB6V1			
M6	VCCPLF			
M7	IO116NDB6V1			
M8	GFB2/IO116PDB6V1			
M9	VCC			
M10	GND			
M11	GND			
M12	GND			
M13	GND			
M14	VCC			
M15	GCB2/IO54PPB3V0			
M16	GCA1/IO52PPB3V0			
M17	GCC2/IO55PPB3V0			
M18	VCCPLC			
M19	GCA2/IO53PDB3V0			
M20	IO53NDB3V0			
M21	IO56PDB3V0			
M22	NC			
N1	IO114PPB6V1			
N2	IO111NDB6V1			
N3	NC			
N4	GFC2/IO115PPB6V1			
N5	IO113PPB6V1			
N6	IO112PDB6V1			
N7	IO112NDB6V1			
N8	VCCIB6			
N9	VCC			
N10	GND			
N11	GND			
N12	GND			
N13	GND			
N14	VCC			
N15	VCCIB3			
N16	IO54NPB3V0			



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Pin Number	A3PE600 Function	Pin Num
N17	IO57NPB3V0	R9
N18	IO55NPB3V0	R10
N19	IO57PPB3V0	R11
N20	NC	R12
N21	IO56NDB3V0	R13
N22	IO58PDB3V0	R14
P1	NC	R15
P2	IO111PDB6V1	R16
P3	IO115NPB6V1	R17
P4	IO113NPB6V1	R18
P5	IO109PPB6V0	R19
P6	IO108PDB6V0	R20
P7	IO108NDB6V0	R21
P8	VCCIB6	R22
P9	GND	T1
P10	VCC	T2
P11	VCC	Т3
P12	VCC	T4
P13	VCC	Т5
P14	GND	Т6
P15	VCCIB3	Τ7
P16	GDB0/IO66NPB3V1	Т8
P17	IO60NDB3V1	Т9
P18	IO60PDB3V1	T10
P19	IO61PDB3V1	T11
P20	NC	T12
P21	IO59PDB3V0	T13
P22	IO58NDB3V0	T14
R1	NC	T15
R2	IO110PDB6V0	T16
R3	VCC	T17
R4	IO109NPB6V0	T18
R5	IO106NDB6V0	T19
R6	IO106PDB6V0	T20
R7	GEC0/IO104NPB6V0	T21
R8	VMV5	T22

	FG484			
Pin Number A3PE600 Function				
R9	VCCIB5			
R10	VCCIB5			
R11	IO84NDB5V0			
R12	IO84PDB5V0			
R13	VCCIB4			
R14	VCCIB4			
R15	VMV3			
R16	VCCPLD			
R17	GDB1/IO66PPB3V1			
R18	GDC1/IO65PDB3V1			
R19	IO61NDB3V1			
R20	VCC			
R21	IO59NDB3V0			
R22	IO62PDB3V1			
T1	NC			
T2	IO110NDB6V0			
Т3	NC			
T4	IO105PDB6V0			
T5	IO105NDB6V0			
Т6	GEC1/IO104PPB6V0			
T7	VCOMPLE			
Т8	GNDQ			
Т9	GEA2/IO101PPB5V2			
T10	IO92NDB5V1			
T11	IO90NDB5V1			
T12	IO82NDB5V0			
T13	IO74NDB4V1			
T14	IO74PDB4V1			
T15	GNDQ			
T16	VCOMPLD			
T17	VJTAG			
T18	GDC0/IO65NDB3V1			
T19	GDA1/IO67PDB3V1			
T20	NC			
T21	IO64PDB3V1			
T22	IO62NDB3V1			

FG484					
Pin Number A3PE600 Function					
U1	NC				
U2	IO107PDB6V0				
U3	IO107NDB6V0				
U4	GEB1/IO103PDB6V0				
U5	GEB0/IO103NDB6V0				
U6	VMV6				
U7	VCCPLE				
U8	IO101NPB5V2				
U9	IO95PPB5V1				
U10	IO92PDB5V1				
U11	IO90PDB5V1				
U12	IO82PDB5V0				
U13	IO76NDB4V1				
U14	IO76PDB4V1				
U15	VMV4				
U16	TCK				
U17	VPUMP				
U18	TRST				
U19	GDA0/IO67NDB3V1				
U20	NC				
U21	IO64NDB3V1				
U22	IO63PDB3V1				
V1	NC				
V2	NC				
V3	GND				
V4	GEA1/IO102PDB6V0				
V5	GEA0/IO102NDB6V0				
V6	GNDQ				
V7	GEC2/IO99PDB5V2				
V8	IO95NPB5V1				
V9	IO91NDB5V1				
V10	IO91PDB5V1				
V11	IO83NDB5V0				
V12	IO83PDB5V0				
V13	IO77NDB4V1				
V14	IO77PDB4V1				

FG484				
Pin Number A3PE600 Function				
V15	IO69NDB4V0			
V16	GDB2/IO69PDB4V0			
V17	TDI			
V18	GNDQ			
V19	TDO			
V20	GND			
V21	NC			
V22	IO63NDB3V1			
W1	NC			
W2	NC			
W3	NC			
W4	GND			
W5	IO100NDB5V2			
W6	GEB2/IO100PDB5V2			
W7	IO99NDB5V2			
W8	IO88NDB5V0			
W9	IO88PDB5V0			
W10	IO89NDB5V0			
W11	IO80NDB4V1			
W12	IO81NDB4V1			
W13	IO81PDB4V1			
W14	IO70NDB4V0			
W15	GDC2/IO70PDB4V0			
W16	IO68NDB4V0			
W17	GDA2/IO68PDB4V0			
W18	TMS			
W19	GND			
W20	NC			
W21	NC			
W22	NC			
Y1	VCCIB6			
Y2	NC			
Y3	NC			
Y4	IO98NDB5V2			
Y5	GND			
Y6	IO94NDB5V1			

FG484				
Pin Number A3PE600 Function				
Y7	IO94PDB5V1			
Y8	VCC			
Y9	VCC			
Y10	IO89PDB5V0			
Y11	IO80PDB4V1			
Y12	IO78NPB4V1			
Y13	NC			
Y14	VCC			
Y15	VCC			
Y16	NC			
Y17	NC			
Y18	GND			
Y19	NC			
Y20	NC			
Y21	NC			
Y22	VCCIB3			

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FG484			FG484		FG484
Pin Number	A3PE1500 Function	n Pin Number A3PE1500 Function		Pin Number	A3PE1500 Function
A1	GND	AA15	NC	B7	IO10PDB0V1
A2	GND	AA16	IO117NDB4V0	B8	IO15NDB0V1
A3	VCCIB0	AA17	IO117PDB4V0	В9	IO17NDB0V2
A4	IO05NDB0V0	AA18	IO115NDB4V0	B10	IO20PDB0V2
A5	IO05PDB0V0	AA19	IO115PDB4V0	B11	IO29PDB0V3
A6	IO11NDB0V1	AA20	NC	B12	IO32NDB1V0
A7	IO11PDB0V1	AA21	VCCIB3	B13	IO43NDB1V1
A8	IO15PDB0V1	AA22	GND	B14	NC
A9	IO17PDB0V2	AB1	GND	B15	NC
A10	IO27NDB0V3	AB2	GND	B16	IO53NDB1V2
A11	IO27PDB0V3	AB3	VCCIB5	B17	IO53PDB1V2
A12	IO32PDB1V0	AB4	IO159NDB5V3	B18	IO54PDB1V3
A13	IO43PDB1V1	AB5	IO159PDB5V3	B19	NC
A14	IO47NDB1V1	AB6	IO149NDB5V1	B20	NC
A15	IO47PDB1V1	AB7	IO149PDB5V1	B21	VCCIB2
A16	IO51NDB1V2	AB8	IO138NDB5V0	B22	GND
A17	IO51PDB1V2	AB9	IO138PDB5V0	C1	VCCIB7
A18	IO54NDB1V3	AB10	NC	C2	NC
A19	NC	AB11	NC	C3	NC
A20	VCCIB1	AB12	IO127NDB4V2	C4	NC
A21	GND	AB13	IO127PDB4V2	C5	GND
A22	GND	AB14	IO125NDB4V1	C6	IO07NDB0V0
AA1	GND	AB15	IO125PDB4V1	C7	IO07PDB0V0
AA2	VCCIB6	AB16	IO122NDB4V1	C8	VCC
AA3	NC	AB17	IO122PDB4V1	C9	VCC
AA4	IO161PDB5V3	AB18	NC	C10	IO20NDB0V2
AA5	IO155NDB5V2	AB19	NC	C11	IO29NDB0V3
AA6	IO155PDB5V2	AB20	VCCIB4	C12	NC
AA7	IO154NDB5V2	AB21	GND	C13	NC
AA8	IO154PDB5V2	AB22	GND	C14	VCC
AA9	IO143PDB5V1	B1	GND	C15	VCC
AA10	IO143NDB5V1	B2	VCCIB7	C16	NC
AA11	IO131PPB4V2	B3	NC	C17	NC
AA12	IO129NDB4V2	B4	IO03NDB0V0	C18	GND
AA13	IO129PDB4V2	B5	IO03PDB0V0	C19	NC
AA14	NC	B6	IO10NDB0V1	C20	NC

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FG484		FG484		FG484	
Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function
C21	NC	E13	IO41NDB1V1	G5	IO217PDB7V3
C22	VCCIB2	E14	IO41PDB1V1	G6	GAC2/IO219PDB7V3
D1	NC	E15	GBC1/IO55PDB1V3	G7	VCOMPLA
D2	NC	E16	GBB0/IO56NDB1V3	G8	GNDQ
D3	NC	E17	GNDQ	G9	IO19NDB0V2
D4	GND	E18	GBA2/IO58PDB2V0	G10	IO19PDB0V2
D5	GAA0/IO00NDB0V0	E19	IO63NDB2V0	G11	IO25PDB0V3
D6	GAA1/IO00PDB0V0	E20	GND	G12	IO33PDB1V0
D7	GAB0/IO01NDB0V0	E21	IO69NDB2V1	G13	IO39PDB1V0
D8	IO09PDB0V1	E22	NC	G14	IO45NDB1V1
D9	IO13PDB0V1	F1	IO218NPB7V3	G15	GNDQ
D10	IO21PDB0V2	F2	IO216NDB7V3	G16	VCOMPLB
D11	IO31NDB0V3	F3	IO216PDB7V3	G17	GBB2/IO59PDB2V0
D12	IO37NDB1V0	F4	IO220NDB7V3	G18	IO62PDB2V0
D13	IO37PDB1V0	F5	IO221NDB7V3	G19	IO62NDB2V0
D14	IO49NDB1V2	F6	VMV7	G20	IO71PDB2V2
D15	IO49PDB1V2	F7	VCCPLA	G21	IO71NDB2V2
D16	GBB1/IO56PDB1V3	F8	GAC0/IO02NDB0V0	G22	NC
D17	GBA0/IO57NDB1V3	F9	GAC1/IO02PDB0V0	H1	IO209PSB7V2
D18	GBA1/IO57PDB1V3	F10	IO23NDB0V2	H2	NC
D19	GND	F11	IO23PDB0V2	H3	VCC
D20	NC	F12	IO35PDB1V0	H4	IO214NDB7V3
D21	IO69PDB2V1	F13	IO39NDB1V0	H5	IO217NDB7V3
D22	NC	F14	IO45PDB1V1	H6	IO219NDB7V3
E1	NC	F15	GBC0/IO55NDB1V3	H7	IO215PDB7V3
E2	IO218PPB7V3	F16	VCCPLB	H8	VMV0
E3	GND	F17	VMV2	H9	VCCIB0
E4	GAB2/IO220PDB7V3	F18	IO58NDB2V0	H10	VCCIB0
E5	GAA2/IO221PDB7V3	F19	IO63PDB2V0	H11	IO25NDB0V3
E6	GNDQ	F20	NC	H12	IO33NDB1V0
E7	GAB1/IO01PDB0V0	F21	NC	H13	VCCIB1
E8	IO09NDB0V1	F22	NC	H14	VCCIB1
E9	IO13NDB0V1	G1	IO211NDB7V2	H15	VMV1
E10	IO21NDB0V2	G2	IO211PDB7V2	H16	GBC2/IO60PDB2V0
E11	IO31PDB0V3	G3	NC	H17	IO59NDB2V0
E12	IO35NDB1V0	G4	IO214PDB7V3	H18	IO67NDB2V1



FG484			FG484		FG484	
Pin Number	in Number A3PE1500 Function P		Pin Number A3PE1500 Function		A3PE1500 Function	
H19	IO67PDB2V1	K11	GND	M3	IO189NDB6V2	
H20	VCC	K12	GND	M4	GFA2/IO189PDB6V2	
H21	VMV2	K13	GND	M5	GFA1/IO190PDB6V2	
H22	IO74PSB2V2	K14	VCC	M6	VCCPLF	
J1	IO212NDB7V2	K15	VCCIB2	M7	IO188NDB6V2	
J2	IO212PDB7V2	K16	GCC1/IO85PPB2V3	M8	GFB2/IO188PDB6V2	
J3	VMV7	K17	IO73NDB2V2	M9	VCC	
J4	IO206PDB7V1	K18	IO73PDB2V2	M10	GND	
J5	IO204PDB7V1	K19	IO81NPB2V3	M11	GND	
J6	IO210PDB7V2	K20	IO75NPB2V2	M12	GND	
J7	IO215NDB7V3	K21	IO77NDB2V2	M13	GND	
J8	VCCIB7	K22	IO79NDB2V3	M14	VCC	
J9	GND	L1	NC	M15	GCB2/IO89PPB3V0	
J10	VCC	L2	IO196PDB7V0	M16	GCA1/IO87PPB3V0	
J11	VCC	L3	IO196NDB7V0	M17	GCC2/IO90PPB3V0	
J12	VCC	L4	GFB0/IO191NPB7V0	M18	VCCPLC	
J13	VCC	L5	GFA0/IO190NDB6V2	M19	GCA2/IO88PDB3V0	
J14	GND	L6	GFB1/IO191PPB7V0	M20	IO88NDB3V0	
J15	VCCIB2	L7	VCOMPLF	M21	IO93PDB3V0	
J16	IO60NDB2V0	L8	GFC0/IO192NPB7V0	M22	NC	
J17	IO65NDB2V1	L9	VCC	N1	IO185PPB6V2	
J18	IO65PDB2V1	L10	GND	N2	IO183NDB6V2	
J19	IO75PPB2V2	L11	GND	N3	VMV6	
J20	GNDQ	L12	GND	N4	GFC2/IO187PPB6V2	
J21	IO77PDB2V2	L13	GND	N5	IO184PPB6V2	
J22	IO79PDB2V3	L14	VCC	N6	IO186PDB6V2	
K1	IO200NDB7V1	L15	GCC0/IO85NPB2V3	N7	IO186NDB6V2	
K2	IO200PDB7V1	L16	GCB1/IO86PPB2V3	N8	VCCIB6	
K3	GNDQ	L17	GCA0/IO87NPB3V0	N9	VCC	
K4	IO206NDB7V1	L18	VCOMPLC	N10	GND	
K5	IO204NDB7V1	L19	GCB0/IO86NPB2V3	N11	GND	
K6	IO210NDB7V2	L20	IO81PPB2V3	N12	GND	
K7	GFC1/IO192PPB7V0	L21	IO83NDB2V3	N13	GND	
K8	VCCIB7	L22	IO83PDB2V3	N14	VCC	
K9	VCC	M1	GNDQ	N15	VCCIB3	
K10	GND	M2	IO185NPB6V2	N16	IO89NPB3V0	



	FG484	FG484		
Pin Number	Pin Number A3PE1500 Function			
N17	IO91NPB3V0	Pin Number R9	VCCIB5	
N18	IO90NPB3V0	R10	VCCIB5	
N19	IO91PPB3V0	R11	IO135NDB5V0	
N20	GNDQ	R12	IO135PDB5V0	
N21	IO93NDB3V0	R13	VCCIB4	
N22	IO95PDB3V1	R14	VCCIB4	
P1	NC	R15	VMV3	
P2	IO183PDB6V2	R16	VCCPLD	
P3	IO187NPB6V2	R17	GDB1/IO109PPB3V2	
P4	IO184NPB6V2	R18	GDC1/IO108PDB3V2	
P5	IO176PPB6V1	R19	IO99NDB3V1	
P6	IO182PDB6V1	R20	VCC	
P7	IO182NDB6V1	R21	IO98NDB3V1	
P8	VCCIB6	R22	IO101PDB3V1	
P9	GND		NC	
P10	VCC	T2	IO177NDB6V1	
P11	VCC	T3	NC	
P12	VCC	T4	IO171PDB6V0	
P13	VCC	Т5	IO171NDB6V0	
P14	GND	T6	GEC1/IO169PPB6V0	
P15	VCCIB3	T7	VCOMPLE	
P16	GDB0/IO109NPB3V2	Т8	GNDQ	
P17	IO97NDB3V1	Т9	GEA2/IO166PPB5V3	
P18	IO97PDB3V1	T10	IO145NDB5V1	
P19	IO99PDB3V1	T11	IO141NDB5V0	
P20	VMV3	T12	IO139NDB5V0	
P21	IO98PDB3V1	T13	IO119NDB4V1	
P22	IO95NDB3V1	T14	IO119PDB4V1	
R1	NC	T15	GNDQ	
R2	IO177PDB6V1	T16	VCOMPLD	
R3	VCC	T17	VJTAG	
R4	IO176NPB6V1	T18	GDC0/IO108NDB3V2	
R5	IO174NDB6V0	T19	GDA1/IO110PDB3V2	
R6	IO174PDB6V0	T20	NC	
R7	GEC0/IO169NPB6V0	T21	IO103PDB3V2	
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FG484			
Pin Number	A3PE1500 Function		
U1	IO175PPB6V1		
U2	IO173PDB6V0		
U3	IO173NDB6V0		
U4	GEB1/IO168PDB6V0		
U5	GEB0/IO168NDB6V0		
U6	VMV6		
U7	VCCPLE		
U8	IO166NPB5V3		
U9	IO157PPB5V2		
U10	IO145PDB5V1		
U11	IO141PDB5V0		
U12	IO139PDB5V0		
U13	IO121NDB4V1		
U14	IO121PDB4V1		
U15	VMV4		
U16	ТСК		
U17	VPUMP		
U18	TRST		
U19	GDA0/IO110NDB3V2		
U20	NC		
U21	IO103NDB3V2		
U22	IO105PDB3V2		
V1	NC		
V2	IO175NPB6V1		
V3	GND		
V4	GEA1/IO167PDB6V0		
V5	GEA0/IO167NDB6V0		
V6	GNDQ		
V7	GEC2/IO164PDB5V3		
V8	IO157NPB5V2		
V9	IO151NDB5V2		
V10	IO151PDB5V2		
V11	IO137NDB5V0		
V12	IO137PDB5V0		
V13	IO123NDB4V1		
V14	IO123PDB4V1		



	FG484	
Pin Number	A3PE1500 Function	Pin I
V15	IO112NDB4V0	
V16	GDB2/IO112PDB4V0	
V17	TDI	
V18	GNDQ	
V19	TDO	
V20	GND	,
V21	NC	,
V22	IO105NDB3V2	,
W1	NC	,
W2	NC	
W3	NC	,
W4	GND	,
W5	IO165NDB5V3	
W6	GEB2/IO165PDB5V3	
W7	IO164NDB5V3	
W8	IO153NDB5V2	
W9	IO153PDB5V2	
W10	IO147NDB5V1	
W11	IO133NDB4V2	
W12	IO130NDB4V2	
W13	IO130PDB4V2	
W14	IO113NDB4V0	
W15	GDC2/IO113PDB4V0	
W16	IO111NDB4V0	
W17	GDA2/IO111PDB4V0	
W18	TMS	
W19	GND	
W20	NC	
W21	NC	
W22	NC	
Y1	VCCIB6	
Y2	NC	
Y3	NC	
Y4	IO161NDB5V3	
Y5	GND	
Y6	IO163NDB5V3	

		FG484				
	Pin Number	A3PE1500 Function				
	Y7	IO163PDB5V3				
	Y8	VCC				
	Y9 VCC					
	Y10	Y10 IO147PDB5V1				
	Y11	IO133PDB4V2				
	Y12 IO131NPB4V2					
	Y13	Y13 NC				
	Y14 VCC					
	Y15 VCC					
	Y16 NC					
	Y17	NC				
	Y18	GND				
	Y19	NC				
	Y20 NC					
	Y21	NC				
	Y22	VCCIB3				



FG484		FG484		FG484	
Pin Number A3PE3000 Function		Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
A1	GND	AA15	IO170PDB4V2	B7	IO14PDB0V1
A2	GND	AA16	IO166NDB4V1	B8	IO18NDB0V2
A3	VCCIB0	AA17	IO166PDB4V1	B9	IO24NDB0V2
A4	IO10NDB0V1	AA18	IO160NDB4V0	B10	IO34PDB0V4
A5	IO10PDB0V1	AA19	IO160PDB4V0	B11	IO40PDB0V4
A6	IO16NDB0V1	AA20	IO158NPB4V0	B12	IO46NDB1V0
A7	IO16PDB0V1	AA21	VCCIB3	B13	IO54NDB1V1
A8	IO18PDB0V2	AA22	GND	B14	IO62NDB1V2
A9	IO24PDB0V2	AB1	GND	B15	IO62PDB1V2
A10	IO28NDB0V3	AB2	GND	B16	IO68NDB1V3
A11	IO28PDB0V3	AB3	VCCIB5	B17	IO68PDB1V3
A12	IO46PDB1V0	AB4	IO216NDB5V2	B18	IO72PDB1V3
A13	IO54PDB1V1	AB5	IO216PDB5V2	B19	IO74PDB1V4
A14	IO56NDB1V1	AB6	IO210NDB5V2	B20	IO76NPB1V4
A15	IO56PDB1V1	AB7	IO210PDB5V2	B21	VCCIB2
A16	IO64NDB1V2	AB8	IO208NDB5V1	B22	GND
A17	IO64PDB1V2	AB9	IO208PDB5V1	C1	VCCIB7
A18	IO72NDB1V3	AB10	IO197NDB5V0	C2	IO303PDB7V3
A19	IO74NDB1V4	AB11	IO197PDB5V0	C3	IO305PDB7V3
A20	VCCIB1	AB12	IO174NDB4V2	C4	IO06NPB0V0
A21	GND	AB13	IO174PDB4V2	C5	GND
A22	GND	AB14	IO172NDB4V2	C6	IO12NDB0V1
AA1	GND	AB15	IO172PDB4V2	C7	IO12PDB0V1
AA2	VCCIB6	AB16	IO168NDB4V1	C8	VCC
AA3	IO228PDB5V4	AB17	IO168PDB4V1	C9	VCC
AA4	IO224PDB5V3	AB18	IO162NDB4V1	C10	IO34NDB0V4
AA5	IO218NDB5V3	AB19	IO162PDB4V1	C11	IO40NDB0V4
AA6	IO218PDB5V3	AB20	VCCIB4	C12	IO48NDB1V0
AA7	IO212NDB5V2	AB21	GND	C13	IO48PDB1V0
AA8	IO212PDB5V2	AB22	GND	C14	VCC
AA9	IO198PDB5V0	B1	GND	C15	VCC
AA10	IO198NDB5V0	B2	VCCIB7	C16	IO70NDB1V3
AA11	IO188PPB4V4	B3	IO06PPB0V0	C17	IO70PDB1V3
AA12	IO180NDB4V3	B4	IO08NDB0V0	C18	GND
AA13	IO180PDB4V3	B5	IO08PDB0V0	C19	IO76PPB1V4
AA14	IO170NDB4V2	B6	IO14NDB0V1	C20	IO88NDB2V0



FG484		FG484		FG484	
Pin Number A3PE3000 Function		Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
C21	IO94PPB2V1	E13	IO58NDB1V2	G5	IO297PDB7V2
C22	VCCIB2	E14	IO58PDB1V2	G6	GAC2/IO307PDB7V4
D1	IO293PDB7V2	E15	GBC1/IO79PDB1V4	G7	VCOMPLA
D2	IO303NDB7V3	E16	GBB0/IO80NDB1V4	G8	GNDQ
D3	IO305NDB7V3	E17	GNDQ	G9	IO26NDB0V3
D4	GND	E18	GBA2/IO82PDB2V0	G10	IO26PDB0V3
D5	GAA0/IO00NDB0V0	E19	IO86NDB2V0	G11	IO36PDB0V4
D6	GAA1/IO00PDB0V0	E20	GND	G12	IO42PDB1V0
D7	GAB0/IO01NDB0V0	E21	IO90NDB2V1	G13	IO50PDB1V1
D8	IO20PDB0V2	E22	IO98PDB2V2	G14	IO60NDB1V2
D9	IO22PDB0V2	F1	IO299NPB7V3	G15	GNDQ
D10	IO30PDB0V3	F2	IO301NDB7V3	G16	VCOMPLB
D11	IO38NDB0V4	F3	IO301PDB7V3	G17	GBB2/IO83PDB2V0
D12	IO52NDB1V1	F4	IO308NDB7V4	G18	IO92PDB2V1
D13	IO52PDB1V1	F5	IO309NDB7V4	G19	IO92NDB2V1
D14	IO66NDB1V3	F6	VMV7	G20	IO102PDB2V2
D15	IO66PDB1V3	F7	VCCPLA	G21	IO102NDB2V2
D16	GBB1/IO80PDB1V4	F8	GAC0/IO02NDB0V0	G22	IO105NDB2V2
D17	GBA0/IO81NDB1V4	F9	GAC1/IO02PDB0V0	H1	IO286PSB7V1
D18	GBA1/IO81PDB1V4	F10	IO32NDB0V3	H2	IO291NPB7V2
D19	GND	F11	IO32PDB0V3	H3	VCC
D20	IO88PDB2V0	F12	IO44PDB1V0	H4	IO295NDB7V2
D21	IO90PDB2V1	F13	IO50NDB1V1	H5	IO297NDB7V2
D22	IO94NPB2V1	F14	IO60PDB1V2	H6	IO307NDB7V4
E1	IO293NDB7V2	F15	GBC0/IO79NDB1V4	H7	IO287PDB7V1
E2	IO299PPB7V3	F16	VCCPLB	H8	VMV0
E3	GND	F17	VMV2	H9	VCCIB0
E4	GAB2/IO308PDB7V4	F18	IO82NDB2V0	H10	VCCIB0
E5	GAA2/IO309PDB7V4	F19	IO86PDB2V0	H11	IO36NDB0V4
E6	GNDQ	F20	IO96PDB2V1	H12	IO42NDB1V0
E7	GAB1/IO01PDB0V0	F21	IO96NDB2V1	H13	VCCIB1
E8	IO20NDB0V2	F22	IO98NDB2V2	H14	VCCIB1
E9	IO22NDB0V2	G1	IO289NDB7V1	H15	VMV1
E10	IO30NDB0V3	G2	IO289PDB7V1	H16	GBC2/IO84PDB2V0
E11	IO38PDB0V4	G3	IO291PPB7V2	H17	IO83NDB2V0
E12	IO44NDB1V0	G4	IO295PDB7V2	H18	IO100NDB2V2



FG484			FG484		FG484
Pin Number A3PE3000 Function		Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
H19	IO100PDB2V2	K11	GND	M3	IO272NDB6V4
H20	VCC	K12	GND	M4	GFA2/IO272PDB6V4
H21	VMV2	K13	GND	M5	GFA1/IO273PDB6V4
H22	IO105PDB2V2	K14	VCC	M6	VCCPLF
J1	IO285NDB7V1	K15	VCCIB2	M7	IO271NDB6V4
J2	IO285PDB7V1	K16	GCC1/IO112PPB2V3	M8	GFB2/IO271PDB6V4
J3	VMV7	K17	IO108NDB2V3	M9	VCC
J4	IO279PDB7V0	K18	IO108PDB2V3	M10	GND
J5	IO283PDB7V1	K19	IO110NPB2V3	M11	GND
J6	IO281PDB7V0	K20	IO106NPB2V3	M12	GND
J7	IO287NDB7V1	K21	IO109NDB2V3	M13	GND
J8	VCCIB7	K22	IO107NDB2V3	M14	VCC
J9	GND	L1	IO257PSB6V2	M15	GCB2/IO116PPB3V0
J10	VCC	L2	IO276PDB7V0	M16	GCA1/IO114PPB3V0
J11	VCC	L3	IO276NDB7V0	M17	GCC2/IO117PPB3V0
J12	VCC	L4	GFB0/IO274NPB7V0	M18	VCCPLC
J13	VCC	L5	GFA0/IO273NDB6V4	M19	GCA2/IO115PDB3V0
J14	GND	L6	GFB1/IO274PPB7V0	M20	IO115NDB3V0
J15	VCCIB2	L7	VCOMPLF	M21	IO126PDB3V1
J16	IO84NDB2V0	L8	GFC0/IO275NPB7V0	M22	IO124PSB3V1
J17	IO104NDB2V2	L9	VCC	N1	IO255PPB6V2
J18	IO104PDB2V2	L10	GND	N2	IO253NDB6V2
J19	IO106PPB2V3	L11	GND	N3	VMV6
J20	GNDQ	L12	GND	N4	GFC2/IO270PPB6V4
J21	IO109PDB2V3	L13	GND	N5	IO261PPB6V3
J22	IO107PDB2V3	L14	VCC	N6	IO263PDB6V3
K1	IO277NDB7V0	L15	GCC0/IO112NPB2V3	N7	IO263NDB6V3
K2	IO277PDB7V0	L16	GCB1/IO113PPB2V3	N8	VCCIB6
K3	GNDQ	L17	GCA0/IO114NPB3V0	N9	VCC
K4	IO279NDB7V0	L18	VCOMPLC	N10	GND
K5	IO283NDB7V1	L19	GCB0/IO113NPB2V3	N11	GND
K6	IO281NDB7V0	L20	IO110PPB2V3	N12	GND
K7	GFC1/IO275PPB7V0	L21	IO111NDB2V3	N13	GND
K8	VCCIB7	L22	IO111PDB2V3	N14	VCC
K9	VCC	M1	GNDQ	N15	VCCIB3
K10	GND	M2	IO255NPB6V2	N16	IO116NPB3V0



FG484			FG484		FG484
Pin Number A3PE3000 Function		Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
N17	IO132NPB3V2	R9	VCCIB5	U1	IO240PPB6V0
N18	IO117NPB3V0	R10	VCCIB5	U2	IO238PDB6V0
N19	IO132PPB3V2	R11	IO196NDB5V0	U3	IO238NDB6V0
N20	GNDQ	R12	IO196PDB5V0	U4	GEB1/IO235PDB6V0
N21	IO126NDB3V1	R13	VCCIB4	U5	GEB0/IO235NDB6V0
N22	IO128PDB3V1	R14	VCCIB4	U6	VMV6
P1	IO247PDB6V1	R15	VMV3	U7	VCCPLE
P2	IO253PDB6V2	R16	VCCPLD	U8	IO233NPB5V4
P3	IO270NPB6V4	R17	GDB1/IO152PPB3V4	U9	IO222PPB5V3
P4	IO261NPB6V3	R18	GDC1/IO151PDB3V4	U10	IO206PDB5V1
P5	IO249PPB6V1	R19	IO138NDB3V3	U11	IO202PDB5V1
P6	IO259PDB6V3	R20	VCC	U12	IO194PDB5V0
P7	IO259NDB6V3	R21	IO130NDB3V2	U13	IO176NDB4V2
P8	VCCIB6	R22	IO134PDB3V2	U14	IO176PDB4V2
P9	GND	T1	IO243PPB6V1	U15	VMV4
P10	VCC	T2	IO245NDB6V1	U16	TCK
P11	VCC	Т3	IO243NPB6V1	U17	VPUMP
P12	VCC	T4	IO241PDB6V0	U18	TRST
P13	VCC	T5	IO241NDB6V0	U19	GDA0/IO153NDB3V4
P14	GND	Т6	GEC1/IO236PPB6V0	U20	IO144NDB3V3
P15	VCCIB3	T7	VCOMPLE	U21	IO140NDB3V3
P16	GDB0/IO152NPB3V4	Т8	GNDQ	U22	IO142PDB3V3
P17	IO136NDB3V2	Т9	GEA2/IO233PPB5V4	V1	IO239PDB6V0
P18	IO136PDB3V2	T10	IO206NDB5V1	V2	IO240NPB6V0
P19	IO138PDB3V3	T11	IO202NDB5V1	V3	GND
P20	VMV3	T12	IO194NDB5V0	V4	GEA1/IO234PDB6V0
P21	IO130PDB3V2	T13	IO186NDB4V4	V5	GEA0/IO234NDB6V0
P22	IO128NDB3V1	T14	IO186PDB4V4	V6	GNDQ
R1	IO247NDB6V1	T15	GNDQ	V7	GEC2/IO231PDB5V4
R2	IO245PDB6V1	T16	VCOMPLD	V8	IO222NPB5V3
R3	VCC	T17	VJTAG	V9	IO204NDB5V1
R4	IO249NPB6V1	T18	GDC0/IO151NDB3V4	V10	IO204PDB5V1
R5	IO251NDB6V2	T19	GDA1/IO153PDB3V4	V11	IO195NDB5V0
R6	IO251PDB6V2	T20	IO144PDB3V3	V12	IO195PDB5V0
R7	GEC0/IO236NPB6V0	T21	IO140PDB3V3	V13	IO178NDB4V3
R8	VMV5	T22	IO134NDB3V2	V14	IO178PDB4V3

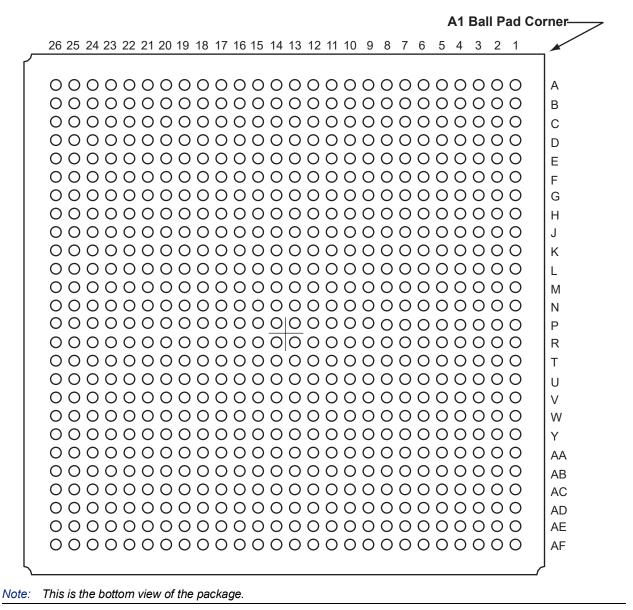
FG484				
Pin Number	A3PE3000 Function	I		
V15	IO155NDB4V0			
V16	GDB2/IO155PDB4V0			
V17	TDI			
V18	GNDQ			
V19	TDO			
V20	GND			
V21	IO146PDB3V4			
V22	IO142NDB3V3			
W1	IO239NDB6V0			
W2	IO237PDB6V0			
W3	IO230PSB5V4			
W4	GND			
W5	IO232NDB5V4			
W6	GEB2/IO232PDB5V4			
W7	IO231NDB5V4			
W8	IO214NDB5V2			
W9	IO214PDB5V2			
W10	IO200NDB5V0			
W11	IO192NDB4V4			
W12	IO184NDB4V3			
W13	IO184PDB4V3			
W14	IO156NDB4V0			
W15	GDC2/IO156PDB4V0			
W16	IO154NDB4V0			
W17	GDA2/IO154PDB4V0			
W18	TMS			
W19	GND			
W20	IO150NDB3V4			
W21	IO146NDB3V4			
W22	IO148PPB3V4			
Y1	VCCIB6			
Y2	IO237NDB6V0			
Y3	IO228NDB5V4			
Y4	IO224NDB5V3			
Y5	GND			
Y6	IO220NDB5V3			

	FG484				
Pin Number	A3PE3000 Function				
Y7	IO220PDB5V3				
Y8	VCC				
Y9	VCC				
Y10	IO200PDB5V0				
Y11	IO192PDB4V4				
Y12	IO188NPB4V4				
Y13	IO187PSB4V4				
Y14	VCC				
Y15	VCC				
Y16	IO164NDB4V1				
Y17	IO164PDB4V1				
Y18	GND				
Y19	IO158PPB4V0				
Y20	IO150PDB3V4				
Y21	IO148NPB3V4				
Y22	VCCIB3				

С Місто сотралу а Міскоснір сотралу



# FG676



## Note

For Package Manufacturing and Environmental information, visit the Resource Center at *http://www.microsemi.com/products/fpga-soc/solutions*.

FG676				
Pin Number	A3PE1500 Function	Pin Num		
A1	GND	AA11		
A2	GND	AA12		
A3	GAA0/IO00NDB0V0	AA13		
A4	GAA1/IO00PDB0V0	AA14		
A5	IO06NDB0V0	AA15		
A6	IO09NDB0V1	AA16		
A7	IO09PDB0V1	AA17		
A8	IO14NDB0V1	AA18		
A9	IO14PDB0V1	AA19		
A10	IO22NDB0V2	AA20		
A11	IO22PDB0V2	AA21		
A12	IO26NDB0V3	AA22		
A13	IO26PDB0V3	AA23		
A14	IO30NDB0V3	AA24		
A15	IO30PDB0V3	AA25		
A16	IO34NDB1V0	AA26		
A17	IO34PDB1V0	AB1		
A18	IO38NDB1V0	AB2		
A19	IO38PDB1V0	AB3		
A20	IO41PDB1V1	AB4		
A21	IO44PDB1V1	AB5		
A22	IO49PDB1V2	AB6		
A23	IO50PDB1V2	AB7		
A24	GBC1/IO55PDB1V3	AB8		
A25	GND	AB9		
A26	GND	AB10		
AA1	IO174PDB6V0	AB11		
AA2	IO171PDB6V0	AB12		
AA3	GEA1/IO167PPB6V0	AB13		
AA4	GEC0/IO169NPB6V0	AB14		
AA5	VCOMPLE	AB15		
AA6	GND	AB16		
AA7	IO165NDB5V3	AB17		
AA8	GEB2/IO165PDB5V3	AB18		
AA9	IO163PDB5V3	AB19		
AA10	IO159NDB5V3	AB20		

	FG676
Pin Number	A3PE1500 Function
AA11	IO153NDB5V2
AA12	IO147NDB5V1
AA13	IO139NDB5V0
AA14	IO137NDB5V0
AA15	IO123NDB4V1
AA16	IO123PDB4V1
AA17	IO117NDB4V0
AA18	IO117PDB4V0
AA19	GDB2/IO112PDB4V0
AA20	GNDQ
AA21	TDO
AA22	GND
AA23	GND
AA24	IO102NDB3V1
AA25	IO102PDB3V1
AA26	IO98NDB3V1
AB1	IO174NDB6V0
AB2	IO171NDB6V0
AB3	GEB1/IO168PPB6V0
AB4	GEA0/IO167NPB6V0
AB5	VCCPLE
AB6	GND
AB7	GND
AB8	IO156NDB5V2
AB9	IO156PDB5V2
AB10	IO150PDB5V1
AB11	IO155PDB5V2
AB12	IO142PDB5V0
AB13	IO135NDB5V0
AB14	IO135PDB5V0
AB15	IO132PDB4V2
AB16	IO129PDB4V2
AB17	IO121PDB4V1
AB18	IO119NDB4V1
AB19	IO112NDB4V0
AB20	VMV4

FG676				
Pin Number A3PE1500 Function				
AB21	ТСК			
AB22	TRST			
AB23	GDC0/IO108NDB3V2			
AB24	GDC1/IO108PDB3V2			
AB25	IO104NDB3V2			
AB26	IO104PDB3V2			
AC1	IO170PDB6V0			
AC2	GEB0/IO168NPB6V0			
AC3	IO166NPB5V3			
AC4	GNDQ			
AC5	GND			
AC6	IO160PDB5V3			
AC7	IO161PDB5V3			
AC8	IO154PDB5V2			
AC9	GND			
AC10	IO150NDB5V1			
AC11	IO155NDB5V2			
AC12	IO142NDB5V0			
AC13	IO138NDB5V0			
AC14	IO138PDB5V0			
AC15	IO132NDB4V2			
AC16	IO129NDB4V2			
AC17	IO121NDB4V1			
AC18	IO119PDB4V1			
AC19	IO118NDB4V0			
AC20	IO118PDB4V0			
AC21	IO114PPB4V0			
AC22	TMS			
AC23	VJTAG			
AC24	VMV3			
AC25	IO106NDB3V2			
AC26	IO106PDB3V2			
AD1	IO170NDB6V0			
AD2	GEA2/IO166PPB5V3			
AD3	VMV5			
AD4	GEC2/IO164PDB5V3			



FG676		FG676		FG676	
Pin Number A3PE1500 Function		Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function
AD5	IO162PDB5V3	AE15	IO134NDB4V2	AF25	GND
AD6	IO160NDB5V3	AE16	IO133NDB4V2	AF26	GND
AD7	IO161NDB5V3	AE17	IO127NDB4V2	B1	GND
AD8	IO154NDB5V2	AE18	IO130NDB4V2	B2	GND
AD9	IO148PDB5V1	AE19	IO126NDB4V1	B3	GND
AD10	IO151PDB5V2	AE20	IO124NDB4V1	B4	GND
AD11	IO144PDB5V1	AE21	IO120NDB4V1	B5	IO06PDB0V0
AD12	IO140PDB5V0	AE22	IO116PDB4V0	B6	IO04NDB0V0
AD13	IO143PDB5V1	AE23	GDC2/IO113PDB4V0	B7	IO07NDB0V0
AD14	IO141PDB5V0	AE24	GDA2/IO111PDB4V0	B8	IO11NDB0V1
AD15	IO134PDB4V2	AE25	GND	B9	IO10NDB0V1
AD16	IO133PDB4V2	AE26	GND	B10	IO16NDB0V2
AD17	IO127PDB4V2	AF1	GND	B11	IO20NDB0V2
AD18	IO130PDB4V2	AF2	GND	B12	IO24NDB0V3
AD19	IO126PDB4V1	AF3	GND	B13	IO23NDB0V2
AD20	IO124PDB4V1	AF4	GND	B14	IO28NDB0V3
AD21	IO120PDB4V1	AF5	IO158NPB5V2	B15	IO31NDB0V3
AD22	IO114NPB4V0	AF6	IO157NPB5V2	B16	IO32PDB1V0
AD23	TDI	AF7	IO152NPB5V2	B17	IO36PDB1V0
AD24	GNDQ	AF8	IO146NDB5V1	B18	IO37PDB1V0
AD25	GDA0/IO110NDB3V2	AF9	IO146PDB5V1	B19	IO42NPB1V1
AD26	GDA1/IO110PDB3V2	AF10	IO149NDB5V1	B20	IO41NDB1V1
AE1	GND	AF11	IO149PDB5V1	B21	IO44NDB1V1
AE2	GND	AF12	IO145NDB5V1	B22	IO49NDB1V2
AE3	GND	AF13	IO145PDB5V1	B23	IO50NDB1V2
AE4	IO164NDB5V3	AF14	IO136NDB5V0	B24	GBC0/IO55NDB1V3
AE5	IO162NDB5V3	AF15	IO136PDB5V0	B25	GND
AE6	IO158PPB5V2	AF16	IO131NDB4V2	B26	GND
AE7	IO157PPB5V2	AF17	IO131PDB4V2	C1	GND
AE8	IO152PPB5V2	AF18	IO128NDB4V2	C2	GND
AE9	IO148NDB5V1	AF19	IO128PDB4V2	C3	GND
AE10	IO151NDB5V2	AF20	IO122NDB4V1	C4	GND
AE11	IO144NDB5V1	AF21	IO122PDB4V1	C5	GAA2/IO221PDB7V3
AE12	IO140NDB5V0	AF22	IO116NDB4V0	C6	IO04PDB0V0
AE13	IO143NDB5V1	AF23	IO113NDB4V0	C7	IO07PDB0V0
AE14	IO141NDB5V0	AF24	IO111NDB4V0	C8	IO11PDB0V1

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Pin Number		Pin Number	A3PE1500 Function
C9	IO10PDB0V1	D19	IO45PDB1V1
C10	IO16PDB0V2	D20	IO46PPB1V1
C11	IO20PDB0V2	D21	IO48PPB1V2
C12	IO24PDB0V3	D22	GBA0/IO57NPB1V3
C13	IO23PDB0V2	D23	GNDQ
C14	IO28PDB0V3	D24	GBB1/IO56PPB1V3
C15	IO31PDB0V3	D25	GBB2/IO59PDB2V0
C16	IO32NDB1V0	D26	IO59NDB2V0
C17	IO36NDB1V0	E1	IO212PDB7V2
C18	IO37NDB1V0	E2	IO211NDB7V2
C19	IO45NDB1V1	E3	IO211PDB7V2
C20	IO42PPB1V1	E4	IO220NPB7V3
C21	IO46NPB1V1	E5	GNDQ
C22	IO48NPB1V2	E6	GAB2/IO220PPB7V3
C23	GBB0/IO56NPB1V3	E7	GAB1/IO01PDB0V0
C24	VMV1	E8	IO05PDB0V0
C25	GBC2/IO60PDB2V0	E9	IO08NDB0V1
C26	IO60NDB2V0	E10	IO12PDB0V1
D1	IO218NDB7V3	E11	IO18PDB0V2
D2	IO218PDB7V3	E12	IO17PDB0V2
D3	GND	E13	IO25PDB0V3
D4	VMV7	E14	IO29PDB0V3
D5	IO221NDB7V3	E15	IO33PDB1V0
D6	GAC0/IO02NDB0V0	E16	IO40NDB1V1
D7	GAC1/IO02PDB0V0	E17	IO43PDB1V1
D8	IO05NDB0V0	E18	IO47NDB1V1
D9	IO08PDB0V1	E19	IO54NDB1V3
D10	IO12NDB0V1	E20	IO52NDB1V2
D11	IO18NDB0V2	E21	IO52PDB1V2
D12	IO17NDB0V2	E22	VCCPLB
D13	IO25NDB0V3	E23	GBA1/IO57PPB1V3
D14	IO29NDB0V3	E24	IO63PDB2V0
D15	IO33NDB1V0	E25	IO63NDB2V0
D16	IO40PDB1V1	E26	IO68PDB2V1
D17	IO43NDB1V1	F1	IO212NDB7V2
D18	IO47PDB1V1	F2	IO203PPB7V1
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	FG676
Pin Number	A3PE1500 Function
F3	IO213NDB7V2
F4	IO213PDB7V2
F5	GND
F6	VCCPLA
F7	GAB0/IO01NDB0V0
F8	GNDQ
F9	IO03PDB0V0
F10	IO13PDB0V1
F11	IO15PDB0V1
F12	IO19PDB0V2
F13	IO21PDB0V2
F14	IO27NDB0V3
F15	IO35PDB1V0
F16	IO39NDB1V0
F17	IO51PDB1V2
F18	IO53PDB1V2
F19	IO54PDB1V3
F20	VMV2
F21	VCOMPLB
F22	IO61PDB2V0
F23	IO61NDB2V0
F24	IO66PDB2V1
F25	IO66NDB2V1
F26	IO68NDB2V1
G1	IO203NPB7V1
G2	IO207NDB7V2
G3	IO207PDB7V2
G4	IO216NDB7V3
G5	IO216PDB7V3
G6	VCOMPLA
G7	VMV0
G8	VCC
G9	IO03NDB0V0
G10	IO13NDB0V1
G11	IO15NDB0V1
G12	IO19NDB0V2



FG676			FG676		FG676	
Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function	
G13	IO21NDB0V2	H23	IO69PDB2V1	K7	IO217NDB7V3	
G14	IO27PDB0V3	H24	IO76PDB2V2	K8	VCCIB7	
G15	IO35NDB1V0	H25	IO76NDB2V2	K9	VCC	
G16	IO39PDB1V0	H26	IO78NDB2V2	K10	GND	
G17	IO51NDB1V2	J1	IO197NDB7V0	K11	GND	
G18	IO53NDB1V2	J2	IO197PDB7V0	K12	GND	
G19	VCCIB1	J3	VMV7	K13	GND	
G20	GBA2/IO58PPB2V0	J4	IO215NDB7V3	K14	GND	
G21	GNDQ	J5	IO215PDB7V3	K15	GND	
G22	IO64NDB2V1	J6	IO214PDB7V3	K16	GND	
G23	IO64PDB2V1	J7	IO214NDB7V3	K17	GND	
G24	IO72PDB2V2	J8	VCCIB7	K18	VCC	
G25	IO72NDB2V2	J9	VCC	K19	VCCIB2	
G26	IO78PDB2V2	J10	VCC	K20	IO65PDB2V1	
H1	IO208NDB7V2	J11	VCC	K21	IO65NDB2V1	
H2	IO208PDB7V2	J12	VCC	K22	IO74PDB2V2	
H3	IO209NDB7V2	J13	VCC	K23	IO74NDB2V2	
H4	IO209PDB7V2	J14	VCC	K24	IO75PDB2V2	
H5	IO219NDB7V3	J15	VCC	K25	IO75NDB2V2	
H6	GAC2/IO219PDB7V3	J16	VCC	K26	IO84PDB2V3	
H7	VCCIB7	J17	VCC	L1	IO195NDB7V0	
H8	VCC	J18	VCC	L2	IO198PPB7V0	
H9	VCCIB0	J19	VCCIB2	L3	GNDQ	
H10	VCCIB0	J20	IO62PDB2V0	L4	IO201PDB7V1	
H11	VCCIB0	J21	IO62NDB2V0	L5	IO201NDB7V1	
H12	VCCIB0	J22	IO70NDB2V1	L6	IO210NDB7V2	
H13	VCCIB0	J23	IO69NDB2V1	L7	IO210PDB7V2	
H14	VCCIB1	J24	VMV2	L8	VCCIB7	
H15	VCCIB1	J25	IO80PDB2V3	L9	VCC	
H16	VCCIB1	J26	IO80NDB2V3	L10	GND	
H17	VCCIB1	K1	IO195PDB7V0	L11	GND	
H18	VCCIB1	K2	IO199NDB7V1	L12	GND	
H19	VCC	K3	IO199PDB7V1	L13	GND	
H20	VCC	K4	IO205NDB7V1	L14	GND	
H21	IO58NPB2V0	K5	IO205PDB7V1	L15	GND	
H22	IO70PDB2V1	K6	IO217PDB7V3	L16	GND	

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	FG676						
Pin Number	A3PE1500 Function	Pin Numb					
L17	GND	N1					
L18	VCC	N2					
L19	VCCIB2	N3					
L20	IO67PDB2V1	N4					
L21	IO67NDB2V1	N5					
L22	IO71PDB2V2	N6					
L23	IO71NDB2V2	N7					
L24	GNDQ	N8					
L25	IO82PDB2V3	N9					
L26	IO84NDB2V3	N10					
M1	IO198NPB7V0	N11					
M2	IO202PDB7V1	N12					
M3	IO202NDB7V1	N13					
M4	IO206NDB7V1	N14					
M5	IO206PDB7V1	N15					
M6	IO204NDB7V1	N16					
M7	IO204PDB7V1	N17					
M8	VCCIB7	N18					
M9	VCC	N19					
M10	GND	N20					
M11	GND	N21					
M12	GND	N22					
M13	GND	N23					
M14	GND	N24					
M15	GND	N25					
M16	GND	N26					
M17	GND	P1					
M18	VCC	P2					
M19	VCCIB2	P3					
M20	IO73NDB2V2	P4					
M21	IO73PDB2V2	P5					
M22	IO81PPB2V3	P6					
M23	IO77PDB2V2	P7					
M24	IO77NDB2V2	P8					
M25	IO82NDB2V3	P9					
M26	IO83PDB2V3	P10					

	FG676	
n Number	A3PE1500 Function	Pi
N1	GFB0/IO191NPB7V0	
N2	VCOMPLF	
N3	GFB1/IO191PPB7V0	
N4	IO196PDB7V0	
N5	GFA0/IO190NDB6V2	
N6	IO200PDB7V1	
N7	IO200NDB7V1	
N8	VCCIB7	
N9	VCC	
N10	GND	
N11	GND	
N12	GND	
N13	GND	
N14	GND	
N15	GND	
N16	GND	
N17	GND	
N18	VCC	
N19	VCCIB2	
N20	IO79PDB2V3	
N21	IO79NDB2V3	
N22	GCA2/IO88PPB3V0	
N23	IO81NPB2V3	
N24	GCA0/IO87NDB3V0	
N25	GCB0/IO86NPB2V3	
N26	IO83NDB2V3	
P1	GFA2/IO189PDB6V2	
P2	VCCPLF	
P3	IO193PPB7V0	
P4	IO196NDB7V0	
P5	GFA1/IO190PDB6V2	
P6	IO194PDB7V0	
P7	IO194NDB7V0	
P8	VCCIB6	
P9	VCC	
P10	GND	

FG676					
Pin Number	A3PE1500 Function				
P11	GND				
P12	GND				
P13	GND				
P14	GND				
P15	GND				
P16	GND				
P17	GND				
P18	VCC				
P19	VCCIB3				
P20	GCC0/IO85NDB2V3				
P21	GCC1/IO85PDB2V3				
P22	GCB1/IO86PPB2V3				
P23	IO88NPB3V0				
P24	GCA1/IO87PDB3V0				
P25	VCCPLC				
P26	VCOMPLC				
R1	IO189NDB6V2				
R2	IO185PDB6V2				
R3	IO187NPB6V2				
R4	IO193NPB7V0				
R5	GFC2/IO187PPB6V2				
R6	GFC1/IO192PDB7V0				
R7	GFC0/IO192NDB7V0				
R8	VCCIB6				
R9	VCC				
R10	GND				
R11	GND				
R12	GND				
R13	GND				
R14	GND				
R15	GND				
R16	GND				
R17	GND				
R18	VCC				
R19	VCCIB3				
R20	NC				



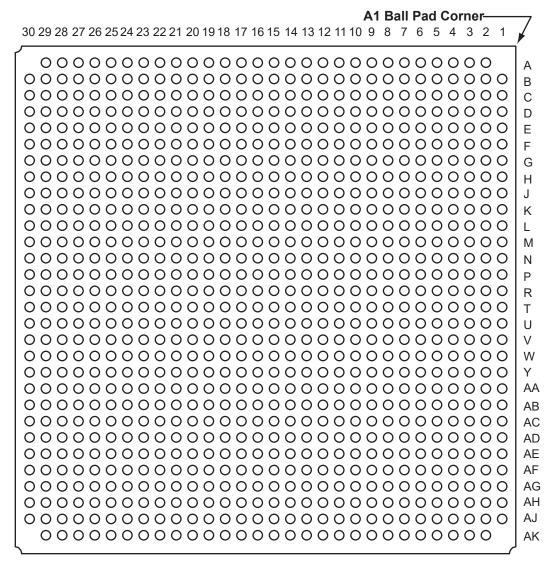
FG676		FG676		FG676	
Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function	Pin Number	A3PE1500 Function
R21	IO89NDB3V0	U5	IO182PDB6V1	V15	VCC
R22	GCB2/IO89PDB3V0	U6	IO178PDB6V1	V16	VCC
R23	IO90NDB3V0	U7	IO178NDB6V1	V17	VCC
R24	GCC2/IO90PDB3V0	U8	VCCIB6	V18	VCC
R25	IO91PDB3V0	U9	VCC	V19	VCCIB3
R26	IO91NDB3V0	U10	GND	V20	IO107PDB3V2
T1	IO186PDB6V2	U11	GND	V21	IO107NDB3V2
T2	IO185NDB6V2	U12	GND	V22	IO103NDB3V2
Т3	GNDQ	U13	GND	V23	IO103PDB3V2
T4	IO180PDB6V1	U14	GND	V24	VMV3
T5	IO180NDB6V1	U15	GND	V25	IO95NDB3V1
Т6	IO188NDB6V2	U16	GND	V26	IO94PDB3V0
T7	GFB2/IO188PDB6V2	U17	GND	W1	IO179NDB6V1
Т8	VCCIB6	U18	VCC	W2	IO179PDB6V1
Т9	VCC	U19	VCCIB3	W3	IO177NDB6V1
T10	GND	U20	NC	W4	IO177PDB6V1
T11	GND	U21	IO101NDB3V1	W5	IO172PDB6V0
T12	GND	U22	IO101PDB3V1	W6	IO172NDB6V0
T13	GND	U23	IO92NDB3V0	W7	VCC
T14	GND	U24	IO92PDB3V0	W8	VCC
T15	GND	U25	IO95PDB3V1	W9	VCCIB5
T16	GND	U26	IO93NPB3V0	W10	VCCIB5
T17	GND	V1	IO183PDB6V2	W11	VCCIB5
T18	VCC	V2	IO183NDB6V2	W12	VCCIB5
T19	VCCIB3	V3	VMV6	W13	VCCIB5
T20	IO99PDB3V1	V4	IO181PDB6V1	W14	VCCIB4
T21	IO99NDB3V1	V5	IO181NDB6V1	W15	VCCIB4
T22	IO97PDB3V1	V6	IO176PDB6V1	W16	VCCIB4
T23	IO97NDB3V1	V7	IO176NDB6V1	W17	VCCIB4
T24	GNDQ	V8	VCCIB6	W18	VCCIB4
T25	IO93PPB3V0	V9	VCC	W19	VCC
T26	NC	V10	VCC	W20	VCCIB3
U1	IO186NDB6V2	V11	VCC	W21	GDB0/IO109NDB3V2
U2	IO184NDB6V2	V12	VCC	W22	GDB1/IO109PDB3V2
U3	IO184PDB6V2	V13	VCC	W23	IO105NDB3V2
U4	IO182NDB6V1	V14	VCC	W24	IO105PDB3V2



Pin Number         A3PE1500 Function           W25         IO96PDB3V1           W26         IO94NDB3V0           Y1         IO175NDB6V1           Y2         IO175PDB6V1           Y2         IO173NDB6V0           Y4         IO173PDB6V0           Y5         GEC1/IO169PPB6V0           Y6         GNDQ           Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V2           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO96NDB3V1           Y25         IO98PDB3V1	FG676					
W26         IO94NDB3V0           Y1         IO175NDB6V1           Y2         IO175PDB6V1           Y3         IO173NDB6V0           Y4         IO173PDB6V0           Y5         GEC1/IO169PPB6V0           Y6         GNDQ           Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y11         IO159PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Pin Number	A3PE1500 Function				
Y1         IO175NDB6V1           Y2         IO175PDB6V1           Y3         IO173NDB6V0           Y4         IO173PDB6V0           Y5         GEC1/IO169PPB6V0           Y6         GNDQ           Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	W25	IO96PDB3V1				
Y2         IO175PDB6V1           Y3         IO173NDB6V0           Y4         IO173PDB6V0           Y5         GEC1/IO169PPB6V0           Y6         GNDQ           Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V3           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO133PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	W26	IO94NDB3V0				
Y3         IO173NDB6V0           Y4         IO173PDB6V0           Y5         GEC1/IO169PPB6V0           Y6         GNDQ           Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V2           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Y1	IO175NDB6V1				
Y4         IO173PDB6V0           Y5         GEC1/IO169PPB6V0           Y6         GNDQ           Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V3           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Y2	IO175PDB6V1				
Y5         GEC1/IO169PPB6V0           Y6         GNDQ           Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V3           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Y3	IO173NDB6V0				
Y6         GNDQ           Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V3           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Y4	IO173PDB6V0				
Y7         VMV6           Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V3           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Y5	GEC1/IO169PPB6V0				
Y8         VCCIB5           Y9         IO163NDB5V3           Y10         IO159PDB5V3           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Y6	GNDQ				
Y9         IO163NDB5V3           Y10         IO159PDB5V3           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Y7	VMV6				
Y10         IO159PDB5V3           Y11         IO153PDB5V2           Y12         IO147PDB5V1           Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y18         IO115NDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1	Y8	VCCIB5				
Y11       IO153PDB5V2         Y12       IO147PDB5V1         Y13       IO139PDB5V0         Y14       IO137PDB5V0         Y15       IO125NDB4V1         Y16       IO125PDB4V1         Y17       IO115NDB4V0         Y18       IO115PDB4V0         Y20       VPUMP         Y21       VCOMPLD         Y22       VCCPLD         Y23       IO100NDB3V1         Y24       IO96NDB3V1	Y9	IO163NDB5V3				
Y12       IO147PDB5V1         Y13       IO139PDB5V0         Y14       IO137PDB5V0         Y15       IO125NDB4V1         Y16       IO125PDB4V1         Y17       IO115NDB4V0         Y18       IO115PDB4V0         Y20       VPUMP         Y21       VCOMPLD         Y23       IO100NDB3V1         Y24       IO96NDB3V1	Y10	IO159PDB5V3				
Y13         IO139PDB5V0           Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO96NDB3V1	Y11	IO153PDB5V2				
Y14         IO137PDB5V0           Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y23         IO100NDB3V1           Y24         IO96NDB3V1	Y12	IO147PDB5V1				
Y15         IO125NDB4V1           Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y23         IO100NDB3V1           Y24         IO96NDB3V1	Y13	IO139PDB5V0				
Y16         IO125PDB4V1           Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO96NDB3V1	Y14	IO137PDB5V0				
Y17         IO115NDB4V0           Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO96NDB3V1	Y15	IO125NDB4V1				
Y18         IO115PDB4V0           Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO96NDB3V1	Y16	IO125PDB4V1				
Y19         VCC           Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1           Y25         IO96NDB3V1	Y17	IO115NDB4V0				
Y20         VPUMP           Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1           Y25         IO96NDB3V1	Y18	IO115PDB4V0				
Y21         VCOMPLD           Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1           Y25         IO96NDB3V1	Y19	VCC				
Y22         VCCPLD           Y23         IO100NDB3V1           Y24         IO100PDB3V1           Y25         IO96NDB3V1	Y20	VPUMP				
Y23         IO100NDB3V1           Y24         IO100PDB3V1           Y25         IO96NDB3V1	Y21	VCOMPLD				
Y24         IO100PDB3V1           Y25         IO96NDB3V1	Y22	VCCPLD				
Y25 IO96NDB3V1	Y23	IO100NDB3V1				
	Y24	IO100PDB3V1				
Y26 IO98PDB3V1	Y25	IO96NDB3V1				
	Y26	IO98PDB3V1				



## FG896



Note: This is the bottom view of the package.

### Note

For Package Manufacturing and Environmental information, visit the Resource Center at *http://www.microsemi.com/products/fpga-soc/solutions*.



FG896		FG896		FG896	
Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
A2	GND	AA9	GEB1/IO235PPB6V0	AB15	IO198PDB5V0
A3	GND	AA10	VCC	AB16	IO192NDB4V4
A4	IO14NPB0V1	AA11	IO226PPB5V4	AB17	IO192PDB4V4
A5	GND	AA12	VCCIB5	AB18	IO178NDB4V3
A6	IO07NPB0V0	AA13	VCCIB5	AB19	IO178PDB4V3
A7	GND	AA14	VCCIB5	AB20	IO174NDB4V2
A8	IO09NDB0V1	AA15	VCCIB5	AB21	IO162NPB4V1
A9	IO17NDB0V2	AA16	VCCIB4	AB22	VCC
A10	IO17PDB0V2	AA17	VCCIB4	AB23	VCCPLD
A11	IO21NDB0V2	AA18	VCCIB4	AB24	VCCIB3
A12	IO21PDB0V2	AA19	VCCIB4	AB25	IO150PDB3V4
A13	IO33NDB0V4	AA20	IO174PDB4V2	AB26	IO148PDB3V4
A14	IO33PDB0V4	AA21	VCC	AB27	IO147NDB3V4
A15	IO35NDB0V4	AA22	IO142NPB3V3	AB28	IO145PDB3V3
A16	IO35PDB0V4	AA23	IO144NDB3V3	AB29	IO143PDB3V3
A17	IO41NDB1V0	AA24	IO144PDB3V3	AB30	IO137PDB3V2
A18	IO43NDB1V0	AA25	IO146NDB3V4	AC1	IO254PDB6V2
A19	IO43PDB1V0	AA26	IO146PDB3V4	AC2	IO254NDB6V2
A20	IO45NDB1V0	AA27	IO147PDB3V4	AC3	IO240PDB6V0
A21	IO45PDB1V0	AA28	IO139NDB3V3	AC4	GEC1/IO236PDB6V0
A22	IO57NDB1V2	AA29	IO139PDB3V3	AC5	IO237PDB6V0
A23	IO57PDB1V2	AA30	IO133NDB3V2	AC6	IO237NDB6V0
A24	GND	AB1	IO256NDB6V2	AC7	VCOMPLE
A25	IO69PPB1V3	AB2	IO244PDB6V1	AC8	GND
A26	GND	AB3	IO244NDB6V1	AC9	IO226NPB5V4
A27	GBC1/IO79PPB1V4	AB4	IO241PDB6V0	AC10	IO222NDB5V3
A28	GND	AB5	IO241NDB6V0	AC11	IO216NPB5V2
A29	GND	AB6	IO243NPB6V1	AC12	IO210NPB5V2
AA1	IO256PDB6V2	AB7	VCCIB6	AC13	IO204NDB5V1
AA2	IO248PDB6V1	AB8	VCCPLE	AC14	IO204PDB5V1
AA3	IO248NDB6V1	AB9	VCC	AC15	IO194NDB5V0
AA4	IO246NDB6V1	AB10	IO222PDB5V3	AC16	IO188NDB4V4
AA5	GEA1/IO234PDB6V0	AB11	IO218PPB5V3	AC17	IO188PDB4V4
AA6	GEA0/IO234NDB6V0	AB12	IO206NDB5V1	AC18	IO182PPB4V3
AA7	IO243PPB6V1	AB13	IO206PDB5V1	AC19	IO170NPB4V2
AA8	IO245NDB6V1	AB14	IO198NDB5V0	AC20	IO164NDB4V1



FG896			FG896		FG896		
Pin Number A3PE3000 Function		Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function		
AC21	IO164PDB4V1	AD27	GDA0/IO153NDB3V4	AF3	VCCIB6		
AC22	IO162PPB4V1	AD28	GDC0/IO151NDB3V4	AF4	IO220NPB5V3		
AC23	GND	AD29	GDC1/IO151PDB3V4	AF5	VCC		
AC24	VCOMPLD	AD30	GND	AF6	IO228NDB5V4		
AC25	IO150NDB3V4	AE1	IO242PPB6V1	AF7	VCCIB5		
AC26	IO148NDB3V4	AE2	VCC	AF8	IO230PDB5V4		
AC27	GDA1/IO153PDB3V4	AE3	IO239PDB6V0	AF9	IO229NDB5V4		
AC28	IO145NDB3V3	AE4	IO239NDB6V0	AF10	IO229PDB5V4		
AC29	IO143NDB3V3	AE5	VMV6	AF11	IO214PPB5V2		
AC30	IO137NDB3V2	AE6	GND	AF12	IO208NDB5V1		
AD1	GND	AE7	GNDQ	AF13	IO208PDB5V1		
AD2	IO242NPB6V1	AE8	IO230NDB5V4	AF14	IO200PDB5V0		
AD3	IO240NDB6V0	AE9	IO224NPB5V3	AF15	IO196NDB5V0		
AD4	GEC0/IO236NDB6V0	AE10	IO214NPB5V2	AF16	IO186NDB4V4		
AD5	VCCIB6	AE11	IO212NDB5V2	AF17	IO186PDB4V4		
AD6	GNDQ	AE12	IO212PDB5V2	AF18	IO180NDB4V3		
AD7	VCC	AE13	IO202NPB5V1	AF19	IO180PDB4V3		
AD8	VMV5	AE14	IO200NDB5V0	AF20	IO168NDB4V1		
AD9	VCCIB5	AE15	IO196PDB5V0	AF21	IO168PDB4V1		
AD10	IO224PPB5V3	AE16	IO190NDB4V4	AF22	IO160NDB4V0		
AD11	IO218NPB5V3	AE17	IO184PDB4V3	AF23	IO158NPB4V0		
AD12	IO216PPB5V2	AE18	IO184NDB4V3	AF24	VCCIB4		
AD13	IO210PPB5V2	AE19	IO172PDB4V2	AF25	IO154NPB4V0		
AD14	IO202PPB5V1	AE20	IO172NDB4V2	AF26	VCC		
AD15	IO194PDB5V0	AE21	IO166NDB4V1	AF27	TDO		
AD16	IO190PDB4V4	AE22	IO160PDB4V0	AF28	VCCIB3		
AD17	IO182NPB4V3	AE23	GNDQ	AF29	GNDQ		
AD18	IO176NDB4V2	AE24	VMV4	AF30	GND		
AD19	IO176PDB4V2	AE25	GND	AG1	IO238NPB6V0		
AD20	IO170PPB4V2	AE26	GDB0/IO152NDB3V4	AG2	VCC		
AD21	IO166PDB4V1	AE27	GDB1/IO152PDB3V4	AG3	IO232NPB5V4		
AD22	VCCIB4	AE28	VMV3	AG4	GND		
AD23	тск	AE29	VCC	AG5	IO220PPB5V3		
AD24	VCC	AE30	IO149PDB3V4	AG6	IO228PDB5V4		
AD25	TRST	AF1	GND	AG7	IO231NDB5V4		
AD26	VCCIB3	AF2	IO238PPB6V0	AG8	GEC2/IO231PDB5V4		



FG896			FG896		FG896		
Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function		
AG9	IO225NPB5V3	AH15	IO195NDB5V0	AJ21	IO173PDB4V2		
AG10	IO223NPB5V3	AH16	IO185NDB4V3	AJ22	IO163NDB4V1		
AG11	IO221PDB5V3	AH17	IO185PDB4V3	AJ23	IO163PDB4V1		
AG12	IO221NDB5V3	AH18	IO181PDB4V3	AJ24	IO167NPB4V1		
AG13	IO205NPB5V1	AH19	IO177NDB4V2	AJ25	VCC		
AG14	IO199NDB5V0	AH20	IO171NPB4V2	AJ26	IO156NPB4V0		
AG15	IO199PDB5V0	AH21	IO165PPB4V1	AJ27	VCC		
AG16	IO187NDB4V4	AH22	IO161PPB4V0	AJ28	TMS		
AG17	IO187PDB4V4	AH23	IO157NDB4V0	AJ29	GND		
AG18	IO181NDB4V3	AH24	IO157PDB4V0	AJ30	GND		
AG19	IO171PPB4V2	AH25	IO155NDB4V0	AK2	GND		
AG20	IO165NPB4V1	AH26	VCCIB4	AK3	GND		
AG21	IO161NPB4V0	AH27	TDI	AK4	IO217PPB5V2		
AG22	IO159NDB4V0	AH28	VCC	AK5	GND		
AG23	IO159PDB4V0	AH29	VPUMP	AK6	IO215PPB5V2		
AG24	IO158PPB4V0	AH30	GND	AK7	GND		
AG25	GDB2/IO155PDB4V0	AJ1	GND	AK8	IO207NDB5V1		
AG26	GDA2/IO154PPB4V0	AJ2	GND	AK9	IO207PDB5V1		
AG27	GND	AJ3	GEA2/IO233PPB5V4	AK10	IO201NDB5V0		
AG28	VJTAG	AJ4	VCC	AK11	IO201PDB5V0		
AG29	VCC	AJ5	IO217NPB5V2	AK12	IO193NDB4V4		
AG30	IO149NDB3V4	AJ6	VCC	AK13	IO193PDB4V4		
AH1	GND	AJ7	IO215NPB5V2	AK14	IO197PDB5V0		
AH2	IO233NPB5V4	AJ8	IO213NDB5V2	AK15	IO191NDB4V4		
AH3	VCC	AJ9	IO213PDB5V2	AK16	IO191PDB4V4		
AH4	GEB2/IO232PPB5V4	AJ10	IO209NDB5V1	AK17	IO189NDB4V4		
AH5	VCCIB5	AJ11	IO209PDB5V1	AK18	IO189PDB4V4		
AH6	IO219NDB5V3	AJ12	IO203NDB5V1	AK19	IO179PPB4V3		
AH7	IO219PDB5V3	AJ13	IO203PDB5V1	AK20	IO175NDB4V2		
AH8	IO227NDB5V4	AJ14	IO197NDB5V0	AK21	IO175PDB4V2		
AH9	IO227PDB5V4	AJ15	IO195PDB5V0	AK22	IO169NDB4V1		
AH10	IO225PPB5V3	AJ16	IO183NDB4V3	AK23	IO169PDB4V1		
AH11	IO223PPB5V3	AJ17	IO183PDB4V3	AK24	GND		
AH12	IO211NDB5V2	AJ18	IO179NPB4V3	AK25	IO167PPB4V1		
AH13	IO211PDB5V2	AJ19	IO177PDB4V2	AK26	GND		
AH14	IO205PPB5V1	AJ20	IO173NDB4V2	AK27	GDC2/IO156PPB4V0		



FG896		FG896		FG896		
Pin Number A3PE3000 Function		Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function	
AK28	GND	C5	VCCIB0	D11	IO11PDB0V1	
AK29	GND	C6	IO03PDB0V0	D12	IO23NDB0V2	
B1	GND	C7	IO03NDB0V0	D13	IO23PDB0V2	
B2	GND	C8	GAB1/IO01PDB0V0	D14	IO27PDB0V3	
B3	GAA2/IO309PPB7V4	C9	IO05PDB0V0	D15	IO40PDB0V4	
B4	VCC	C10	IO15NPB0V1	D16	IO47NDB1V0	
B5	IO14PPB0V1	C11	IO25NDB0V3	D17	IO47PDB1V0	
B6	VCC	C12	IO25PDB0V3	D18	IO55NPB1V1	
B7	IO07PPB0V0	C13	IO31NPB0V3	D19	IO65NDB1V3	
B8	IO09PDB0V1	C14	IO27NDB0V3	D20	IO65PDB1V3	
B9	IO15PPB0V1	C15	IO39NDB0V4	D21	IO71NDB1V3	
B10	IO19NDB0V2	C16	IO39PDB0V4	D22	IO71PDB1V3	
B11	IO19PDB0V2	C17	IO55PPB1V1	D23	IO73NDB1V4	
B12	IO29NDB0V3	C18	IO51PDB1V1	D24	IO73PDB1V4	
B13	IO29PDB0V3	C19	IO59NDB1V2	D25	IO74NDB1V4	
B14	IO31PPB0V3	C20	IO63NDB1V2	D26	GBB0/IO80NPB1V4	
B15	IO37NDB0V4	C21	IO63PDB1V2	D27	GND	
B16	IO37PDB0V4	C22	IO67NDB1V3	D28	GBA0/IO81NPB1V4	
B17	IO41PDB1V0	C23	IO67PDB1V3	D29	VCC	
B18	IO51NDB1V1	C24	IO75NDB1V4	D30	GBA2/IO82PPB2V0	
B19	IO59PDB1V2	C25	IO75PDB1V4	E1	GND	
B20	IO53PDB1V1	C26	VCCIB1	E2	IO303NPB7V3	
B21	IO53NDB1V1	C27	IO64PPB1V2	E3	VCCIB7	
B22	IO61NDB1V2	C28	VCC	E4	IO305PPB7V3	
B23	IO61PDB1V2	C29	GBA1/IO81PPB1V4	E5	VCC	
B24	IO69NPB1V3	C30	GND	E6	GAC0/IO02NDB0V0	
B25	VCC	D1	IO303PPB7V3	E7	VCCIB0	
B26	GBC0/IO79NPB1V4	D2	VCC	E8	IO06PPB0V0	
B27	VCC	D3	IO305NPB7V3	E9	IO24NDB0V2	
B28	IO64NPB1V2	D4	GND	E10	IO24PDB0V2	
B29	GND	D5	GAA1/IO00PPB0V0	E11	IO13NDB0V1	
B30	GND	D6	GAC1/IO02PDB0V0	E12	IO13PDB0V1	
C1	GND	D7	IO06NPB0V0	E13	IO34NDB0V4	
C2	IO309NPB7V4	D8	GAB0/IO01NDB0V0	E14	IO34PDB0V4	
C3	VCC	D9	IO05NDB0V0	E15	IO40NDB0V4	
C4	GAA0/IO00NPB0V0	D10	IO11NDB0V1	E16	IO49NDB1V1	



FG896		FG896		FG896	
Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
E17	IO49PDB1V1	F23	IO72PDB1V3	G29	IO100PPB2V2
E18	IO50PDB1V1	F24	GNDQ	G30	GND
E19	IO58PDB1V2	F25	GND	H1	IO294PDB7V2
E20	IO60NDB1V2	F26	VMV2	H2	IO294NDB7V2
E21	IO77PDB1V4	F27	IO86PDB2V0	H3	IO300NDB7V3
E22	IO68NDB1V3	F28	IO92PDB2V1	H4	IO300PDB7V3
E23	IO68PDB1V3	F29	VCC	H5	IO295PDB7V2
E24	VCCIB1	F30	IO100NPB2V2	H6	IO299PDB7V3
E25	IO74PDB1V4	G1	GND	H7	VCOMPLA
E26	VCC	G2	IO296NPB7V2	H8	GND
E27	GBB1/IO80PPB1V4	G3	IO306NDB7V4	H9	IO08NDB0V0
E28	VCCIB2	G4	IO297NDB7V2	H10	IO08PDB0V0
E29	IO82NPB2V0	G5	VCCIB7	H11	IO18PDB0V2
E30	GND	G6	GNDQ	H12	IO26NPB0V3
F1	IO296PPB7V2	G7	VCC	H13	IO28NDB0V3
F2	VCC	G8	VMV0	H14	IO28PDB0V3
F3	IO306PDB7V4	G9	VCCIB0	H15	IO38PPB0V4
F4	IO297PDB7V2	G10	IO10NDB0V1	H16	IO42NDB1V0
F5	VMV7	G11	IO16NDB0V1	H17	IO52NDB1V1
F6	GND	G12	IO22PDB0V2	H18	IO52PDB1V1
F7	GNDQ	G13	IO26PPB0V3	H19	IO62NDB1V2
F8	IO12NDB0V1	G14	IO38NPB0V4	H20	IO62PDB1V2
F9	IO12PDB0V1	G15	IO36NDB0V4	H21	IO70NDB1V3
F10	IO10PDB0V1	G16	IO46NDB1V0	H22	IO70PDB1V3
F11	IO16PDB0V1	G17	IO46PDB1V0	H23	GND
F12	IO22NDB0V2	G18	IO56NDB1V1	H24	VCOMPLB
F13	IO30NDB0V3	G19	IO56PDB1V1	H25	GBC2/IO84PDB2V0
F14	IO30PDB0V3	G20	IO66NDB1V3	H26	IO84NDB2V0
F15	IO36PDB0V4	G21	IO66PDB1V3	H27	IO96PDB2V1
F16	IO48NDB1V0	G22	VCCIB1	H28	IO96NDB2V1
F17	IO48PDB1V0	G23	VMV1	H29	IO89PDB2V0
F18	IO50NDB1V1	G24	VCC	H30	IO89NDB2V0
F19	IO58NDB1V2	G25	GNDQ	J1	IO290NDB7V2
F20	IO60PDB1V2	G26	VCCIB2	J2	IO290PDB7V2
F21	IO77NDB1V4	G27	IO86NDB2V0	J3	IO302NDB7V3
F22	IO72NDB1V3	G28	IO92NDB2V1	J4	IO302PDB7V3



FG896		FG896		FG896	
Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
J5	IO295NDB7V2	K11	IO04PPB0V0	L17	VCC
J6	IO299NDB7V3	K12	VCCIB0	L18	VCC
J7	VCCIB7	K13	VCCIB0	L19	VCC
J8	VCCPLA	K14	VCCIB0	L20	VCC
J9	VCC	K15	VCCIB0	L21	IO78NPB1V4
J10	IO04NPB0V0	K16	VCCIB1	L22	IO104NPB2V2
J11	IO18NDB0V2	K17	VCCIB1	L23	IO98NDB2V2
J12	IO20NDB0V2	K18	VCCIB1	L24	IO98PDB2V2
J13	IO20PDB0V2	K19	VCCIB1	L25	IO87PDB2V0
J14	IO32NDB0V3	K20	IO76PPB1V4	L26	IO87NDB2V0
J15	IO32PDB0V3	K21	VCC	L27	IO97PDB2V1
J16	IO42PDB1V0	K22	IO78PPB1V4	L28	IO101PDB2V2
J17	IO44NDB1V0	K23	IO88NDB2V0	L29	IO103PDB2V2
J18	IO44PDB1V0	K24	IO88PDB2V0	L30	IO119NDB3V0
J19	IO54NDB1V1	K25	IO94PDB2V1	M1	IO282NDB7V1
J20	IO54PDB1V1	K26	IO94NDB2V1	M2	IO282PDB7V1
J21	IO76NPB1V4	K27	IO85PDB2V0	M3	IO292NDB7V2
J22	VCC	K28	IO85NDB2V0	M4	IO292PDB7V2
J23	VCCPLB	K29	IO93PDB2V1	M5	IO283NDB7V1
J24	VCCIB2	K30	IO93NDB2V1	M6	IO285PDB7V1
J25	IO90PDB2V1	L1	IO286NDB7V1	M7	IO287PDB7V1
J26	IO90NDB2V1	L2	IO286PDB7V1	M8	IO289PDB7V1
J27	GBB2/IO83PDB2V0	L3	IO298NDB7V3	M9	IO289NDB7V1
J28	IO83NDB2V0	L4	IO298PDB7V3	M10	VCCIB7
J29	IO91PDB2V1	L5	IO283PDB7V1	M11	VCC
J30	IO91NDB2V1	L6	IO291NDB7V2	M12	GND
K1	IO288NDB7V1	L7	IO291PDB7V2	M13	GND
K2	IO288PDB7V1	L8	IO293PDB7V2	M14	GND
K3	IO304NDB7V3	L9	IO293NDB7V2	M15	GND
K4	IO304PDB7V3	L10	IO307NPB7V4	M16	GND
K5	GAB2/IO308PDB7V4	L11	VCC	M17	GND
K6	IO308NDB7V4	L12	VCC	M18	GND
K7	IO301PDB7V3	L13	VCC	M19	GND
K8	IO301NDB7V3	L14	VCC	M20	VCC
K9	GAC2/IO307PPB7V4	L15	VCC	M21	VCCIB2
K10	VCC	L16	VCC	M22	NC



ProASIC3E Flash Family FPGAs

	FG896		FG896		FG896
Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
M23	IO104PPB2V2	N29	IO107PDB2V3	R5	GFB0/IO274NPB7V0
M24	IO102PDB2V2	N30	IO107NDB2V3	R6	IO271NDB6V4
M25	IO102NDB2V2	P1	IO276NDB7V0	R7	GFB2/IO271PDB6V4
M26	IO95PDB2V1	P2	IO278NDB7V0	R8	IO269PDB6V4
M27	IO97NDB2V1	P3	IO280NDB7V0	R9	IO269NDB6V4
M28	IO101NDB2V2	P4	IO284NDB7V1	R10	VCCIB7
M29	IO103NDB2V2	P5	IO279NDB7V0	R11	VCC
M30	IO119PDB3V0	P6	GFC1/IO275PDB7V0	R12	GND
N1	IO276PDB7V0	P7	GFC0/IO275NDB7V0	R13	GND
N2	IO278PDB7V0	P8	IO277PDB7V0	R14	GND
N3	IO280PDB7V0	P9	IO277NDB7V0	R15	GND
N4	IO284PDB7V1	P10	VCCIB7	R16	GND
N5	IO279PDB7V0	P11	VCC	R17	GND
N6	IO285NDB7V1	P12	GND	R18	GND
N7	IO287NDB7V1	P13	GND	R19	GND
N8	IO281NDB7V0	P14	GND	R20	VCC
N9	IO281PDB7V0	P15	GND	R21	VCCIB2
N10	VCCIB7	P16	GND	R22	GCC0/IO112NDB2V3
N11	VCC	P17	GND	R23	GCB2/IO116PDB3V0
N12	GND	P18	GND	R24	IO118PDB3V0
N13	GND	P19	GND	R25	IO111PPB2V3
N14	GND	P20	VCC	R26	IO122PPB3V1
N15	GND	P21	VCCIB2	R27	GCA0/IO114NPB3V0
N16	GND	P22	GCC1/IO112PDB2V3	R28	VCOMPLC
N17	GND	P23	IO110PDB2V3	R29	GCB1/IO113PPB2V3
N18	GND	P24	IO110NDB2V3	R30	IO115NPB3V0
N19	GND	P25	IO109PPB2V3	T1	IO270NDB6V4
N20	VCC	P26	IO111NPB2V3	T2	VCCPLF
N21	VCCIB2	P27	IO105PDB2V2	Т3	GFA2/IO272PPB6V4
N22	IO106NDB2V3	P28	IO105NDB2V2	T4	GFA1/IO273PDB6V4
N23	IO106PDB2V3	P29	GCC2/IO117PDB3V0	T5	IO272NPB6V4
N24	IO108PDB2V3	P30	IO117NDB3V0	Т6	IO267NDB6V4
N25	IO108NDB2V3	R1	GFC2/IO270PDB6V4	T7	IO267PDB6V4
N26	IO95NDB2V1	R2	GFB1/IO274PPB7V0	Т8	IO265PDB6V3
N27	IO99NDB2V2	R3	VCOMPLF	Т9	IO263PDB6V3
N28	IO99PDB2V2	R4	GFA0/IO273NDB6V4	T10	VCCIB6



Package Pin Assignments

	FG896		FG896		FG896
Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function	Pin Number	A3PE3000 Function
T11	VCC	U17	GND	V23	IO128NDB3V1
T12	GND	U18	GND	V24	IO132PDB3V2
T13	GND	U19	GND	V25	IO130PPB3V2
T14	GND	U20	VCC	V26	IO126NDB3V1
T15	GND	U21	VCCIB3	V27	IO129NDB3V1
T16	GND	U22	IO120PDB3V0	V28	IO127NDB3V1
T17	GND	U23	IO128PDB3V1	V29	IO125NDB3V1
T18	GND	U24	IO124PDB3V1	V30	IO123PDB3V1
T19	GND	U25	IO124NDB3V1	W1	IO266NDB6V4
T20	VCC	U26	IO126PDB3V1	W2	IO262NDB6V3
T21	VCCIB3	U27	IO129PDB3V1	W3	IO260NDB6V3
T22	IO109NPB2V3	U28	IO127PDB3V1	W4	IO252NDB6V2
T23	IO116NDB3V0	U29	IO125PDB3V1	W5	IO251NDB6V2
T24	IO118NDB3V0	U30	IO121NDB3V0	W6	IO251PDB6V2
T25	IO122NPB3V1	V1	IO268NDB6V4	W7	IO255NDB6V2
T26	GCA1/IO114PPB3V0	V2	IO262PDB6V3	W8	IO249PPB6V1
T27	GCB0/IO113NPB2V3	V3	IO260PDB6V3	W9	IO253PDB6V2
T28	GCA2/IO115PPB3V0	V4	IO252PDB6V2	W10	VCCIB6
T29	VCCPLC	V5	IO257NPB6V2	W11	VCC
T30	IO121PDB3V0	V6	IO261NPB6V3	W12	GND
U1	IO268PDB6V4	V7	IO255PDB6V2	W13	GND
U2	IO264NDB6V3	V8	IO259PDB6V3	W14	GND
U3	IO264PDB6V3	V9	IO259NDB6V3	W15	GND
U4	IO258PDB6V3	V10	VCCIB6	W16	GND
U5	IO258NDB6V3	V11	VCC	W17	GND
U6	IO257PPB6V2	V12	GND	W18	GND
U7	IO261PPB6V3	V13	GND	W19	GND
U8	IO265NDB6V3	V14	GND	W20	VCC
U9	IO263NDB6V3	V15	GND	W21	VCCIB3
U10	VCCIB6	V16	GND	W22	IO134PDB3V2
U11	VCC	V17	GND	W23	IO138PDB3V3
U12	GND	V18	GND	W24	IO132NDB3V2
U13	GND	V19	GND	W25	IO136NPB3V2
U14	GND	V20	VCC	W26	IO130NPB3V2
U15	GND	V21	VCCIB3	W27	IO141PDB3V3
U16	GND	V22	IO120NDB3V0	W28	IO135PDB3V2

4-46



	FG896
Pin Number	A3PE3000 Function
W29	IO131PDB3V2
W30	IO123NDB3V1
Y1	IO266PDB6V4
Y2	IO250PDB6V2
Y3	IO250NDB6V2
Y4	IO246PDB6V1
Y5	IO247NDB6V1
Y6	IO247PDB6V1
Y7	IO249NPB6V1
Y8	IO245PDB6V1
Y9	IO253NDB6V2
Y10	GEB0/IO235NPB6V0
Y11	VCC
Y12	VCC
Y13	VCC
Y14	VCC
Y15	VCC
Y16	VCC
Y17	VCC
Y18	VCC
Y19	VCC
Y20	VCC
Y21	IO142PPB3V3
Y22	IO134NDB3V2
Y23	IO138NDB3V3
Y24	IO140NDB3V3
Y25	IO140PDB3V3
Y26	IO136PPB3V2
Y27	IO141NDB3V3
Y28	IO135NDB3V2
Y29	IO131NDB3V2
Y30	IO133PDB3V2







# **5 – Datasheet Information**

## List of Changes

The following table lists critical changes that were made in each revision of the ProASIC3E datasheet.

#### Table 1 •

Revision	Changes	Page
Revision 16 (November 2019)	Updated the template change with Microchip-Microsemi logo across the document.	NA
	Removed PQ208 from the A3PE600 device and its related information across the document.	NA
Revision 15 (June 2015)	Updated "ProASIC3E Ordering Information". Interchanged the positions of Y- Security Feature and I- Application (Temperature Range) (SAR 67296).	1-111
	Added Note "Only devices with package size greater than or equal to 5x5 are supported".	
	Updated Commercial and Industrial Junction Temperatures (SAR 67588).	
	Added the A3PE3000 package to Table 2-5 (SARs 52320 and 58737).	2-5
	Updated "VCCIBx I/O Supply Voltage" (SAR 43323).	3-1
Revision 14 (May 2014)	Added 2 mA and 6 mA I/O short currents values in "I/O Short Currents IOSH/IOSL" (SAR 56295).	2-23 2-25
	Added 2 mA and 6 mA minimum and maximum DC input and output levels in "Minimum and Maximum DC Input and Output Levels"(SAR 56295).	2-26 2-26
	Added 3.3 V LVTTL / 3.3 V LVCMOS High Slew Commercial-Case Conditions for 2 mA and 6 mA in "3.3 V LVTTL / 3.3 V LVCMOS High Slew" (SAR 56295).	
	Added 3.3 V LVTTL / 3.3 V LVCMOS Low Slew Commercial-Case Conditions for 2 mA and 6 mA in "3.3 V LVTTL / 3.3 V LVCMOS Low Slew" (SAR 56295).	
Revision 13 (January 2013)	In the "Features and Benefits" section, updated the Clock Conditioning Circuit (CCC) and PLL Wide Input Frequency Range from '1.5 MHz to 200 MHz' to '1.5MHz to 350 MHz' based on Table 2-98 (SAR 22196).	1-1
	The "ProASIC3E Ordering Information" section has been updated to mention "Y" as "Blank" mentioning "Device Does Not Include License to Implement IP Based on the Cryptography Research, Inc. (CRI) Patent Portfolio" (SAR 43220).	1-111
	Added a note to "Recommended Operating Conditions <sup>1</sup> " table (SAR 42716): The programming temperature range supported is $T_{ambient} = 0^{\circ}C$ to 85°C.	2-2
	The note in "ProASIC3E CCC/PLL Specification" table referring the reader to SmartGen was revised to refer instead to the online help associated with the core (SAR 42571).	2-73
	Libero Integrated Design Environment (IDE) was changed to Libero System-on- Chip (SoC) throughout the document (SAR 40285).	NA
	Live at Power-Up (LAPU) has been replaced with 'Instant On'.	
Revision 12 (September 2012)	The "Security" section was modified to clarify that Microsemi does not support read-back of programmed data.	1-1



Table	1	•
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Revision	Changes	Page
Revision 11 (August 2012)	Added a Note stating "VMV pins must be connected to the corresponding VCCI pins. See the "VMVx I/O Supply Voltage (quiet)" section on page 3-1 for further information." to Table 2-1 • Absolute Maximum Ratings and Table 2-2 • Recommended Operating Conditions <sup>1</sup> (SAR 38322).	2-1 3-1 2-1
	<ul> <li>The drive strength, IOL, and IOH value for 3.3 V GTL and 2.5 V GTL was changed from 25 mA to 20 mA in the following tables (SAR 31924):</li> <li>"Summary of Maximum and Minimum DC Input and Output Levels" table</li> <li>"Summary of I/O Timing Characteristics—Software Default Settings" table</li> <li>"I/O Output Buffer Maximum Resistances<sup>1</sup>" table</li> <li>"Minimum and Maximum DC Input and Output Levels" table)</li> <li>"Minimum and Maximum DC Input and Output Levels" table</li> <li>"Minimum and Maximum DC Input and Output Levels" table</li> <li>"Minimum and Maximum DC Input and Output Levels" table</li> <li>Also added note stating "Output drive strength is below JEDEC specification" for Tables 2-17 and 2-19.</li> <li>Additionally, the IOL and IOH values for 3.3 V GTL+ and 2.5 V GTL+ were corrected from 51 to 35 (for 3.3 V GTL+) and from 40 to 33 (for 2.5 V GTL+) in table Table 2-13 (SAR 39714).</li> </ul>	2-17 2-20 2-21 2-40 2-42
	"Duration of Short Circuit Event Before Failure" table was revised to change the maximum temperature from 110°C to 100°C, with an example of six months instead of three months (SAR 37934).	2-23
	The following sentence was deleted from the "2.5 V LVCMOS" section (SAR 34796): "It uses a 5 V-tolerant input buffer and push-pull output buffer." This change was made in revision 10 and omitted from the change table in error.	2-31
Revision 11 (continued)	Figure 2-11 was updated to match tables in the "Summary of I/O Timing Characteristics – Default I/O Software Settings" section (SAR 34889).	2-39
	In Table 2-81 VIL and VIH were revised so that the maximum is 3.6 V for all listed values of VCCI (SAR 37222).	2-54
	Figure 2-47and Figure 2-48 are new (SAR 34848).	2-82
	The following sentence was removed from the "VMVx I/O Supply Voltage (quiet)" section in the "Pin Descriptions and Packaging" chapter: "Within the package, the VMV plane is decoupled from the simultaneous switching noise originating from the output buffer VCCI domain" and replaced with "Within the package, the VMV plane biases the input stage of the I/Os in the I/O banks" (SAR 38322). The datasheet mentions that "VMV pins must be connected to the corresponding VCCI pins" for an ESD enhancement.	3-1



Table 1 •

Revision	Changes	Page
Revision 10 (March 2012)	The "In-System Programming (ISP) and Security" section and "Security" section were revised to clarify that although no existing security measures can give an absolute guarantee, Microsemi FPGAs implement the best security available in the industry (SAR 34669).	I, 1-1
	The Y security option and Licensed DPA Logo were added to the "ProASIC3E Ordering Information" section. The trademarked Licensed DPA Logo identifies that a product is covered by a DPA counter-measures license from Cryptography Research (SAR 34727).	III
	The following sentence was removed from the "Advanced Architecture" section:	1-3
	"In addition, extensive on-chip programming circuitry allows for rapid, single- voltage (3.3 V) programming of IGLOOe devices via an IEEE 1532 JTAG interface" (SAR 34689).	
	The "Specifying I/O States During Programming" section is new (SAR 34699).	1-6
	VCCPLL in Table 2-2 • Recommended Operating Conditions <sup>1</sup> was corrected from "1.4 to 1.6 V" to "1.425 to 1.575 V" (SAR 33851).	2-2
	The T <sub>J</sub> symbol was added to the table and notes regarding T <sub>A</sub> and T <sub>J</sub> were removed. The second of two parameters in the VCCI and VMV row, called "3.3 V DC supply voltage," was corrected to "3.0 V DC supply voltage" (SAR 37227).	
	The reference to guidelines for global spines and VersaTile rows, given in the "Global Clock Contribution—P <sub>CLOCK</sub> " section, was corrected to the "Spine Architecture" section of the Global Resources chapter in the <i>ProASIC3E FPGA Fabric User's Guide</i> (SAR 34735).	2-10
	t <sub>DOUT</sub> was corrected to t <sub>DIN</sub> in Figure 2-3 • Input Buffer Timing Model and Delays (example) (SAR 37109).	2-14
	The typo related to the values for 3.3 V LVCMOS Wide Range in Table 2-17 • Summary of I/O Timing Characteristics—Software Default Settings was corrected (SAR 37227).	2-20
	The notes regarding drive strength in the "Summary of I/O Timing Characteristics – Default I/O Software Settings" section and "3.3 V LVCMOS Wide Range" section and tables were revised for clarification. They now state that the minimum drive strength for the default software configuration when run in wide range is $\pm 100 \ \mu$ A. The drive strength displayed in software is supported in normal range only. For a detailed I/V curve, refer to the IBIS models (SAR 34763).	2-19, 2-28



Table	1	•
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Revision	Changes	Page
Revision 10 (continued)	"TBD" for 3.3 V LVCMOS Wide Range in Table 2-19 • I/O Output Buffer Maximum Resistances <sup>1</sup> and Table 2-21 • I/O Short Currents IOSH/IOSL was replaced by "Same as regular 3.3 V LVCMOS" (SAR 33853).	2-21, 2-28
	3.3 V LVCMOS Wide Range information was separated from regular 3.3 V LVCMOS and placed into its own new section, "3.3 V LVCMOS Wide Range". Values of IOSH and IOSL were added in Table 2-29 • Minimum and Maximum DC Input and Output Levels (SAR 33853).	
	The formulas in the table notes for Table 2-20 • I/O Weak Pull-Up/Pull-Down Resistances were corrected (SAR 34755).	2-22
	The AC Loading figures in the "Single-Ended I/O Characteristics" section were updated to match tables in the "Summary of I/O Timing Characteristics – Default I/O Software Settings" section (SAR 34889).	2-25
	The titles and subtitles for Table 2-31 • 3.3 V LVCMOS Wide Range High Slew and Table 2-32 • 3.3 V LVCMOS Wide Range Low Slew were corrected (SAR 37227).	2-29, 2-30
	The following notes were removed from Table 2-78 • LVDS Minimum and Maximum DC Input and Output Levels (SAR 34812): ±5% Differential input voltage = ±350 mV	2-52
	Minimum pulse width High and Low values were added to the tables in the "Global Tree Timing Characteristics" section. The maximum frequency for global clock parameter was removed from these tables because a frequency on the global is only an indication of what the global network can do. There are other limiters such as the SRAM, I/Os, and PLL. SmartTime software should be used to determine the design frequency (SAR 36957).	2-71
	A note was added to Table 2-98 • ProASIC3E CCC/PLL Specification indicating that when the CCC/PLL core is generated by Microsemi core generator software, not all delay values of the specified delay increments are available (SAR 34824).	2-73
	The following figures were deleted. Reference was made to a new application note, <i>Simultaneous Read-Write Operations in Dual-Port SRAM for Flash-Based</i> <i>cSoCs and FPGAs</i> , which covers these cases in detail (SAR 34872). Figure 2-44 • Write Access after Write onto Same Address Figure 2-45 • Read Access after Write onto Same Address Figure 2-46 • Write Access after Read onto Same Address The port names in the SRAM "Timing Waveforms", SRAM "Timing Characteristics" tables, Figure 2-49 • FIFO Reset, and the FIFO "Timing Characteristics" tables were revised to ensure consistency with the software names (SAR 35750).	2-77, 2-78, 2-82, 2-85
	The "Pin Descriptions and Packaging" chapter is new (SAR 34771).	3-1
	Package names used in the "Package Pin Assignments" section were revised to match standards given in <i>Package Mechanical Drawings</i> (SAR 34771).	4-1
	Pin E6 for the FG256 package was corrected from VvB0 to VCCIB0 (SARs 30364, 31597, 26243).	4-9
July 2010	The versioning system for datasheets has been changed. Datasheets are assigned a revision number that increments each time the datasheet is revised. The "ProASIC3E Device Status" table on page II indicates the status for each device in the device family.	N/A



Revision	Changes	Page
Revision 9 (Aug 2009)	All references to speed grade –F have been removed from this document.	N/A
Product Brief v1.2		
	The "Pro I/Os with Advanced I/O Standards" section was revised to add definitions of hot-swap and cold-sparing.	1-6
DC and Switching Characteristics v1.3	3.3 V LVCMOS and 1.2 V LVCMOS Wide Range support was added to the datasheet. This affects all tables that contained 3.3 V LVCMOS and 1.2 V LVCMOS data.	N/A
	IIL and IIH input leakage current information was added to all "Minimum and Maximum DC Input and Output Levels" tables.	N/A
	-F was removed from the datasheet. The speed grade is no longer supported.	N/A
	In the Table 2-2 • Recommended Operating Conditions <sup>1</sup> "3.0 V DC supply voltage" and note 4 are new.	2-2
	The Table 2-4 • Overshoot and Undershoot Limits <sup>1</sup> table was updated.	2-3
	The Table 2-6 • Temperature and Voltage Derating Factors for Timing Delays table was updated.	2-6
	There are new parameters and data was updated in the Table 2-99 • RAM4K9 table.	2-79
	There are new parameters and data was updated in the Table 2-100 • RAM512X18 table.	2-80
Revision 8 (Feb 2008) Product Brief v1.1	Table 1-2 • ProASIC3E FPGAs Package Sizes Dimensions is new.	1-II
<b>Revision 7 (Jun 2008)</b> DC and Switching Characteristics v1.2	The title of Table 2-4 • Overshoot and Undershoot Limits <sup>1</sup> was modified to remove "as measured on quiet I/Os." Table note 2 was revised to remove "estimated SSO density over cycles." Table note 3 was deleted.	2-3
	Table 2-78 • LVDS Minimum and Maximum DC Input and Output Levels was updated.	2-52
Revision 6 (Jun 2008)	The A3PE600 "FG484" table was missing G22. The pin and its function were added to the table.	4-25
<b>Revision 5 (Jun 2008)</b> Packaging v1.4	The naming conventions changed for the following pins in the "FG484" for the A3PE600:	4-20
	Pin Number New Function Name	
	J19 IO45PPB2V1	
	K20 IO45NPB2V1	
	M2 IO114NPB6V1	
	N1 IO114PPB6V1	
	N4 GFC2/IO115PPB6V1	
	P3 IO115NPB6V1	
Revision 4 (Apr 2008) Product Brief v1.0	The product brief portion of the datasheet was divided into two sections and given a version number, starting at v1.0. The first section of the document includes features, benefits, ordering information, and temperature and speed grade offerings. The second section is a device family overview.	N/A
Packaging v1.3	The "FG324" package diagram was replaced.	4-10

Revision	Changes	Page
<b>Revision 3 (Apr 2008)</b> Packaging v1.2	The following pins had duplicates and the extra pins were deleted from the "PQ208" A3PE3000 table:	4-2
	36, 62, 171 Note: There were no pin function changes in this update.	
	The following pins had duplicates and the extra pins were deleted from the "FG324" table:	4-10
	E2, E3, E16, E17, P2, P3, T16, U17 Note: There were no pin function changes in this update.	
	The "FG256" pin table was updated for the A3PE600 device because the old PAT were based on the IFX die, and this is the final UMC die version.	4-7
	The "FG484" was updated for the A3PE600 device because the old PAT were based on the IFX die, and this is the final UMC die version.	4-20
	The following pins had duplicates and the extra pins were deleted from the "FG896" table:	4-39
	AD6, AE5, AE28, AF29, F5, F26, G6, G25	
	Note: There were no pin function changes in this update.	
Revision 2 (Mar 2008) Product Brief rev. 1	The FG324 package was added to the "ProASIC3E Product Family" table, the "I/Os Per Package1" table, and the "Temperature Grade Offerings" table for A3PE3000.	I, II, IV
<b>Revision 1 (Feb 2008)</b> DC and Switching Characteristics v1.1	In Table 2-3 • Flash Programming Limits – Retention, Storage and Operating Temperature 1, Maximum Operating Junction Temperature was changed from 110°C to 100°C for both commercial and industrial grades.	2
	The "PLL Behavior at Brownout Condition" section is new.	2-4
	In the "PLL Contribution—PPLL" section, the following was deleted: FCLKIN is the input clock frequency.	2-11
	In Table 2-14 • Summary of Maximum and Minimum DC Input Levels, the note was incorrect. It previously said $T_J$ and it was corrected and changed to $T_A$ .	2-18
	In Table 2-98 • ProASIC3E CCC/PLL Specification, the SCLK parameter and note 1 are new.	2-73
	Table 2-103 • JTAG 1532 was populated with the parameter data, which was not in the previous version of the document.	2-83
Revision 1 (cont'd)	The "PQ208" pin table for A3PE3000 was updated.	4-2
Packaging v1.1	The "FG324" pin table for A3PE3000 is new.	4-11
	The "FG484" pin table for A3PE3000 is new.	4-15
	The "FG896" pin table for A3PE3000 is new.	4-39
Revision 0 (Jan 2008)	This document was previously in datasheet v2.1. As a result of moving to the handbook format, Actel has restarted the version numbers. The new version number is 51700098-001-0.	N/A
v2.1 (July 2007)	CoreMP7 information was removed from the "Features and Benefits" section.	1-1
	The M1 device part numbers have been updated in ProASIC3E Product Family, "Packaging Tables", "Temperature Grade Offerings", "Speed Grade and Temperature Grade Matrix", and "Speed Grade and Temperature Grade Matrix".	1-1



Changes	Page
The words "ambient temperature" were added to the temperature range in the "Temperature Grade Offerings", "Speed Grade and Temperature Grade Matrix", and "Speed Grade and Temperature Grade Matrix" sections.	1-1
The "Clock Conditioning Circuit (CCC) and PLL" section was updated.	1-I
The caption "Main (chip)" in Figure 2-9 • Overview of Automotive ProASIC3 VersaNet Global Network was changed to "Chip (main)."	2-9
The T <sub>J</sub> parameter in Table 3-2 $\cdot$ Recommended Operating Conditions was changed to T <sub>A</sub> , ambient temperature, and table notes 4–6 were added.	3-2
The "PLL Macro" section was updated to add information on the VCO and PLL outputs during power-up.	2-15
In the "Temperature Grade Offerings" section, Ambient was deleted.	iii
Ambient was deleted from "Temperature Grade Offerings".	iii
Ambient was deleted from the "Speed Grade and Temperature Grade Matrix".	iv
The "PLL Macro" section was updated to include power-up information.	2-15
Table 2-13 • ProASIC3E CCC/PLL Specification was updated.	2-30
Figure 2-19 • Peak-to-Peak Jitter Definition is new.	2-18
The "SRAM and FIFO" section was updated with operation and timing requirement information.	2-21
The "RESET" section was updated with read and write information.	2-25
The "RESET" section was updated with read and write information.	2-25

The "Introduction" in the "Advanced I/Os" section was updated to include 2-28 information on input and output buffers being disabled. In the Table 2-15 • Levels of Hot-Swap Support, the ProASIC3 compliance 2-34 descriptions were updated for levels 3 and 4. Table 2-45 • I/O Hot-Swap and 5 V Input Tolerance Capabilities in ProASIC3E 2-64 Devices was updated. Notes 3, 4, and 5 were added to Table 2-17 · Comparison Table for 5 V-2-40 Compliant Receiver Scheme. 5 x 52.72 was changed to 52.7 and the Maximum current was updated from 4 x 52.7 to 5 x 52.7. The "VCCPLF PLL Supply Voltage" section was updated. 2-50 The "VPUMP Programming Supply Voltage" section was updated. 2-50 The "GL Globals" section was updated to include information about direct input 2-51 into quadrant clocks. VJTAG was deleted from the "TCK Test Clock" section. 2-51 In Table 2-22 • Recommended Tie-Off Values for the TCK and TRST Pins, TSK 2-51 was changed to TCK in note 2. Note 3 was also updated. Ambient was deleted from Table 3-2 • Recommended Operating Conditions. 3-2 VPUMP programming mode was changed from "3.0 to 3.6" to "3.15 to 3.45". Note 3 is new in Table 3-4 • Overshoot and Undershoot Limits (as measured on 3-2 quiet I/Os). In EQ 3-2, 150 was changed to 110 and the result changed to 5.88. 3-5 **Revision 16** 

Revision v2.1 (continued)

v2.0 (April 2007)

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Revision	Changes	Page
v2.0 (continued)	Table 3-6 • Temperature and Voltage Derating Factors for Timing Delays was updated.	3-5
	Table 3-5 • Package Thermal Resistivities was updated.	3-5
	Table 3-10 • Different Components Contributing to the Dynamic Power           Consumption in ProASIC3E Devices was updated.	3-8
	$t_{WRO}$ and $t_{CCKH}$ were added to Table 3-94 $\bullet$ RAM4K9 and Table 3-95 $\bullet$ RAM512X18.	3-74 to 3-74
	The note in Table 3-24 • I/O Input Rise Time, Fall Time, and Related I/O Reliability was updated.	3-23
	Figure 3-43 • Write Access After Write onto Same Address, Figure 3-44 • Read Access After Write onto Same Address, and Figure 3-45 • Write Access After Read onto Same Address are new.	3-71 to 3- 73
	Figure 3-53 • Timing Diagram was updated.	3-80
	Notes were added to the package diagrams identifying if they were top or bottom view.	N/A
	The A3PE1500 "208-Pin PQFP" table is new.	4-4
	The A3PE1500 "484-Pin FBGA" table is new.	4-18
	The A3PE1500 "A3PE1500 Function" table is new.	4-24
Advance v0.6 (January 2007)	In the "Packaging Tables" table, the number of I/Os for the A3PE1500 was changed for the FG484 and FG676 packages.	ii
Advance v0.5 (April 2006)	B-LVDS and M-LDVS are new I/O standards added to the datasheet.	N/A
	The term flow-through was changed to pass-through.	N/A
	Figure 2-8 • Very-Long-Line Resources was updated.	2-8
	The footnotes in Figure 2-27 • CCC/PLL Macro were updated.	2-28
	The Delay Increments in the Programmable Delay Blocks specification in Figure 2-24 • ProASIC3E CCC Options.	2-24
	The "SRAM and FIFO" section was updated.	2-21
	The "RESET" section was updated.	2-25
	The "WCLK and RCLK" section was updated.	2-25
	The "RESET" section was updated.	2-25
	The "RESET" section was updated.	2-27
	B-LVDS and M-LDVS are new I/O standards added to the datasheet.	N/A
	The term flow-through was changed to pass-through.	N/A
	Figure 2-8 • Very-Long-Line Resources was updated.	2-8
	The footnotes in Figure 2-27 • CCC/PLL Macro were updated.	2-28
	The Delay Increments in the Programmable Delay Blocks specification in Figure 2-24 • ProASIC3E CCC Options.	2-24
	The "SRAM and FIFO" section was updated.	2-21
	The "RESET" section was updated.	2-25
	The "WCLK and RCLK" section was updated.	2-25

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Revision	Changes	Page
Advance v0.5 (continued)	The "RESET" section was updated.	2-25
	The "RESET" section was updated.	2-27
	The "Introduction" of the "Introduction" section was updated.	2-28
	PCI-X 3.3 V was added to the Compatible Standards for 3.3 V in Table 2- 11 • VCCI Voltages and Compatible Standards	2-29
	Table 2-35 • ProASIC3E I/O Features was updated.	2-54
	The "Double Data Rate (DDR) Support" section was updated to include information concerning implementation of the feature.	2-32
	The "Electrostatic Discharge (ESD) Protection" section was updated to include testing information.	2-35
	Level 3 and 4 descriptions were updated in Table 2-43 • I/O Hot-Swap and 5 V Input Tolerance Capabilities in ProASIC3 Devices.	2-64
	The notes in Table 2-45 • I/O Hot-Swap and 5 V Input Tolerance Capabilities in ProASIC3E Devices were updated.	2-64
	The "Simultaneous Switching Outputs (SSOs) and Printed Circuit Board Layout" section is new.	2-41
	A footnote was added to Table 2-37 • Maximum I/O Frequency for Single-Ended and Differential I/Os in All Banks in ProASIC3E Devices (maximum drive strength and high slew selected).	2-55
	Table 2-48 • ProASIC3E I/O Attributes vs. I/O Standard Applications	2-81
	Table 2-55 • ProASIC3 I/O Standards—SLEW and Output Drive (OUT_DRIVE) Settings	2-85
	The "x" was updated in the "Pin Descriptions" section.	2-50
	The "VCC Core Supply Voltage" pin description was updated.	2-50
	The "VMVx I/O Supply Voltage (quiet)" pin description was updated to include information concerning leaving the pin unconnected.	2-50
	EXTFB was removed from Figure 2-24 • ProASIC3E CCC Options.	2-24
	The CCC Output Peak-to-Peak Period Jitter F <sub>CCC_OUT</sub> was updated in Table 2-13 • ProASIC3E CCC/PLL Specification.	2-30
	EXTFB was removed from Figure 2-27 • CCC/PLL Macro.	2-28
	The LVPECL specification in Table 2-45 • I/O Hot-Swap and 5 V Input Tolerance Capabilities in ProASIC3E Devices was updated.	2-64
	Table 2-15 • Levels of Hot-Swap Support was updated.	2-34
	The "Cold-Sparing Support" section was updated.	2-34
	"Electrostatic Discharge (ESD) Protection" section was updated.	2-35
	The VJTAG and I/O pin descriptions were updated in the "Pin Descriptions" section.	2-50
	The "VJTAG JTAG Supply Voltage" pin description was updated.	2-50
	The "VPUMP Programming Supply Voltage" pin description was updated to include information on what happens when the pin is tied to ground.	2-50

Revision	Changes	Page
Advance v0.5 (continued)	The "I/O User Input/Output" pin description was updated to include information on what happens when the pin is unused.	2-50
	The "JTAG Pins" section was updated to include information on what happens when the pin is unused.	2-51
	The "Programming" section was updated to include information concerning serialization.	2-53
	The "JTAG 1532" section was updated to include SAMPLE/PRELOAD information.	2-54
	The "DC and Switching Characteristics" chapter was updated with new information.	Starting on page 3-1
	Table 3-6 was updated.	3-5
	In Table 3-10, PAC4 was updated.	3-8
	Table 3-19 was updated.	3-20
	The note in Table 3-24 was updated.	3-23
	All Timing Characteristics tables were updated from LVTTL to Register Delays	3-26 to 3-64
	The Timing Characteristics for RAM4K9, RAM512X18, and FIFO were updated.	3-74 to 3-79
	F <sub>TCKMAX</sub> was updated in Table 3-98.	3-80
Advance v0.4 (October 2005)	The "Packaging Tables" table was updated.	ii
Advance v0.3	Figure 2-11 was updated.	2-9
	The "Clock Resources (VersaNets)" section was updated.	2-9
	The "VersaNet Global Networks and Spine Access" section was updated.	2-9
	The "PLL Macro" section was updated.	2-15
	Figure 2-27 was updated.	2-28
	Figure 2-20 was updated.	2-19
	Table 2-5 was updated.	2-25
	Table 2-6 was updated.	2-25
	The "FIFO Flag Usage Considerations" section was updated.	2-27
	Table 2-33 was updated.	2-51
	Figure 2-24 was updated.	2-31
	The "Cold-Sparing Support" section is new.	2-34
	Table 2-45 was updated.	2-64
	Table 2-48 was updated.	2-81
	Pin descriptions in the "JTAG Pins" section were updated.	2-51
	The "Pin Descriptions" section was updated.	2-50
	Table 3-7 was updated.	3-6



Revision	Changes	Page
Advance v0.3	The "Methodology" section was updated.	3-9
(continued)	The A3PE3000 "208-Pin PQFP" pin table was updated.	4-6



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#### Categories

In order to provide the latest information to designers, some datasheet parameters are published before data has been fully characterized from silicon devices. The data provided for a given device, as highlighted in the "ProASIC3E Device Status" table on page II, is designated as either "Product Brief," "Advance," "Preliminary," or "Production." The definitions of these categories are as follows:

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The product brief is a summarized version of a datasheet (advance or production) and contains general product information. This document gives an overview of specific device and family information.

#### Advance

This version contains initial estimated information based on simulation, other products, devices, or speed grades. This information can be used as estimates, but not for production. This label only applies to the DC and Switching Characteristics chapter of the datasheet and will only be used when the data has not been fully characterized.

#### Preliminary

The datasheet contains information based on simulation and/or initial characterization. The information is believed to be correct, but changes are possible.

#### Production

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